

HCD-MJ1

SERVICE MANUAL

*US Model
Canadian Model
AEP Model
UK Model
E Model*



- HCD-MJ1 is the tuner, CD amplifier and MDsection in MJ-L1.

US and foreign patents licensed from Dolby Laboratories Licensing Corporation.

CD Section	Model Name Using Similar Mechanism	HCD-D1/T1
	CD Mechanism Type	CDM13C-5BD19
	Base Unit Name	BU-5BD19
MD Section	Model Name Using Similar Mechanism	NEW
	Mini Disc Mechanism Type	MDM-2ER

SPECIFICATIONS

CD player section

System Compact disc and digital audio system
Laser Semiconductor laser ($\lambda=780$ nm)

Emission duration: continuous

Laser output

Max 44.6 μ W*

* This output is the value measured at a distance of 200mm from the objective lens surface on the Optical Pick-up Block with 7 mm aperture.

Wavelength

780 - 790 nm

Frequency response

2 Hz - 20 kHz

MiniDisc deck section

System MiniDisc digital audio system

Disc MiniDisc

Laser Semiconductor laser ($\lambda=780$ nm)

Laser output

Max 44.6 μ W*

* This output is the value measured at a distance of 200mm from the objective lens surface on the Optical Pick-up Block with 7 mm aperture.

Laser diode properties

Materi.II: GaAIAs

Revolutions (CLV)

Approx. 400 rpm to 900 rpm

Error correction

Adv.Inced Cross IntL•rlieve Rced
Solomon Code (ACIRC)

Sampling frequency

44.1 kHz

Modulation system

EFM
(Eight-to-Fourteen Modula tion)

Number of channels

2 stereo channels

Frequency response

5 Hz - 20 kHz

Wow and flutter

Below measurable limit

Tuner section

FM tuner section

Tuning range

US, Canadian model

: 87.5 - 108.0 MHz (100 kHz step)

Except US, Canadian model

: 87.5 - 108.0 MHz (50 kHz step)

Aerial FM lead aerial

Aerial terminal

75 ohm unbalanced

Intermediate frequency

10.7 MHz

AM tuner section

Tuning range

US, Canadian model

: 530 - 1.710 kHz
(with the interval set at 10 kHz)

AEP, UK, German, Italian, Singapore,

Hong kong model

: 531 - 1.602 kHz
(with the interval set at 9 kHz)

Aerial AM loop aerial,
External aerial terminals

Intermediate frequency

450 kHz

Timer section

System Quartz lock system

Timer setting

One-minute step

Sleep timer

10-minute step. max. 90 minutes

- Continued on pag 2 -

FLAT COMPONENT SYSTEM
SONY®



Amplifier section

DIN power output	30 W + 30 W (6 ohms at 1 kHz, DIN)
Continuous RMS power output	
US, Canadian model :	30 W + 30 W (6 ohms at 40Hz-16kHz, 1.0% THD) 35 W + 35 W (6 ohms at 1kHz, 5% THD) POPO 350W
Except US, Canadian model :	40 W + 40 W (6 ohms at 1 kHz, 10% THD)
Music power output	70W+70W (6 ohms at 1 kHz, 10% THD)
Inputs	TAPE (phono jacks): voltage 250 mV impedance 47 kilohms
Outputs	TAPE (phono jacks): voltage 250 mV impedance 1 kilohms PHONES (stereo phone jack): accepts headphones of 8 ohms or more.

Supplied accessories

- Sony RM-SMJI Remote (1)
- Sony lithium battery. CR2025 (1)
- FM lead aerial (1)
- AM loop aerial (1)
- Speaker cords (2)

General

Power requirements

Destination	Power requirements	Power consumption
US, Canadian model	120V AC,60Hz	95W
AEP, UK, German Italian model	220-230V AC, 50/60Hz	95W
E, Singapore, Hong Kong model	110-120V/ 220-240V AC, 50/60Hz Adjustable with the Voltage Selector	95W

Dimensions

Approx. 430 x 95 x 290 mm
(17 x 3³/4 x 11 1/2 inches) (w/h/d)
incl. projecting parts and controls

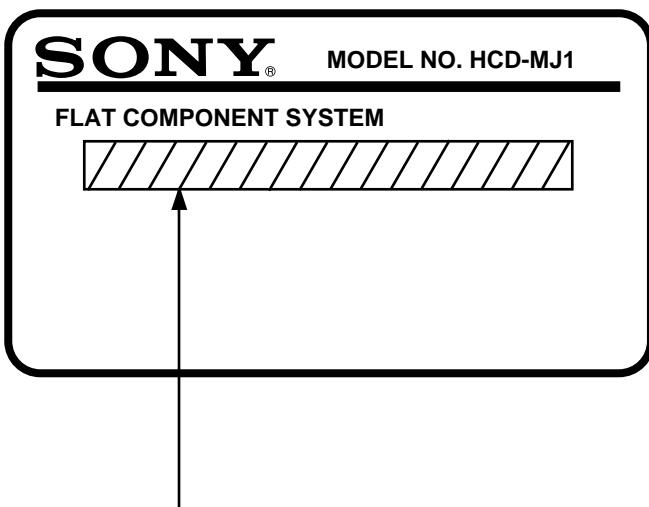
Mass Approx. 7.0 kg (15 lb 7 oz)

Design and specifications are subject to
change without notice.

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MODEL IDENTIFICATION



US, Canadian model : AC120V ~60Hz
 AEP, UK, German, Italian model : AC220-230V ~50/60Hz
 Hong kong, Sinagpore mdel : AC110-120V/AC220-240V ~50/60Hz

Laser component in this product is capable of emitting radiation exceeding the limit for Class 1.

For customers in Europe

CLASS 1 LASER PRODUCT
LUOKAN 1 LASERLAITE
KLASS 1 LASERAPPARAT

This Compact Disc player is classified as a CLASS 1 LASER product.
 The CLASSLASER PRODUCT label is located on the rear exterior.

CAUTION	; INVISIBLE LASER RADIATION WHEN OPEN. AVOID EXPOSURE TO BEAM.
ADVARSEL	; USYNLIG LASERSTRÅLING VED ÅBNING NÄR SIKKERHEDSAFTRYDEREN ER UDE AF FUNKTION. UNDGA UDSÆTTELSE FOR STRÅLING.
VARO!	; AVATTAESSA JA SUOJALUKITUS OHITTETTAESSA DLET ALTTINA LASERSÄTEILYLLE.
VARNING	; LASERSTRÅLING NÄR DENNA DEL ÄR ÖPPNAD OCH SPÄRREN ÄR URXOPPLAD.
ADVARSEL	; USYNLIG LASERSTRÅLING NÄR DEKSEL ÄPNES UNNGÅ EKSPOSERING FOR STRÅLEN.

This caution label is located insuide the unit.

CAUTION

Use of controls or adjustments or performance of procedures other than those specified herein may result in hazardous radiation exposure.

SAFETY CHECK-OUT

After correcting the original service problem, perform the following safety check before releasing the set to the customer : Check the antenna terminals, metal trim, "metallized" knobs, screws, and all other exposed metal parts for AC leakage. Check leakage as described below.

LEAKAGE TEST

The AC leakage from any exposed metal part to earth ground and from all exposed metal parts to any exposed metal part having a return to chassis, must not exceed 0.5mA (500 microampers).

Leakage current can be measured by any one of three methods.

1. A commercial leakage tester, such as the Simpson 229 or RCA WT-540A. Follow the manufacturers' instructions to use these instruments.
2. A battery-operated AC milliammeter. The Data Precision 245 digital multimeter is suitable for this job.
3. Measuring the voltage drop across a resistor by means of a VOM or battery-operated AC voltmeter. The "limit" indication is 0.75V, so analog meters must have an accurate low-voltage scale. The Simpson 250 and Sanwa SH-63Trd are examples of a passive VOM that is suitable. Nearly all battery operated digital multimeters that have a 2V AC range are suitable. (See Fig. A)

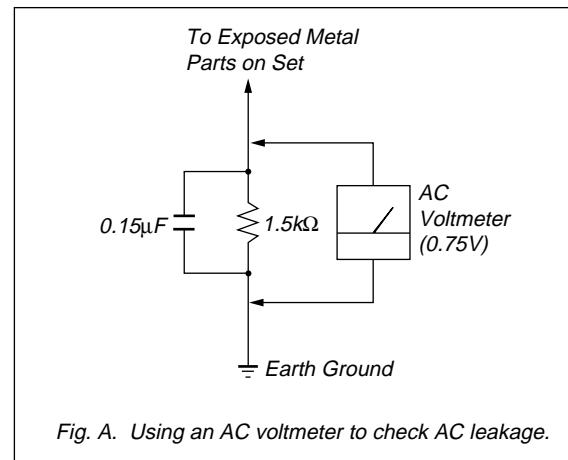


Fig. A. Using an AC voltmeter to check AC leakage.

SAFETY-RELATED COMPONENT WARNING!!

COMPONENTS IDENTIFIED BY MARK \triangle OR DOTTED LINE WITH MARK \triangle ON THE SCHEMATIC DIAGRAMS AND IN THE PARTS LIST ARE CRITICAL TO SAFE OPERATION.
 REPLACE THESE COMPONENTS WITH SONY PARTS WHOSE PART NUMBERS APPEAR AS SHOWN IN THIS MANUAL OR IN SUPPLEMENTS PUBLISHED BY SONY.

ATTENTION AU COMPOSANT AYANT RAPPORT À LA SÉCURITÉ!

LES COMPOSANTS IDENTIFIÉS PAR UNE MARQUE \triangle SUR LES DIAGRAMMES SCHÉMATIQUES ET LA LISTE DES PIÈCES SONT CRITIQUES POUR LA SÉCURITÉ DE FONCTIONNEMENT. NE REMPLACER CES COMPOSANTS QUE PAR DES PIÈCES SONY DONT LES NUMÉROS SONT DONNÉS DANS CE MANUEL OU DANS LES SUPPLÉMENTS PUBLIÉS PAR SONY.

SECTION 1

SERVICING NOTES

NOTES ON HANDLING THE OPTICAL PICK-UP BLOCK OR BASE UNIT

The laser diode in the optical pick-up block may suffer electrostatic breakdown because of the potential difference generated by the charged electrostatic load, etc. on clothing and the human body. During repair, pay attention to electrostatic breakdown and also use the procedure in the printed matter which is included in the repair parts.

The flexible board is easily damaged and should be handled with care.

NOTES ON LASER DIODE EMISSION CHECK

The laser beam on this model is concentrated so as to be focused on the disc reflective surface by the objective lens in the optical pick-up block. Therefore, when checking the laser diode emission, observe more than 30 cm away from the objective lens.

ENTERING TEST MODE

When you press the **[DISP]** button, **[■]** button, and **[EDIT]** button at the same time, the system goes into key, fluorescent tube, jogr and LED check mode.

● Fluorescent tube check

All the lights light up. Then, each time you press the **[ENTER]** button, the display mode changes as shown below.



● LED check

When you turn the jog dial, the LEDS change froln all lit to individually lit.

● Key check

The **[EDIT/NO]** button puts the system into key/jog check mode .

When you press a button, the number is counted up.

However, pressing a button again that you already pressed does not count up the number.

Turning the jog dial to the right increases the jog count display, turning the jog dial to the left decreases the jog count.

When you have pressed all the buttons and "KEY= 0K" is displayed, pressing any button ends test Inode.

Cautions when replacing IC121 and IC171 on the BD board

A change has been made from CXD2535BR due to a modification of IC121 on the BD board in this unit.

Accompanying this modification, a portion of the non-volatile memory of IC171 (XC24CO1S) has been changed.

Conversely, when IC121 has been replaced, use CXD2535BR and rewrite the contents of IC171.

Contents of non-volatile memories CXD2535BR

Address	CXD2535BR
15	93
2D	1A
2E	1A

Rewrite Procedure for Non-volatile Memory

(1) With the power switched off and the power plug plugged into a socket, press the BASS/TREBLE button, CLOCK button, and MD button more than one at a time in order.

(2) Rotate the JOG dial knob and display the "EEP MODE".

When you press the YES key, the display changes to show "EEP**@@".

(Here, **indicates the address, and @@ indicates the data.)

(3) Rotate the JOG dial knob and display the "EEP 15 @@".

(4) When you press the CD SYNCHRO button, "EEP 15 @>@@" is displayed so then turn the JOG dial knob to show "EEP 15 @>93"

(5) Press the YES key and "COMPLETE" will appear for a moment and data shown as "EEP 15 93" is being rewritten.

(6) Rewrite address 2D and address 2E, into 1A using steps (3) to (5) above.

(7) When all changes are complete, press the NO key and display "EEP MODE".

(8) Press the REPEAT button. If no disc is loaded, the time is displayed, so unplug the power plug. If a disc is loaded, the disc is ejected, then the time is displayed. Unplug the power plug from the socket to end EEP rewrite mode. (See "How to end test mode" below.)

Note: Changes in the contents of non-volatile memory are not reflected until the power is switched off, then on.

HOW TO END TEST MODE

Method :

- 1 Press the REPEAT button.
- 2 If no disc is loaded, the time is displayed. If a disc is loaded, the disc is ejected, then the time is displayed .
- 3 Unplug the power plug from the socket.

SECTION 2

GENERAL

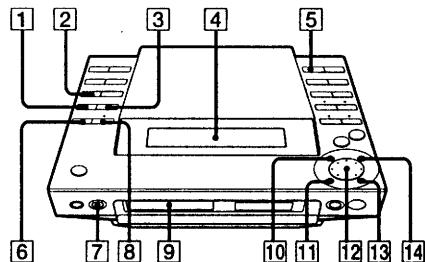
This section is extracted from instruction manual.

Index to Parts and Controls

Refer to the pages indicated in parentheses for how to use the controls.
Controls with an asterisk have built-in lamps on themselves.

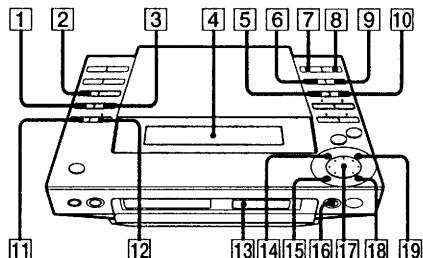
Front Panel

CD player section



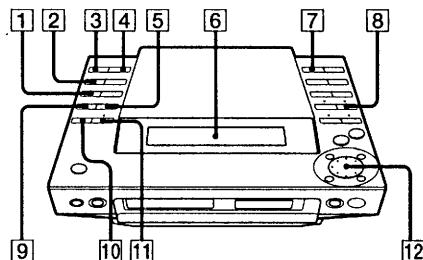
- 1 PLAY MODE button (9)
- 2 CHARACTER button (10)
- 3 REPEAT button (8)
- 4 Display window (7, 8)
- 5 DISPLAY button (8)
- 6 EDIT/NO button (10)
- 7 CD □ (eject) button (7)
- 8 ENTER/YES button (9, 10)
- 9 Disc tray (7)
- 10 ▷ (play/pause) button (7)
- 11 ◀ (fast backward) button (8)
- 12 JOG dial (7)
- 13 ► (fast forward) button (8)
- 14 □ (stop) button (7)

MiniDisc deck section



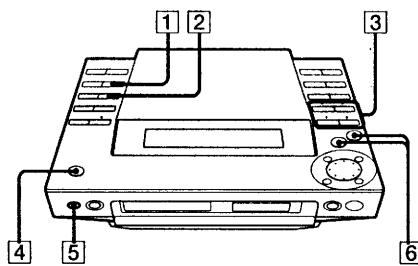
- 1 PLAY MODE button (13)
- 2 CHARACTER button (21)
- 3 REPEAT button (12)
- 4 Display window (11, 12)
- 5 REC PAUSE button (15)
- 6 CD SYNCHRO button (15)
- 7 DISPLAY button (12)
- 8 SCROLL button (12, 21)
- 9 REC button (16)
- 10 REC STOP button (15)
- 11 EDIT/NO button (15, 18)
- 12 ENTER/YES button (13, 15, 18)
- 13 Disc slot (11)
- 14 ▷ (play/pause) button (11)
- 15 ◀ (fast backward) button (12)
- 16 MD □ (eject) button (11)
- 17 JOG dial (11)
- 18 ► (fast forward) button (12)
- 19 □ (stop) button (11)

Tuner section



- 1 CHARACTER button (23)
- 2 CLOCK button (6)
- 3 TIMER SELECT button (27)
- 4 TIMER SET button (26)
- 5 STEREO/MONO button (22)
- 6 Display window (22)
- 7 DISPLAY button (24)
- 8 TUNER/BAND button (22)
- 9 TUNING button (22)
- 10 EDIT/NO button (23)
- 11 ENTER/YES button (23)
- 12 JOG dial (22)

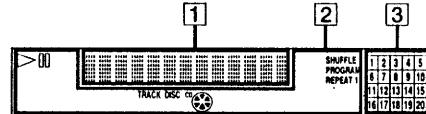
Amplifier section



- [1] BASS/TREBLE button (25)
[2] BALANCE button (25)
[3] FUNCTION buttons
 TAPE button (16, 28)
 MD button (11, 18)
 CD button (7, 16)
 TUNER/BAND button (16, 22)
[4] POWER switch (7, 27)
[5] PHONES jack (25)
[6] VOLUME +/- buttons (25)

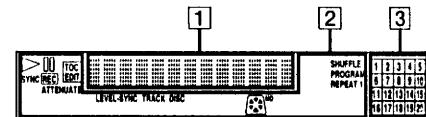
Display Window

CD player section



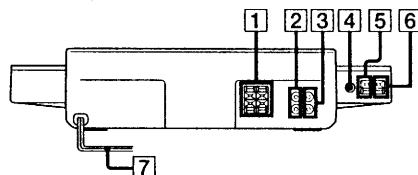
- [1] Playing time/track number indication (7)
[2] CD indication
 ▷ (play/pause) (7)
 REPEAT 1 (8)
 SHUFFLE (9)
 PROGRAM (9)
 DISC (7)
 TRACK (7)
[3] Music calendar (7)

MD deck section



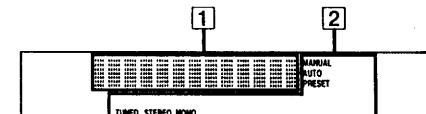
- [1] Playing time/track number/title indication (11)
[2] MD indication
 ▷ (play/pause) (11)
 [REC] (15)
 SYNC (synchro) (15)
 LEVEL-SYNC (level synchro) (14)
 [TOC EDIT] (TOC edit) (15)
 REPEAT 1 (12)
 SHUFFLE (13)
 PROGRAM (13)
 DISC (11)
 TRACK (11)
[3] Music calendar (11)

Rear Panel



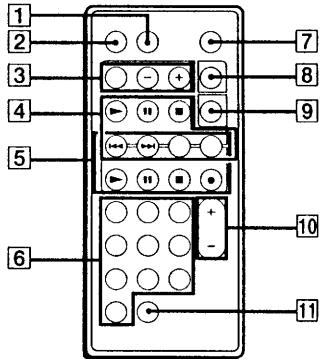
- [1] SPEAKER connectors (4)
[2] TAPE OUT jacks (28)
[3] TAPE IN jacks (28)
[4] FM 75 Ω COAXIAL connector (4)
[5] μ (earth) terminal (4)
[6] AM terminal (4)
[7] Mains lead (5)

Tuner section



- [1] Frequency/time/station name indications (6, 22, 23, 26)
[2] Tuner indications
 TUNED (22)
 STEREO MONO (22)
 MANUAL (22)
 AUTO (22)
 PRESET (24)

Remote (RM-SMJ1)

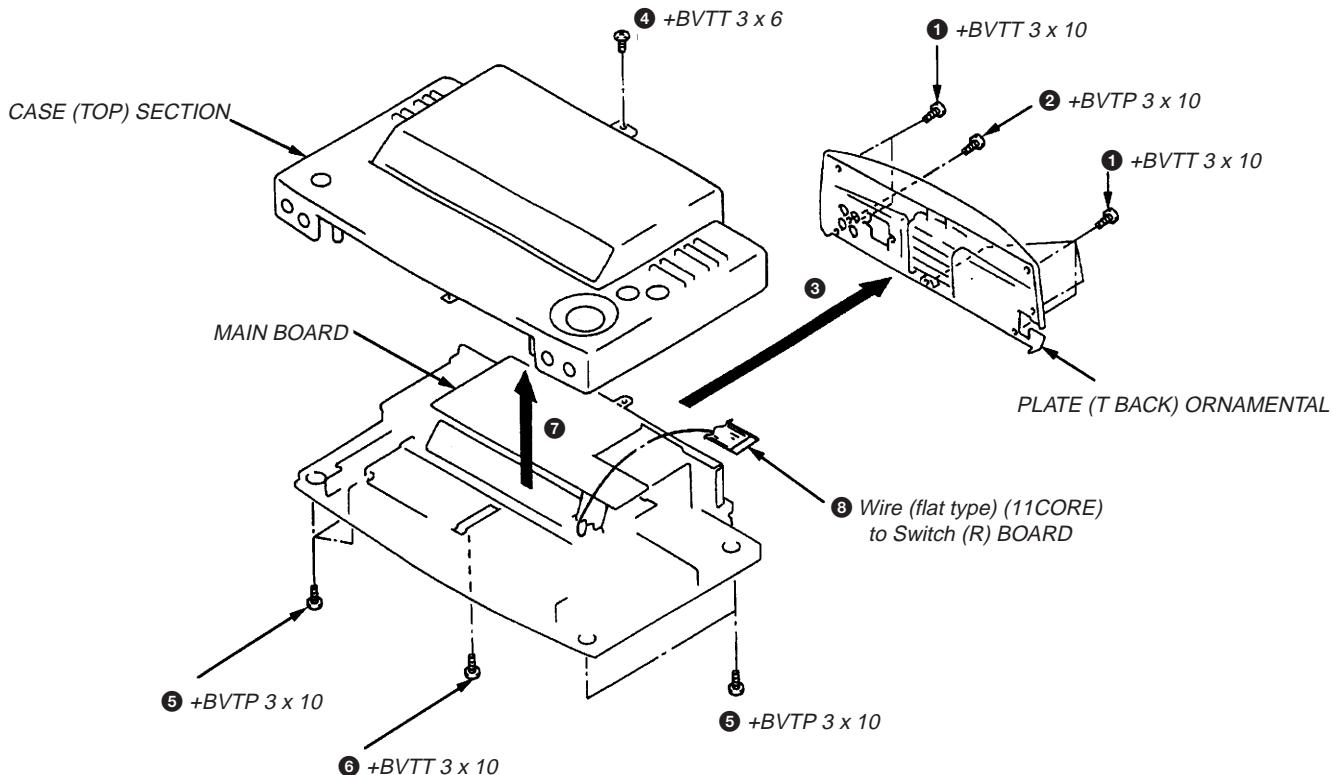


- 1** SLEEP button (26)
- 2** FUNCTION button (16)
- 3** Tuner operating buttons
BAND button (22)
PRESET + / - buttons (24)
- 4** CD operating buttons
 - ▶ (play) button (7)
 - (pause) button (7)
 - (stop) button (7)
 - ◀◀ (search backward) button (7)
 - ▶▶ (search forward) button (7)
 - REPEAT button (8)
 - P.MODE (play mode) button (9)
- 5** MD operating buttons
 - ▶ (play) button (11)
 - (pause) button (11)
 - (stop) button (11)
 - ◀◀ (search backward) button (11)
 - ▶▶ (search forward) button (11)
 - REC button (16)
 - REPEAT button (12)
 - P.MODE (play mode) button (13)
- 6** Numeric buttons (7, 11, 24)
- 7** POWER button (7)
- 8** DISPLAY button (8, 12)
- 9** SCROLL button (12, 21)
- 10** VOL +/- buttons (25)
- 11** >10 button (7, 11, 24)

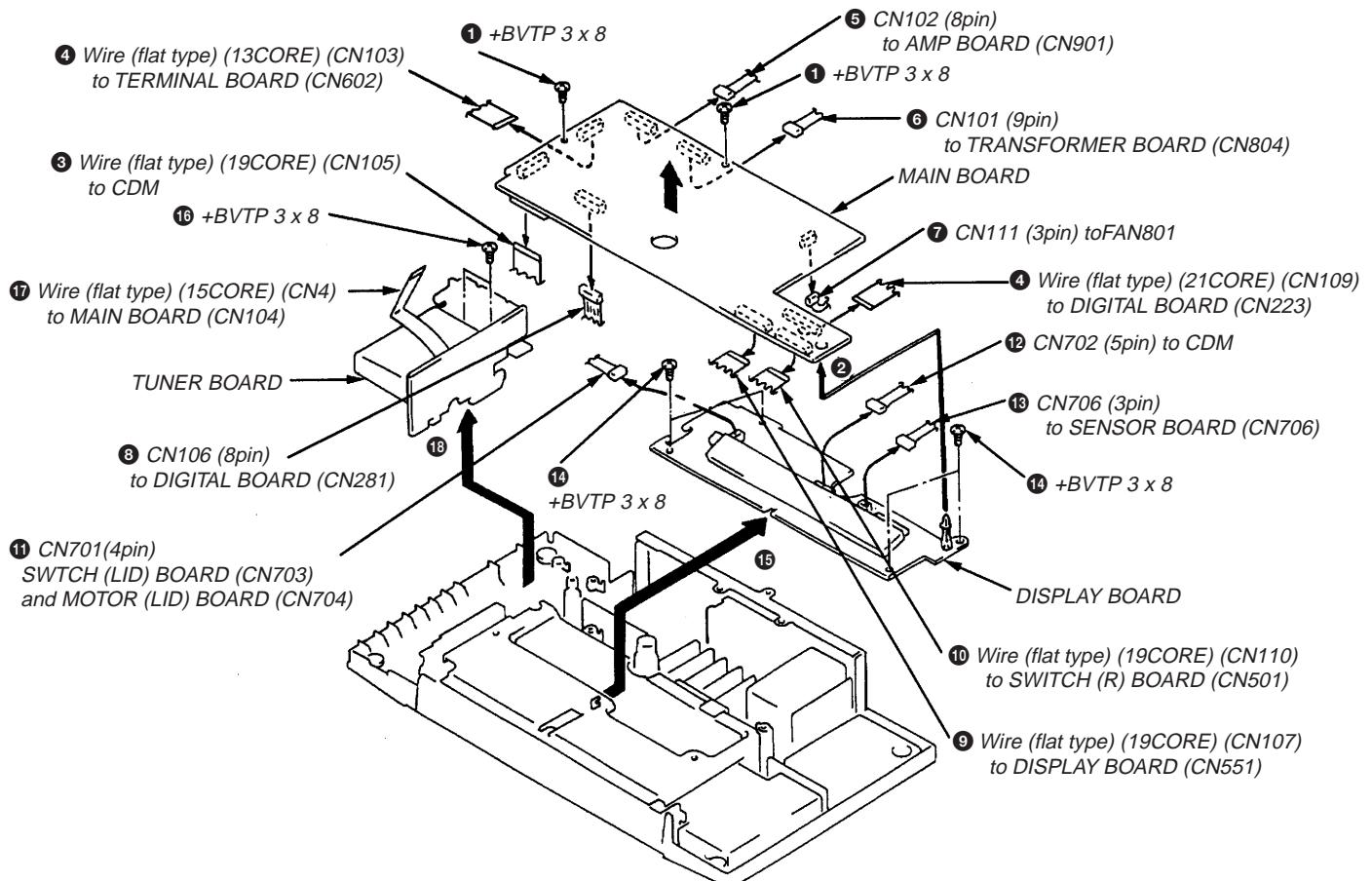
SECTION 3 DISASSEMBLY

Note : Follow the disassembly procedure in the numerical order given.

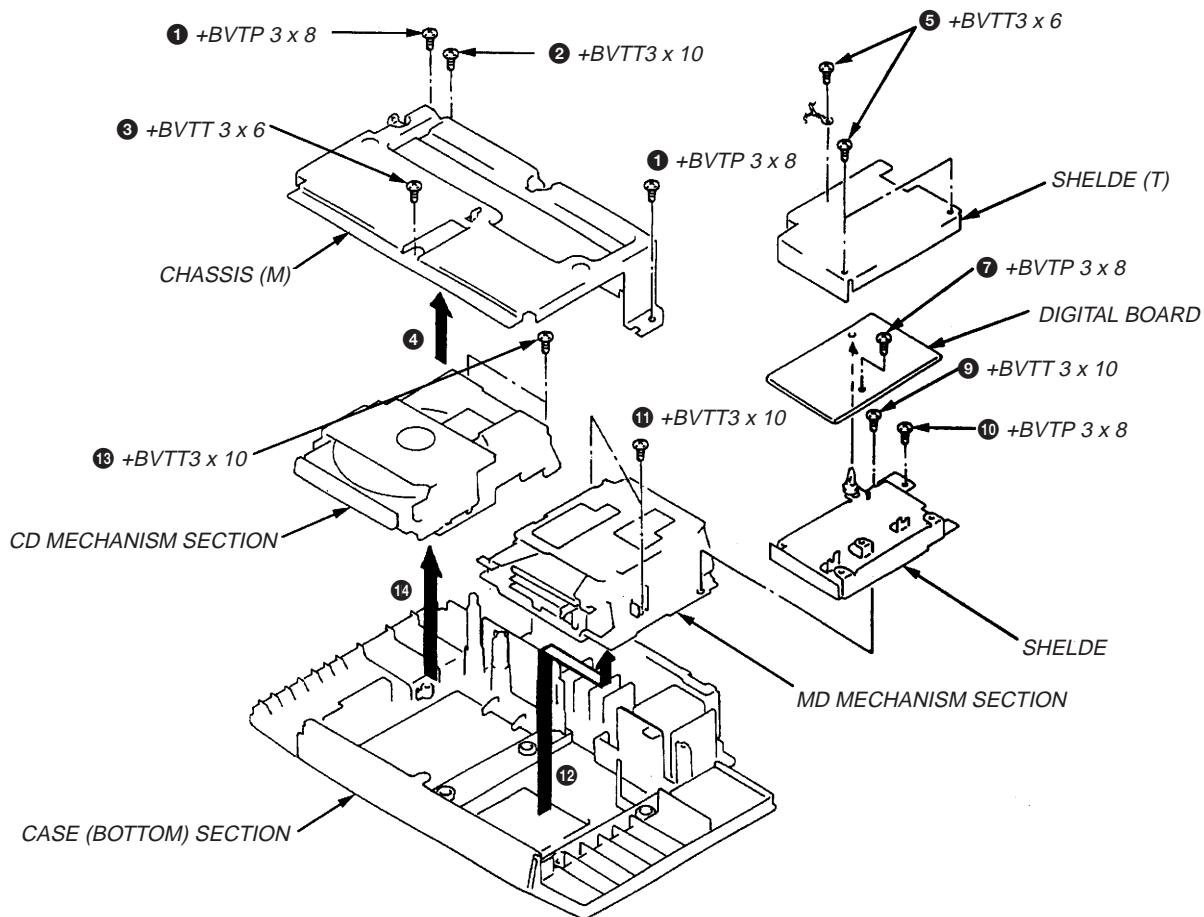
3-1. CASE (TOP) SECTION AND PLATE (T BACK) ORNAMENTAL REMOVAL



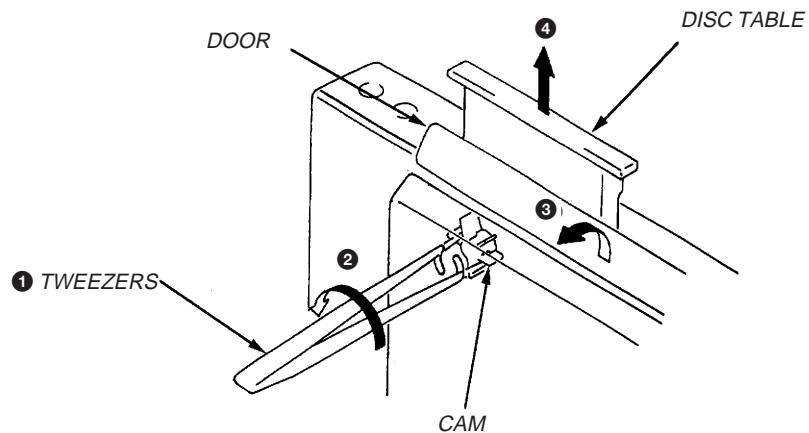
3-2. MAIN BOARD, TUNER BOARD AND DISPLAY BOARD REMOVAL



3-3. CD MECHANISM, MD MECHANISM AND DIGITAL BOARD REMOVAL



SECTION 4
DISC TABLE GETTING OUT PROCEDURE ON THE POWER SUPPLY IS OFF



SECTION 5 TEST MODE

5-1. How to enter the Test Mode

With the power switched off and the power plug plugged into a socket, press the BASS/TREBLE button, CLOCK button, and MD button more than one at a time in order.

5-2. How to Release the Test Mode

Press the REPEAT button.

5-3. Basic Operations of the Test Mode

All operations are performed using the JOG dial (Rotary Encoder) , YES (ENTR/TES)button, and NO (EDIT/ON)button.
The functions of these keys are as follows.

Function	Contents
JOG dial	Changes parameters and modes.
YES button	Proceeds onto the next step. Finalizes input
NO button	Returns to previous step. Stops operations.

5-4. Selecting the Test Mode

Eight test modes are selected by turning the AMS knob.

Display	Contents
TEMP ADJUST	Temperature compensation offset adjustment
LDPWR ADJUST	Laser power adjustment
EFBAL ADJUST	Traverse adjustment
FBIAS ADJUST	Focus bias adjustment
FBIAS CHECK	Focus bias check
CPLAY MODE	Continuous playback mode
CREC MODE	Continuous recording mode
EEP MODE	Non-volatile memory mode*

For detailed description of each adjustment mode, refer to 6. Electrical Adjustments.

If a different adjustment mode has been selected by mistake, press the NO button to exit from it.

* The EEP MODE is not used in servicing. If set accidentally, press the NO button immediately to exit it.

5-5-1. Operating the Continuous Playback Mode

1. Entering the continuous playback mode

- ① Set the disc in the unit (either MO or CD).
- ② Rotate the JOG dial and display “CPLAY MODE”.
- ③ Press the YES button to change the display “CPLAY IN”.
- ④ When access completes, the display changes to “C1 = 00000 AD = 00”

Note : The “00” displayed are arbitrary numbers.

2. Changing the parts to be played back

- ① Press the YES button during continuous playback to change the display to “CPLAY MID”, “CPLAY OUT”.
When pressed another time, the parts to be played back can be changed.
- ② When access completes, the display changes to “C1 = 00000 AD = 00”

Note : The “00” displayed are arbitrary numbers.

3. Ending the continuous playback mode

- ① Press the NO button. The display will change to “CPLAY MODE”.
- ② Press the MD button and remove the disc.

Note 1 : The playback start addresses for IN, MID, and OUT are as follows.

Press the DISPLAY button twice to display the address. Pressing the DISPLAY button again returns the display to

“C1 = 00000 AD = 00”

IN 40h cluster

MID 300h cluster

OUT 700h cluster

5-5-2. Operating the Continuous Recording Mode

1. Entering the continuous recording mode

- ① Set the MO disc in the unit.
- ② Rotate the JOG dial knob and display “CREC MODE”.
- ③ Press the YES button to change the display to “CREC IN”.
- ④ When access completes, the display changes to “CREC (arbitrary numbers)” and REC lights up.

Note : The “ arbitrary numbers ” displayed are arbitrary numbers.

2. Changing the parts to be recorded

- ① When the YES button is pressed during continuous recording, the display changes to “CREC MID”, “CREC OUT” and REC goes off. When pressed another time, the parts to be recorded can be changed.
- ② When access completes, the display changes to “CREC (arbitrary numbers)” and REC lights up.

Note : The “ arbitrary numbers ” displayed are arbitrary numbers.

3. Ending the continuous recording mode

- ① Press the No button. The display changes to “CREC MODE” and REC goes off.
- ② Press the MD \triangle button and remove the disc.

Note 1 : The recording start addresses for IN, MID, and OUT are as follows.

IN	40h cluster
MID	300h cluster
OUT	700h cluster

Note 2 : The No button can be used to stop recording anytime.

Note 3 : During the test mode, the erasing-protection tab will not be detected. Therefore be careful not to set the continuous recording mode when a disc not be erased is set in the unit.

Note 4 : Do not perform continuous recording for long periods of time above 5 minutes.

Note 5 : During continuous recording, be careful not to apply vibration.

5-5-3. Non-Volatile Memory Mode (EEP MODE)

This mode reads and writes the contents of the nonvolatile memory.

It is not used in servicing. If set accidentally, press the No button immediately to exit it.

5-6. Functions of Other buttons

Function	Contents
▶■	Sets continuous playback when pressed in the STOP state. When pressed during continuous playback, the tracking servo turns ON/OFF.
■	Stops continuous playback and continuous recording.
▶▶	The sled moves to the outer circumference only when this is pressed.
◀◀	The sled moves to the inner circumference only when this is pressed.
●	Turns recording ON/OFF when pressed during continuous playback.
SCROLL	Switches between the pit and groove modes when pressed.
DISPLAY	Switches the display when pressed. Returns to previous step. Stops operations.

Note : The erasing-protection tab is not detected during the test mode. Recording will start regardless of the position of the erasing-protection tab when the ● (REC) button is pressed.

5-7. Test Mode Displays

Each time the DISPLAY button is pressed, the display changes in the following order.

MODE display→Error rate display→Address display

1. MODE display

Displays “TEMP ADJUST”, “CPLAY MODE”, etc.

2. Address display

Addresses are displayed as follows.

$h = \square \square \square \square$ $s = \square \square \square \square$ (MO pit and CD)

$h = \square \square \square \square$ $a = \square \square \square \square$ (MO groove)

h = Header address

s = SUBQ address

a = ADIP address

* A ‘ ’ display appears when the address cannot be loaded.

3. Error rate display

Error rates are displayed as follows.

$C1 = \square \square \square \square$ $AD = \square \square \square \square$

$C1$ = Indicates C1 error

AD = Indicates ADER

5-8. Meanings of Other Displays

Display	Contents		
	Light	Off	Blinking
▶	During continuous playback	STOP	
▶■	Tracking servo OFF	Tracking servo ON	
REC	Recording mode ON	Recording mode OFF	
SYNC	CLV LOCK	CLV UNLOCK	
TRACK	Pit	Groove	
DISC	High reflection	Low reflection	
LEVEL-SYNC	CLV-S	CLV-A	
MEMORY	ABCD adjustment completed		
SHUFFLE	(Focus auto gain successful Tracking auto gain successful)		(Focus auto gain successful Tracking auto gain failed)

5-9. Precautions for Use of Test Mode

② As loading related operations will be performed regardless of the test mode operations being performed, be sure to check that the disc is stopped before setting and removing it.

Even if the MD \triangle button is pressed while the disc is rotating during continuous playback, continuous recording, etc., the disc will not stop rotating.

Therefore, it will be ejected while rotating.

* Always press the NO button before pressing the MD \triangle button.

② The erasing-protection tab is not detected in the test mode. Therefore, when modes which output the recording laser power such as continuous recording mode and traverse adjustment mode, etc. are set, the recorded contents will be erased regardless of the position of the tab. When using a disc that is not to be erased in the test mode, be careful not enter the continuous recording mode and traverse adjustment mode.

SECTION 6

ELECTRICAL ADJUSTMENTS

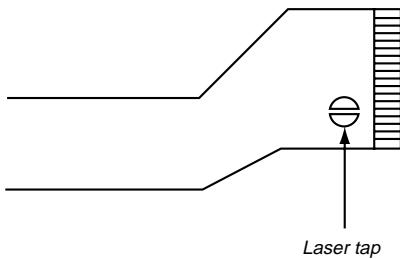
PRECAUTION

6-1. Precautions for Checking Laser Diode Emission

To check the emission of the laser diode during adjustments, never view directly from the top as this may lose your eye-sight.

6-2. Precautions for Use of optical pickup (KMS-210A)

As the laser diode in the optical pickup is easily damaged by static electricity, solder the laser tap of the flexible board when using it. Before disconnecting the connector, desolder first. Before connecting the connector, be careful not to remove the solder. Also take adequate measures to prevent damage by static electricity. Handle the flexible board with care as it breaks easily.



Optical pickup flexible board

6-3. Precautions for Adjustments

- 1) when replacing the following parts, perform the adjustments and checks with O in the order shown in the following table.

	Optical pickup	BD (MD) BOARD		
		IC171	D101	IC101,IC121,IC191
1. Temperature compensation offset adjustment	X	O	O	O
2. Laser power adjustment	O	X	X	O
3. Traverse adjustment	O	O	X	O
4. Focus bias adjustment	O	O	X	O
5. Error rate check	O	O	X	O

- 2) Set the test mode when performing adjustments.

After completing the adjustments, exit the test mode.

- 3) Perform the adjustments in the order shown.

- 4) Use the following tools and measuring devices.

- Test disc (CD) TDYS-1 (Parts No. 4-963-646-01)
- Laser power meter LPM-8001 (Parts No. J-2501-046-A)
- Oscilloscope
- Digital voltmeter
- Thermometer

- 5) When observing several signals on the oscilloscope, etc., make sure that VC and GND do not connect inside the oscilloscope.

(VC and GND will become short-circuited)

- 6) Do not move RV105 of the BD (MD) board. When replacing it, adjust to the mechanical center of the semi-fixed resistor.

6-4. Creating MO Continuously Recorded Disc

- * This disc is used in focus bias adjustment and error rate check. The following describes how to create a MO continuous recording disc.

1. Insert a MO disc (blank disc) commercially available.
2. Rotate the JOG dial and display "CREC MODE".
3. Press the YES button and display "CREC IN".
4. Press the YES button again to display "CREC MID".
"CREC (0300)" is displayed for a moment and recording starts.
5. Complete recording within 5 minutes.
6. Press the NO button and stop recording
7. Press the MD \triangleleft button and remove the MO disc.

The above has been how to create a continuous recording data for the focus bias adjustment and error rate check.

Note :

- Be careful not to apply vibration during continuous recording.

6-5. Temperature Compensation Offset Adjustment

Save the temperature data at that time in the non-volatile memory as 25°C reference data.

Note :

1. Usually, do not perform this adjustment.
2. Perform this adjustment in an ambient temperature of 22°C to 28°C. Perform it immediately after the power is turned on when the internal temperature of the unit is the same as the ambient temperature.
3. When D101 has been replaced, perform this adjustment after the temperature of this part has become the ambient temperature.

Adjusting Method :

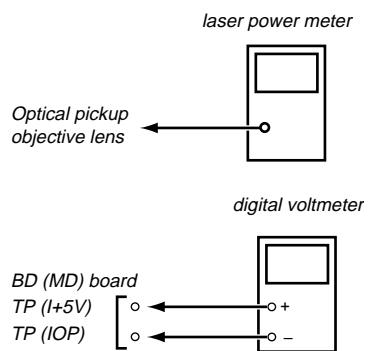
1. Rotate the JOG dial and display “TEMP ADJUST”.
2. Press the YES button and select the “TEMP ADJUST” mode.
3. “TEMP = $\square \square$ ” and the current temperature data will be displayed
4. To save the data, press the YES button.
When not saving the data, press the NO button.
5. When the YES button is pressed, “TEMP = $\square \square$ SAVE” will be displayed for some time, followed by “TEMP ADJUST”.
When the NO button is pressed, “TEMP ADJUST” will be displayed.

Specifications :

The temperature should be within “TEMP = EO” to “TEMP = IF”.

4-6. Laser Power Adjustment

Connection :

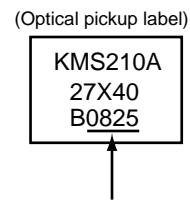


Adjusting Method :

1. Set the laser power meter on the objective lens of the optical pickup.
(When it cannot be set properly, press the \blacktriangleleft button or \triangleright button and move the optical pickup.)
Connect the digital voltmeter to TP (IOP) and TP (I+5V).
2. Rotate the JOG dial and display “LDPWR ADJUST”.
(Laser power : For adjustment)
3. Press the YES button twice and display “LD \$ 4B = 3.5mW”.
4. Adjust RV102 of the BD (MD) board so that the reading of the laser power meter becomes $3.4^{+0.1}$ mW.
5. Press the YES button and display “LD \$ 96 = 7.0mW”.
(Laser power : MO writing)
6. Check that the laser power meter and digital voltmeter readings satisfy the specified value.

Specification :

Laser power meter reading : 7.0 ± 0.3 mW
Digital voltmeter reading : Optical pickup displayed value
 $\pm 10\%$



IOP = 82.5mA in this case

IOP (mA) = Digital voltmeter reading (mV) / $1(\Omega)$

7. Press the YES button and display “LD \$ 0F = 0.7mW”.
(Laser power : MO reading)
8. Check that the laser power meter at this time satisfies the specified value.

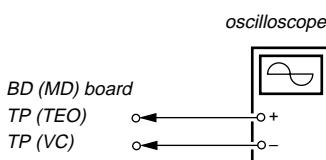
Specification :

Laser power meter reading : 0.70 ± 0.1 mW

9. Press the NO button and display “LDPWR ADJUST”, and stop laser emission.
(The NO button is effective at all times to stop the laser emission.)

6-7. Traverse Adjustment

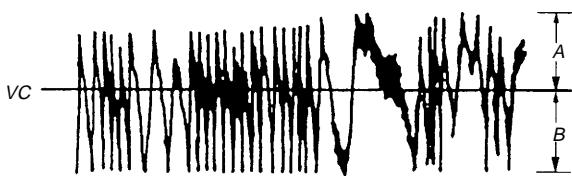
Connection :



Adjusting Method :

1. Connect an oscilloscope to TP (TEO) and TP (VC) of the BD (MD) board.
2. Load a MO disc (any available on the market).
3. Press the \blacktriangleleft button or \triangleright button and move the optical pickup outside the pit.
4. Rotate the JOG dial and display "EFBAL ADJUST".
5. Press the YES button and display "EFBAL MO-W".
(Laser power WRITE power/Focus servo ON/tracking servo OFF/spindle (S) servo ON)
6. Adjust RV101 of the BD (MD) board so that the waveform of the oscilloscope becomes the specified value.
(MO groove write power traverse adjustment)

(Traverse Waveform)



Specification : $A = B$

7. Press the YES button and display "EFB = \$ \square MO-R".
(Laser power : MO reading)
8. Rotate the JOG dial so that waveforms of the oscilloscope becomes the specified value.
(When the JOG dial is rotated, the \square of "EFB = \square " changes and the waveform changes.) in this adjustment, waveform varies at intervals of approx. 3%. Adjust the waveform so that the specified value is satisfied as much as possible.
(MO groove read power traverse adjustment)

(Traverse Waveform)



Specification : $A = B$

9. Press the YES button, display "EFB = \$ \square SAVE" for a moment and save the adjustment results in the non-volatile memory.
Next "EFBAL MO-P" is displayed.
10. Press the YES button and display "EFB = \$ \square MO-P".
The optical pickup moves to the pit area automatically and servo is imposed.

11. Rotate the JOG dial until the waveforms of the oscilloscope moves closer to the specified value.

In this adjustment, waveform varies at intervals of approx. 3%. Adjust the waveform so that the specified value is satisfied as much as possible.

(Traverse Waveform)



Specification : $A = B$

12. Press the YES button, display "EFB = \square SAVE" for a moment and save the adjustment results in the non-volatile memory.
Next "EFBAL CD" is displayed. The disc stops rotating automatically.
13. Press the MD \triangleleft button and remove the MO disc.
14. Load the test disc TDYS-1.
15. Press the YES button and display "EFB = \square CD". Servo is imposed automatically.
16. Rotate the JOG dial so that the waveforms of the oscilloscope moves closer to the specified value.
In this adjustment, waveform varies at intervals of approx. 3%. Adjust the waveform so that the specified value is satisfied as much as possible.

(Traverse Waveform)

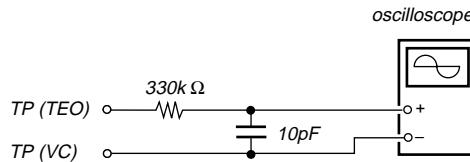


Specification : $A = B$

17. Press the YES button, display "EFB = \$ \square SAVE" for a moment and save the adjustment results in the non-volatile memory.
Next "EFBAL ADJUST" is displayed.
18. Press the MD \triangleleft button and remove the test disc TDYS-1.

Note 1) Data will be erased during MO reading if a recorded disc is used in this adjustment.

Note 2) If the traverse waveform is not clear, connect the oscilloscope as shown in the following figure so that it can be seen more clearly.



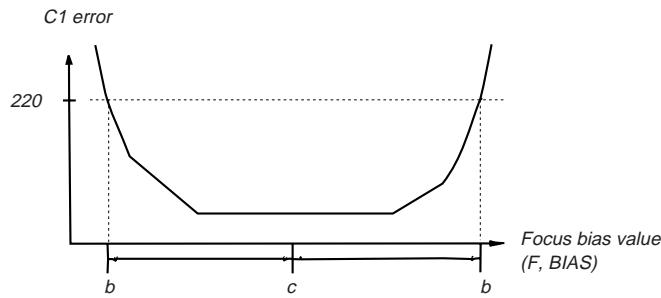
6-8. Focus Bias Adjustment

Adjusting Method :

1. Load a continuously recorded disc (Refer to “6-4. Creating MO Continuously Recorded Disc”.)
2. Rotate the JOG dial and display “CPLAY MODE”.
3. Press the YES button twice and display “CPLAY MID”.
4. Press the NO button when “C1 = 0000 AD = 00” is displayed.
5. Rotate the JOG dial and display “FBIAS ADJUST”.
6. Press the YES button and display “0000 / 00 a = 00”.
The first four digits indicate the C1 error rate, the two digits after [/] indicate ADER, and the 2 digits after [a =] indicate the focus bias value.
7. Rotate the JOG dial in the clockwise direction and find the focus bias value at which the C1 error rate becomes 220.
8. Press the YES button and display “0000 / 00 b = 00”.
9. Rotate the JOG dial in the counterclockwise direction and find the focus bias value at which the C1 error rate becomes 220.
10. Press the YES button and display “0000 / 00 c = 00”.
11. Check that the C1 error rate is below 50 and ADER is 00.
Then press the YES button.
12. If the “(00)” in “0000 / 00 (00)” is above 20, press the YES button.
If below 20, press the NO button and repeat the adjustment from step 2 again.
13. Press the NO button and press the MD \triangleleft button to remove the continuously recorded disc.

Note 1 : The relation between the C1 error and focus bias is as shown in the following figure. Find points a and b in the following figure using the above adjustment. The focal point position c is automatically calculated from points a and b.

Note 2 : As the C1 error rate changes, perform the adjustment using the average vale.



6-9. Error Rate Check

6-9-1. CD Error Rate Check

Checking Method :

1. Load a test disc TDYS-1.
2. Rotate the JOG dial and display “CPLAY MODE”.
3. Press the YES button twice and display “CPLAY MID”.
4. “C1 = 0000 AD = - -” is displayed.
5. Check that the C1 error is below 20.
6. Press the NO button, stop playback, press the MD \triangleleft button, and remove the test disc.

6-9-2. MO Error Rate Check

Checking Method :

1. Load a continuously recorded disc (Refer to “6-4. Creating MO Continuously Recorded Disc”.)
2. Rotate the JOG dial and display “CPLAY MODE”.
3. Press the YES button twice and display “CPLAY MID”.
4. “C1 = 0000 AD = 00” is displayed
5. If the C1 error rate is below 50, check that ADER is 00.
6. Press the NO button, stop playback, press the MD \triangleleft button, and remove the continuously recorded disc.

6-10. Focus Bias Check

Change the focus bias and check the focus tolerance amount.

Checking Method :

1. Load a continuously recorded disc (Refer to “6-4. Creating MO Continuously Recorded Disc”.)
2. Rotate the JOG dial and display “CPLAY MODE”.
3. Press the YES button twice and display “CPLAY MID”.
4. Press the NO button when “C1 = 0000 AD = 00” is displayed
5. Rotate the JOG dial and display “FBIAS CHECK”.
6. Press the YES button and display “0000 / 00 c = 00”.

The first four digits indicate the C1 error rate, the two digits after [/] indicate ADER, and the 2 digits after [c =] indicate the focus bias value.

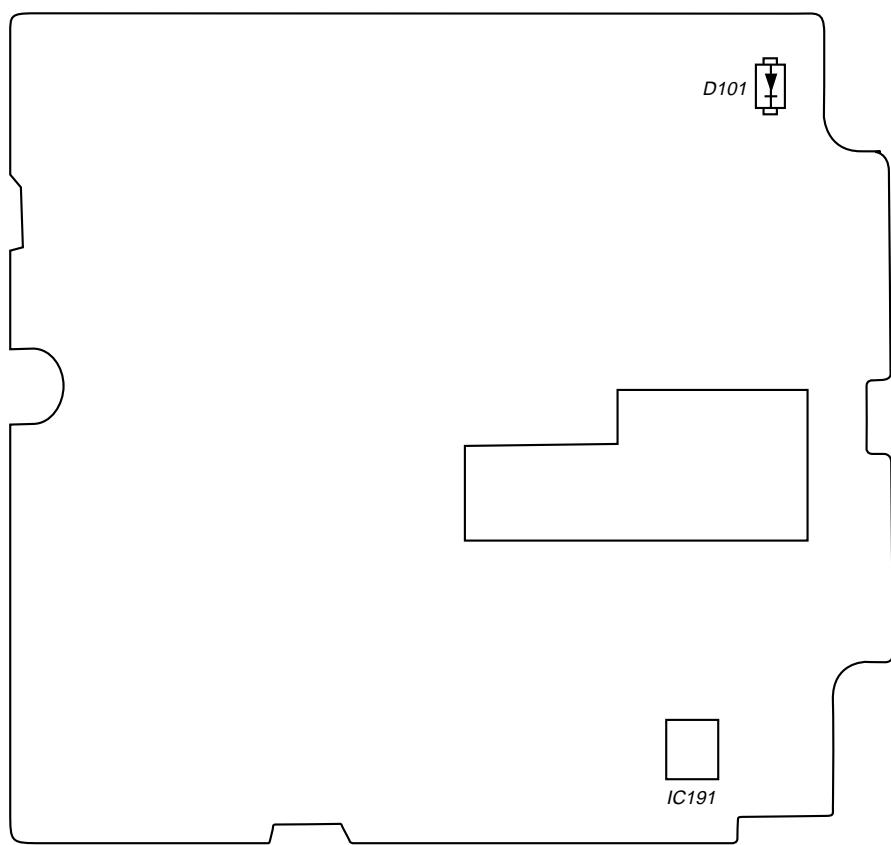
Check that the C1 error is below 50 and ADER is 00.

7. Press the YES button and display “0000 / 00 b = 00”.
Check that the C1 error is not below 220 and ADER is not above 00 every time.
8. Press the YES button and display “0000 / 00 a = 00”.
Check that the C1 error is not below 220 and ADER is not above 00 every time.
9. Press the NO button, next press the MD \triangleleft button, and remove the continuously recorded disc.

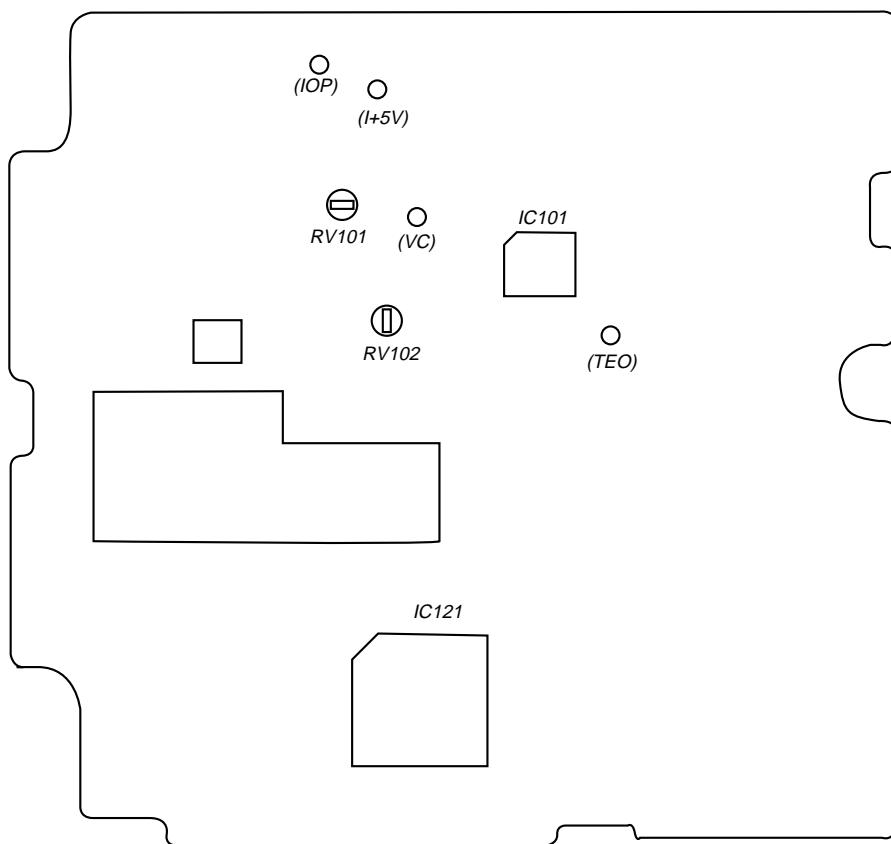
Note 1 : If the C1 error and ADER are above 00 at points a or b, the focus bias adjustment may not have been carried out properly. Adjust perform the beginning again.

6-11. Adjusting Points and Connecting Points

[BD (MD) BOARD] (Component side)



[BD (MD) BOARD] (Conductor side)



TUNER SECTION

As a front-end (TB1) is difficult to repair if faulty, replace it with new one.

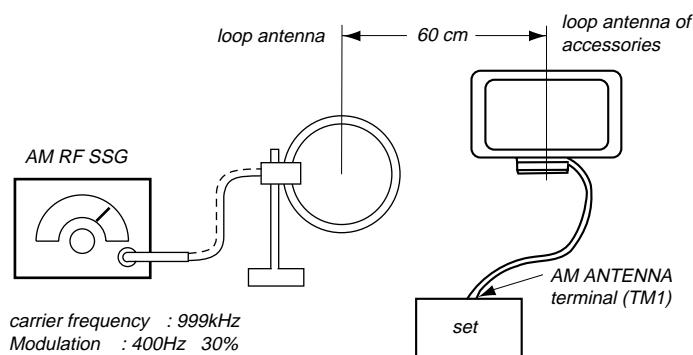
But AEP, UK, German, and Italian model are please note, however, that the following adjustments are possible:

AM Section Adjustment

AM Tuned Indication Lighting Level Adjustment

Band : AM

Setting :



Procedure :

1. Set AM RF SSG output level to 81dB μ so that the input level becomes 55dB μ .
2. Tune the set to 999kHz .
3. Adjust RV(AM TUNED LEVEL ADJUSTMENT) so that the TUNED light up.

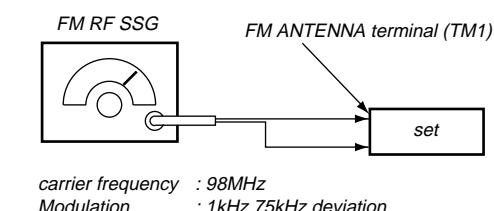
Adjustment Location : TB1 (TUNER board)

FM Section Adjustment

FM Tuned Indication Lighting Level Adjustment

Band : FW

Setting :



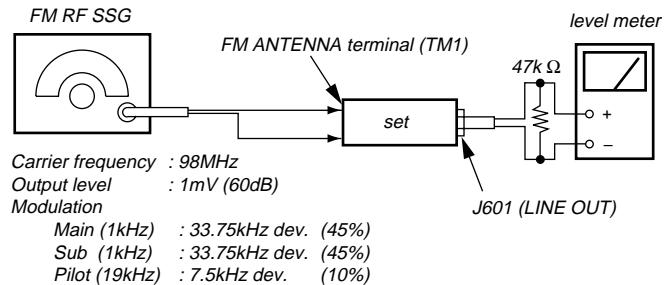
Procedure :

1. Supply a 17.8 μ V (25dB μ) 98MHz signal to the ANTENNA terminal.
2. Tune the set to 98MHz.
3. Adjust RV(FM TUNED LEVEL ADJUSTMENT) so that the TUNED light up.

Adjustment Location : TB1 (TUNER board)

FM Stereo Separation Adjustment

Setting :



Procedure :

Turn the set to 98MHz.

FM stereo signal generator output channel	VTVM connection	VTVM reading (dB)
L-CH	L-CH	(A)
		(B)
R-CH	L-CH	Adjust RV (FM STEREO SEPARATION ADJUSTMENT) for minimum reading.
R-CH	R-CH	(C)
		(D)
L-CH	R-CH	Adjust RV (FM STEREO SEPARATION ADJUSTMENT) for minimum reading.

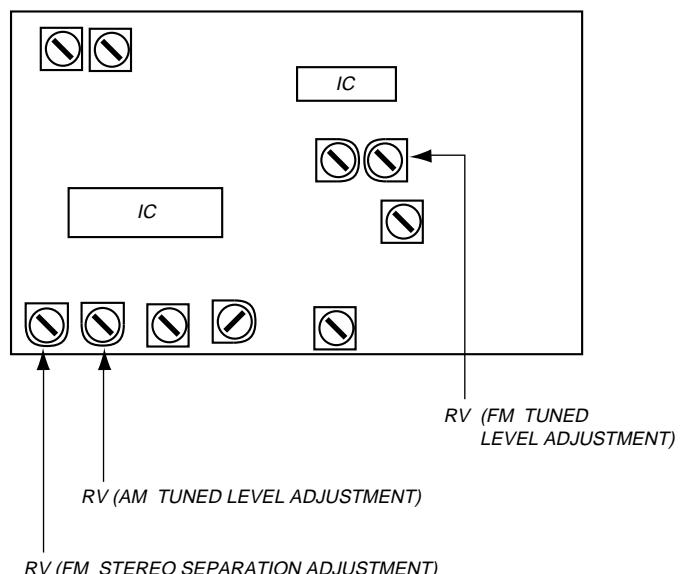
L-CH Stereo separation : (A) - (B)

R-CH Stereo separation : (C) - (D)

The separations of both channels should be equal.

Adjustment Location : TB1 (TUNER board)

[TB1 TUNER BOARD] (Conductor side)



CD SECTION

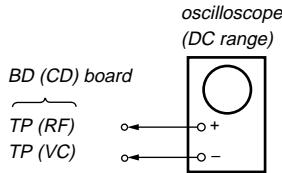
NOTE :

1. CD Block basically constructed to operate without adjustment. Therefore, check each item in order given.
2. Use YEADS-18 disc (3-702-101-01) unless otherwise indicated.
3. Use the oscilloscope with more than $10M\Omega$ impedance.
4. Clean an object lens by an applicator with neutral detergent when the signal level is low than specified value with the following checks.

Focus Bias Adjustment

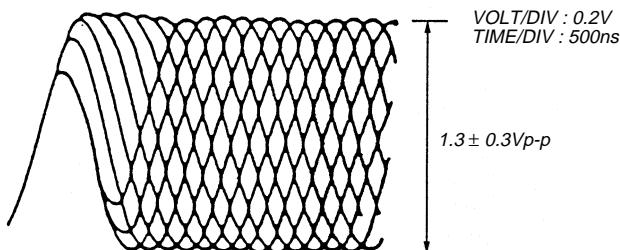
This adjustment is to be done when the optical block is replaced.

Adjustment procedure :



1. Connect oscilloscope to test point TP (VC) and TP (RF) on BD (CD) board.
2. Connect TP ADJ (IC301 ⑧ pin) to ground with lead wire on Main board.
3. Turned power switch ON. (Stop mode)
4. Put disc (YEADS-18) in and press the $\blacktriangleright \text{II}$ button.
5. Press the $\blacktriangleright \text{II}$ button (Tracking servo ON).
6. Adjust RV101 so that the oscilloscope waveform is as shown in the figure below (eye pattern).
A good eye pattern means that the diamond shape () in the center of the waveform can be clearly distinguished.
7. After adjustment, remove the lead wire connected in step 2.

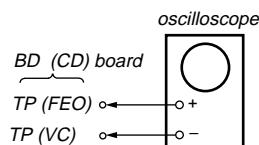
● RF signal reference waveform (eye pattern)



When observing the eye pattern, set the oscilloscope for AC range and raise vertical sensitivity.

Adjustment Location : BD (CD) board. (see page 13)

S-Curve Check

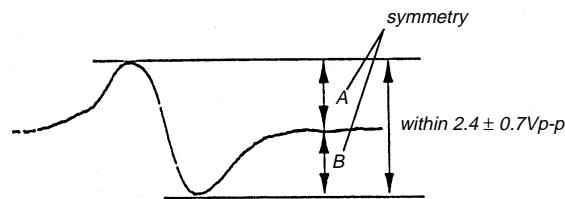


Procedure :

1. Connect oscilloscope to test point TP (VC) and TP (FEO) on BD (CD) board.

2. Connect between test point TP (FOK) and GND by lead wire.
3. Turned Power switch on.
4. Put disc (YEADS-18) in and turned Power switch on again and actuate the focus search. (actuate the focus search when disc table is moving in and out.)
5. Check the oscilloscope waveform (S-curve) is symmetrical between A and B. And confirm peak to peak level within $2.4 \pm 0.7Vp-p$.

S-curve waveform

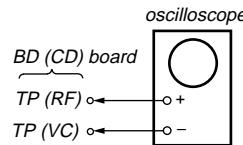


6. After check, remove the lead wire connected in step 2.

Note : ● Try to measure several times to make sure that the ratio of A : B or B : A is more than 10 : 7.
● Take sweep time as long as possible and light up the brightness to obtain best waveform.

Adjustment Location : BD (CD) board. (see page 13)

RF Level Check



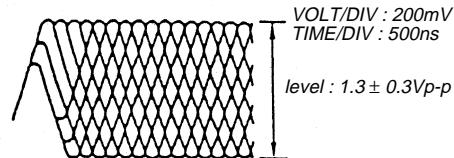
Procedure :

1. Connect oscilloscope to test point TP (VC) and TP (RF) on BD (CD) board.
2. Turned Power switch on.
3. Put disc (YEADS-18) in and press the $\blacktriangleright \text{II}$ button.
4. Confirm that oscilloscope waveform is clear and check RF signal level is correct or not.

Note :

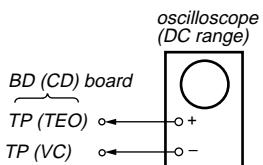
Clear RF signal waveform means that the shape “◊” can be clearly distinguished at the center of the waveform.

● RF signal waveform



Adjustment Location : BD (CD) board. (see page 13)

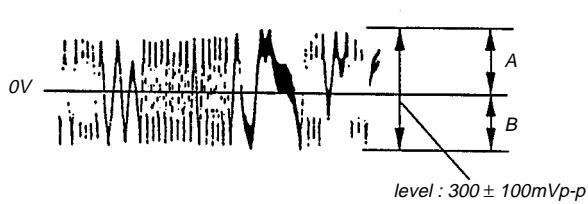
E-F Balance Check



Procedure :

1. Connect TP ADJ (IC301 ⑧ pin) to ground with lead wire on Main board.
2. Connect oscilloscope to test point TP (VC) and TP (TEO) on BD (CD) board.
3. Turned Power switch on.
4. Put disc (YEDS-18) in and press the **►II** button.
5. Confirm that the osilloscope waveform is symmetrical on the top and bottom in relation to 0V, and check this level.

Traverse waveform



$$\text{specified value : } \bullet \frac{A-B}{2(A+B)} \times 100 = \text{less than } \pm 7\% \\ \bullet A+B = 300 \pm 100 \text{mVp-p}$$

6. Remove the lead wire connected in step 1.

Focus/Tracking Gain Adjustment (RV102, RV103)

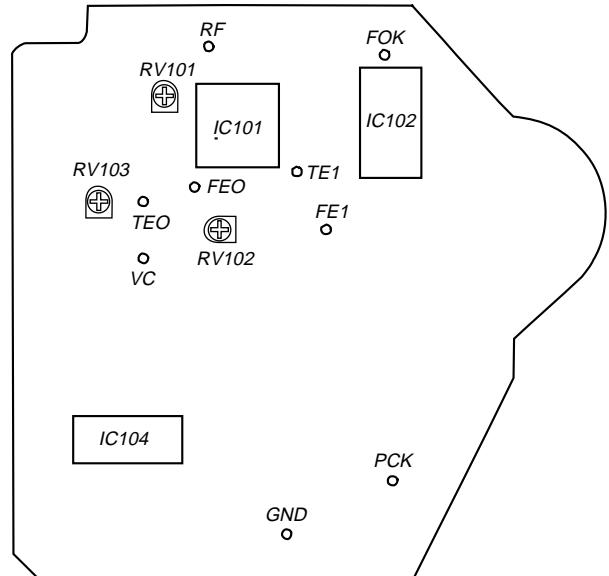
This gain has a margin, so even if it is slightly off. There is no problem.

Therefore, do not perform, this adjustment.

Please note that it should be fixed to mechanical center position when you moved and do not know original position.

Adjustment Location

[BD (CD) BOARD] (Conductor side)



SECTION 7

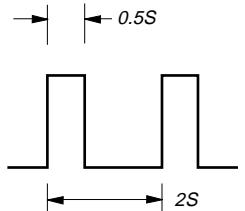
EXPLANATION OF IC TERMINALS

IC101 RF AMP (CXA1981AR)

Pin No.	Pin name	I/O	Description
1	VC	O	Output terminal for the center point voltage (+1.4V) generated.
2 – 7	A-F	I	Signal input from detector circuit in the optical pick-up block.
8	FI	I	Signal (-) input of the operational amplifier for F signal.
9	FO	O	Signal output of the operational amplifier for F signal.
10	PD	I	Front monitor. Connected to the photo diode.
11	APCREF	I	Input terminal for the setting of laser power.
12	TEMPI	I	Terminal for the connection to temperature sensor.
13	GND	-	Ground terminal.
14	AAPC	O	LD amplifier output terminal of APC circuit.
15	DAPC	O	Not used. (Open)
16	TEMPR	O	Output terminal of the reference voltage for temperature sensor.
17	XRST	I	Reset signal input from the system controller (IC201). When reset : "L"
18	SWDT	I	Write data signal input from the system controller (IC201).
19	SCLK	I	Clock signal input from the system controller (IC201).
20	XLAT	I	Latch signal input from the system controller (IC201).
21	VREF	O	Reference voltage output. Not used this set (Open)
22	TENV	O	Not used. (Open)
23	THLD	I	Not used. (Connected to the VC)
24	VCC	-	Power supply terminal. (+5V)
25	TFIL	I	Not used. (Open)
26	TE	O	Tracking error signal output to CXD2535BR (IC121).
27	TLB	I	Input terminal of the adder signal to tracking error.
28	CSLED	I	Terminal for the sled error lowpass filter.
29	SE	O	Sled error signal output to CXD2535BR (IC121).
30	ADFM	O	FM signal output terminal of the ADIP.
31	ADIN	I	Input terminal by AC coupling is FM signal of the ADIP.
32	ADAGC	I	External capacitor connect terminal for AGC of the ADIP.
33	ADFG	O	ADIP double turned FM signal output to CXD2535BR (IC121). (22.05kHz±1kHz)
34	AUX	O	Sub signal output to CXD2535BR (IC121).
35	FE	O	Focus error signal output to CXD2535BR (IC121).
36	FLB	I	Not used. (Open)
37	ABCD	O	Light amount signal output to CXD2535BR (IC121).
38	BOTM	O	Light amount bottom hold signal output to CXD2535BR (IC121).
39	PEAK	O	Light amount peak hold signal output to CXD2535BR (IC121).
40	PFAGC	I	External capacitor connect terminal of AGC circuit for the RF.
41	RF	O	Playback EFM RF signal output to CXD2535BR (IC121).
42	ISET	I	Setting terminal for the internal circuit constant. 22kHz, BPF center frequency
43	AGCT	I	Input terminal by AC coupling is RF signal.
44	RFO	O	RF signal output terminal.
45	MORFI	I	Input terminal by AC coupling is RF signal of the MO.
46	MORFO	O	RF signal output terminal of the MO.
47,48	I,J	I	Signal input from detector circuit in the optical pick-up block.

IC201 SYSTEM CONTROLLER (M37610MD-068FP)

Pin No.	Pin name	I/O	Description
1	C. SET1	I	Not used this set. (Fixed at "L")
2	C. SET0	I	Not used this set. (Fixed at "L")
3	KEY3	I	Key input terminal. Not used this set (Fixed at "L")
4 – 6	KEY2–KEY0	I	Key input terminal. Not used this set (Fixed at "L")
7		I	Not used this set. (Fixed at "L")
8	XINT	I	Interruption status input from CXD2536R (IC271).
9	SENS	I	Internal status (SENSE) input from CXD2535BR (IC121).
10	SHCK	I	Track jump signal input from CXD2535BR (IC121).
11	AUBK	I	Audio bus signal input. (Not used this set)
12	S/A	O	Sircs remote controller/audio bus selection signal output. (Not used this set)
13	BEEP SW	I	Not used this set. (Fixed at "L")
14	REC/OTHER	O	When recording :"L", Other :"H" (Not used this set).
15	BEEP	O	Buzzer signal output. (Not used this set)
16	F. BIAS/C2	I	Not used this set. (Fixed at "L")
17	GND (CNVSS)	—	Ground terminal.
18	SYSTEM RST	I	System reset signal input. "H" after several hundred ms of "L" after power start-up.
19	XIN T	I	Not used this set. (Fixed at "L")
20	XOUT T	O	Not used this set. (Fixed at "L")
21	GND	—	Ground terminal.
22	XIN	I	8MHz crystal oscillator input.
23	XOUT	O	8MHz crystal oscillator output.
24	+5V	—	Power supply terminal. (+5V)
25	STB	O	Strobe signal output to the power supply circuit. When power ON :"H", When standby :"L"
26, 27	MIC SW	I	Not used this set. (Fixed at "L")
28	BUS OUT	O	Not used this set. (Fixed at "L")
29		I	Not used this set. (Fixed at "L")
30, 31	LED2, LED1	I	Not used this set. (Fixed at "L")
32	LED0	O	Not used this set. (Fixed at "L")
33	C1	I	Not used this set. (Fixed at "L")
34	ADER	I	Not used this set. (Fixed at "L")
35	N. C.	I	Not used this set. (Fixed at "L")
36	MASTER/SLAVE	I	Not used this set. (Fixed at "H")
37, 38	JOG1, JOG0	I	Not used this set. (Fixed at "L")
39	SDA	I/O	Backup memory (IC171) data bus.
40	SCL	O	Clock signal output to the Backup memory (IC171).
41	POWER DOWN	I	Power down detection input. Normally : "H" input
42	REMOCON	I	Remote control signal input. Not used this set (Fixed at "L")
43	ATSY	I	ATP address sync or sub-code Q sync (SCOR) input from CXD2535BR (IC121). "L" every 13.3msec, Almost "H"
44	DQSY	I	Input the U-bit CD format sub-code Q sync (SCOR) of the digital in from CXD2535BR (IC121). "L" every 13.3msec, Almost "H"
45 – 48		I	Not used this set. (Fixed at "L")
49	SCLK	O	Clock signal output to the serial bus.

Pin No.	Pin name	I/O	Description
50	SWDT	O	Write data signal output to the serial bus.
51	SRDT	I	Read data signal input to the serial bus.
52		I	Connected to the pin ⑤1.
53	FLCLK	O	Serial clock signal output to the display driver (IC701). Not used this set (Fixed at "L")
54	FLDATA	O	Serial data signal output to the display driver (IC701). Not used this set (Fixed at "L")
55	FLCS	O	Chip select signal output to the display driver (IC701). Not used this set (Fixed at "L")
56		I	Not used. (Fixed at "L")
57	TEST0	I	Terminal for test. (Fixed at "L")
58	TEST1	O	Reset signal output to CXD2536R (IC271).
59, 60		I	Not used. (Fixed at "L")
61	AFAST	I	Not used this set. (Fixed at "L")
62	16/18	I	16bit/18bit selector. "H" : 16bit
63	LDON	O	Laser ON/OFF control signal output. When laser ON : "H"
64	P/GROOVE	I	PIT/GROOVE detection input. "H" : Disc for playing and TOC area. Not used this set (Fixed at "L")
65	FOK	I	Focus OK signal input from CXD2535BR (IC121). "H" is input when the focus is applied.
66	MON	I	Not used this set. (Input and the pull-down)
67	LOCK	O	Not used this set. (Output and the pull-down)
68	WRPWR	O	Laser power selection signal output to the optical pick-up block and CXD2535BR (IC121).
69	DIG RST	O	Reset signal output to CXA1981R (IC101), CXD2535BR (IC121), and the motor driver (IC151). When reset : "L"
70	DA RST	O	Reset signal output to D/A converter (IC341) and the A/D converter (IC301). When reset : "L"
71, 72	SCMD 1, SCMD 0	O	Serial command control mode signal output to CXD2536R (IC271).
73	MOD	O	Laser modulation selection signal output. When playback power : "L", When stop : "H" When recording power : 
74	REC/PB	O	Recording/playback selection signal output to CXD2535BR (IC121). When recording : "H", When playback : "L"
75	WR/MN	O	Write/monitor mode selection signal output to CXD2536R (IC271).
76	SCTX	O	Writing data transmission timing output to CXD2536R (IC271). Used together with the magnetic field head ON/OFF output.
77	XLATCH	O	Latch signal output to the serial bus.
78	DFLATCH	O	Latch signal output to the D/A converter (IC341).
79	DFMUTE	O	Muting signal output. Not used this set. (Connected to the Ground)

Pin No.	Pin name	I/O	Description
80	AMUTE	O	Line out muting signal output.
81	LDOUT	O	Loading motor (M191) control output. *1
82	LDIN	O	Loading motor (M191) control output. *1
83	CHKIN	I	Detection signal input from the chucking in switch (S193). When chucking : "L"
84	INSW	I	Detection signal input from the loading in switch (S192). "L" at the position where the head descends, Others : "H"
85	OUTSW	I	Detection signal input from the loading out switch (S191). "L" at the position of load out, Others : "H"
86	PROTECT	I	Rec proof detection signal input from the protect detector switch (S102-1). When protect : "H"
87	REFLECT	I	Disc reflection rate detection signal input from the reflect detector switch (S102-2). "H" : Low reflection rate disc
88	LIMIT IN	I	Detection signal input from the limit in switch (S101). When sled limit in : "L"
89	232C. 4	O	UART data transmission request signal output to mPD78052G (IC301)
90	232C. 3	I	UART data transmission request signal input from mPD78052G (IC301)
91	232C. 2	I	UART data input from mPD78052GC (IC301)
92	232C. 1	O	UART data output to mPD78052GC (IC301)
93–96		O	Not used (Fixed at "L").
97	AVSS (AGND)	-	Ground terminal.
98	VREF (+5V)	I	Reference voltage input (+5V)
99	TIMER REC/PLAY	I	Timer record /time playback/time OFF selection signal input terminal. When timer recording : "H", When timer playback : "L", When timer OFF : Center point voltage (+2.5V) Not used this set (Fixed at "L")
100	INPUT SELECT	I	Analog/digital in selection signal input terminal When analog in : "L", When digital in : "H" Not used this set (Fixed at "L")

* 1 Loading motor control

Mode Terminal	IN	OUT	BRAKE
LDIN pin ②	"H"	"L"	"H"
LDOUT pin ⑧	"L"	"H"	"H"

IC271 SHCCK PROOF MEMORY CONTROLLER, ATRAC ENCODER/DECODER (CXD2536R)

Pin No.	Pin name	I/O	Description
1	VDD	—	Power supply terminal, (+5V)
2	SWDT	I	Write data signal input from the system controller (IC201).
3	SCK	I	Serial clock signal input from the system controller (IC201).
4	XLAT	I	Serial latch signal input from the system controller (IC201).
5	SRDT	O	Read data signal output to the system controller (IC201).
6	SENSE	O	Internal status (SENSE) output to the system controller (IC201).
7	SCMD0	I	Serial command control mode input from the system controller. (Fixed at "H")
8	SCMD1	I	Serial command control mode input from the system controller. (Fixed at "H")
9	XINT	O	Interruption status output to the system controller (IC201).
10	RCPB	I	Record/playback selection signal input. Not used this set. (Fixed at "L")
11	WRMN	I	Write/monitor mode selection signal input from the system controller (IC201).
12	TX	—	Writing data transmission timing input from the system controller (IC201). Used together with the magnetic field head ON/OFF output.
13	VSS	—	Ground terminal.
14	SICK	I	Chip reserve terminal. (Fixed at "L")
15	IDSL	I	Chip reserve terminal. (Fixed at "L")
16	XILT	I	Chip reserve terminal. (Fixed at "H")
17	XRST	I	Reset signal input from the system controller (IC201). When reset : "L"
18-21	TS0-TS3	I	Test input terminal. (Fixed at "L")
22	EXIR	I	Chip reserve terminal. (Fixed at "L")
23	SASL	I	Single use the block selection. "L" : ATRAC, "H" : RAM Controller (Fixed at "L")
24	SNGLE	I	Normally fixed at "L", Fixed at "H" when the ATRAC or RAM controller is single used. (Fixed at "L")
25	VSS	—	Ground terminal.
26	AIRCPB	O	Record/playback mode signal output terminal of the ATRAC or external audio block. Not used this set.
27	XRQ	I/O	XRQ signal input/output terminal of the ATRAC interface. Not used this set.
28	ADTO	I/O	Decoder data signal input/output terminal of the ATRAC. Not used this set.
29	ADTI	I/O	Encoder data signal input/output terminal of the ATRAC. Not used this set.
30	XALT	I/O	XALT signal input/output terminal of the ATRAC interface. Not used this set.
31	ACK	I/O	ACK signal input/output terminal of the ATRAC interface. Not used this set.
32	AC2	I/O	Error data signal input/output terminal of the ATRAC interface. Not used this set.
33	LCHST	I/O	Lch Start data signal input/output terminal of the ATRAC interface. Not used this set.
34	EXE	I/O	EXE signal input/output terminal of the ATRAC interface. Not used this set.
35	MUTE	I/O	MUTE signal input/output terminal of the ATRAC interface. Not used this set.
36	OSCO	O	45MHz clock oscillation output. (45MHz)
37	OSCI	I	45MHz clock oscillation input. (45MHz)
38	VSS	—	Ground terminal.
39	ATT	I/O	ATT signal input/output terminal of the ATRAC interface. Not used this set.
40	F86	O	11.6msec timing signal output terminal of the ATRAC block. Not used this set.
41	DOUT	O	Monitor/audio decode data signal output to the D/A converter (IC281).
42	ADIN	I	Recoding data signal input from the D/A converter (IC261).
43	ABCK	O	Bit clock signal output to the A/D, D/A converter (IC261, 281).
44	ALRCK	O	L/R clock signal output to the A/D, D/A converter (IC261, 281).
45-47	SA2-SA0	O	Address signal output. Not used this set (OPEN)
48,49	A11,A10	O	Address signal output. Not used this set

Pin No.	Pin name	I/O	Description
50	VSS	—	Ground terminal.
51	VDD	—	Power supply terminal. (+5V)
52–55	A03–A00	O	Address signal output to the RAM (IC222)
56–60	A04–A08	O	Address signal output to the RAM (IC222)
61	XOE	O	Output enable control signal output to the RAM (IC222).
62	XCAS	O	Column address strobe signal output to the RAM (IC222).
63	VSS	—	Ground terminal.
64	XCS	O	Chip select signal output. Not used this set
65	A09	O	Address signal output to the RAM (IC222).
66	XRAS	O	Row address strobe signal output to the RAM (IC222).
67	XWE	O	Write enable control signal output to the RAM (IC222).
68,69	D1, D0	I/O	RAM (IC222) data bus.
70,71	D2,D3	I/O	RAM (IC222) data bus.
72–74	D4–D6	I/O	Data bus. Not used this set (OPEN)
75	VSS	—	Ground terminal.
76	D7	I/O	Data bus. Not used this set (OPEN)
77	ERR	I/O	Input/output terminal of the error (C2PO) data signal to the external RAM. Not used this set (OPEN)
78	EXTC2R	I	External RAM selection signal input for the error data writing. (When “H” : External RAM) (Fixed at “L”).
79	BUSY	O	BUSY signal output of the RAM access. Not used this set (OPEN)
80	EMP	O	Empty or before the full of the ATRAC data. (When DSC=ASC+1 : “H”). Not used this set.
81	FUL	O	Full or before the empty of the ATRAC data. (When ASC=DSC+1 : “H”). Not used this set.
82	EQL	O	Empty of the ATRACK data. (when DSC=ASC : “H”). Not used this set.
83	MDLK	O	Indicate the main/sub of the recording or playback data. (When sub and linking : “H”, When the main : “L”). Not used this set.
84	CPSY	O	Interpolation sync signal output. Not used this set.
85	CTMD0	O	DSC counter mode output. Not used this set.
86	CTMD1	O	DSC counter mode output. Not used this set.
87	SPO	O	System clock (512Fs=22.5792MHz) signal output to CXD2535BR (IC121).
88	VSS	—	Ground terminal.
89	MDSY	O	Sync detection signal output of the main data. Not used this set.
90	LRCK	I	L/R clock (44.1kHz) signal input from CXD2535BR (IC121).
91	BCK	I	Bit clock (2.8224MHz) signal input from CXD2535BR (IC121).
92	C2PO	I	C2PO (indicate the error mode of the data) signal input from CXD2535BR (IC121). When playback : C2PO (“H”), When digital recording : D. IN-Vflag, When analog recording : “L”
93	DATA	I/O	When recording : Record audio data signal output to CXD2535BR (IC121). When playback : playback audio data signal input from CXD2535BR (IC121).
94	DIDT	I	16-bit data input terminal for the digital audio in from the CXD2535BR(IC121).
95	DODT	O	16-bit data output terminal for the digital audio out from the CXD2535BR (IC121).
96	DIRCPB	O	Disc drive, Record or playback mode output of the EFM encoder/decoder. Not used this set (Open)
97	MIN	I	Defect ON/OFF selection signal input from CXD2535BR (IC121).
98	SPOS L	I	IN/OUT selection input terminal of the pin ⑦. (“L” : IN, “H” : OUT) (Fixed at “H”)
99	MCKT1	O	Internal master clock signal output terminal of the RAM controller. Not used this set.
100	VSS	—	Ground terminal.

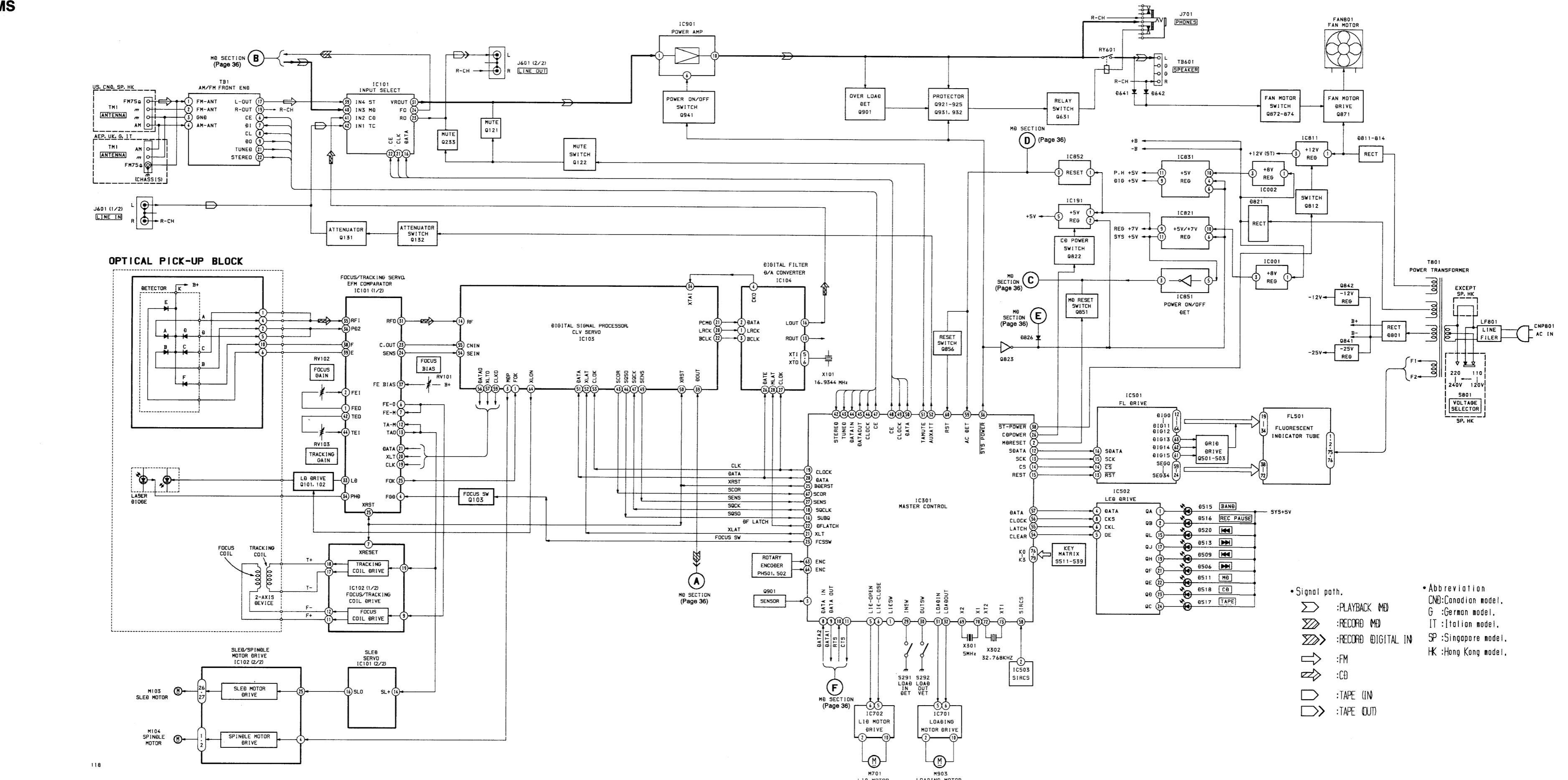
IC301 MASTER CONTROL (μPD78058GC-243-3B9)

Pin No.	Pin name	I/O	Description
1	LID SW	I	LID switch input (OPEN, CLOSE, SHUT switch).
2	MD RESET	I	Reset input for MD.
3		I	CADY sensor input terminal.
4	AVSS	-	Ground.
5	LID-OPEN	O	LID motor control output (open direction).
6	LID CLS	O	LID motor control output (close direction).
7		-	Not used.
8	DATA IN	I	Serial data input from MD.
9	DATA OUT	O	Serial data output to MD.
10	CTS	I	Clock input from ⑧ , ⑨ pin.
11	RTS	O	Clock output to ⑧ , ⑨ pin.
12	SDATA	O	Serial data output to FL driver.
13	SCK	O	Clock output to FL driver.
14	CS	O	Chip selector output to FL driver.
15	REST	O	Reset output to FL driver.
16	SUBQ	I	SUB "Q" input from CD.
17	OPEN	-	Not used.
18	SQCLK	O	SUB "Q" clock output to CD.
19	CCLOK	O	Master clock output to CD.
20	DATA	O	Data output to CD.
21	XLT	O	Latch output to CD.
22	DFLATCH	O	Latch output to CD digital filter.
23	FCSSW	O	output to Focus SW.
24	A MUTE	-	Not used.
25	BDRST	O	Reset output to CD.
26	CD POWER	O	CD Block Power ON/OFF. ("H" : ACT)
27	SENS	I	Sens input from CD.
28	ADJ	I	Terminal for test mode. ("L" : Test mode)
29	IN SW	I	LOAD IN Switch input. (close)
30	OUT SW	I	LOAD OUT Switch input. (open)
31	LOD IN	O	Loading Motor drive output. (open direction)
32	LOD OUT	O	Loading Motor drive output. (close direction)
33	VSS	-	Ground.
34		-	Not used. (open)
35		-	Not used. (open)
36	SYS POWER	O	System power ON / OFF control. ("L" : power ON)
37		-	Not used.
38	ST POWER	O	ST Power ON / OFF control. ("L" : ST ON)
39	TAPE	-	Not used.
40		-	Not used.
41		-	Not used.
42	STEREO	I	Stereo Signal input from ST block.
43	TUNED	I	Tuned Signal input from ST block.
44	DATA IN	I	Serial data input from ST block.
45	DATA OUT	O	Serial data output to ST block.
46	CLOCK	I/O	Clock input / output of the ST block.

Pin No.	Pin name	I/O	Description
47	CE	O	Chip enable output to ST block.
48	CE	O	Chip enable output to IC101 (CXA1946Q).
49	CLOCK	O	Clock output to IC101 (CXA1946Q).
50	DATA	O	Serial data output to IC101 (CXA1946Q).
51	TA MUTE	O	Mute signal output to AMP. "L" : Mute
52	AUX ATT	O	Attenuation output for when AUX input. "L" : ATT
53	MIC DET	-	Not used.
54	CLEAR	O	Reset output to LED driver.
55	LATCH	O	Latch output to LED driver.
56	CLOCK	O	Clock output to LED driver.
57	DATA	O	Data output to LED driver.
58	SIRCS	I	SIRCS signal input terminal.
59	AC-DET	I	AC detection terminal.
60	CST	I	System reset terminal.
61	AUB I	-	Not used. (Ground connection)
62	AUB O	-	Not used. (Ground connection)
63	ENC	I	Input terminal from encoder.
64	ENC	I	Input terminal from encoder.
65		-	Not used.
66	FAN	I	FAN input terminal.
67	SCOR	I	SCOR input from BD.
68	VDD	-	Power supply. (+5 V)
69	X2	O	MICOM clock output terminal. (5.0 MHz)
70	X1	I	MICOM clock input terminal. (5.0 MHz)
71	GND	-	Ground.
72	XT2	O	Clock output for timer. (3.0 kHz)
73	XT1	I	Clock input for timer. (3.0 kHz)
74	AVDD	-	Power supply for Analog. (+5 V)
75	AVREFO	-	Reference Voltage output for Analog. (+5 V)
76	K0	I	Key input.
77	K1	I	Key input.
78	K2	I	Key input.
79	K3	I	Key input.
80	VER	I	Input terminal for Virsion Select.

SECTION 8 DIAGRAMS

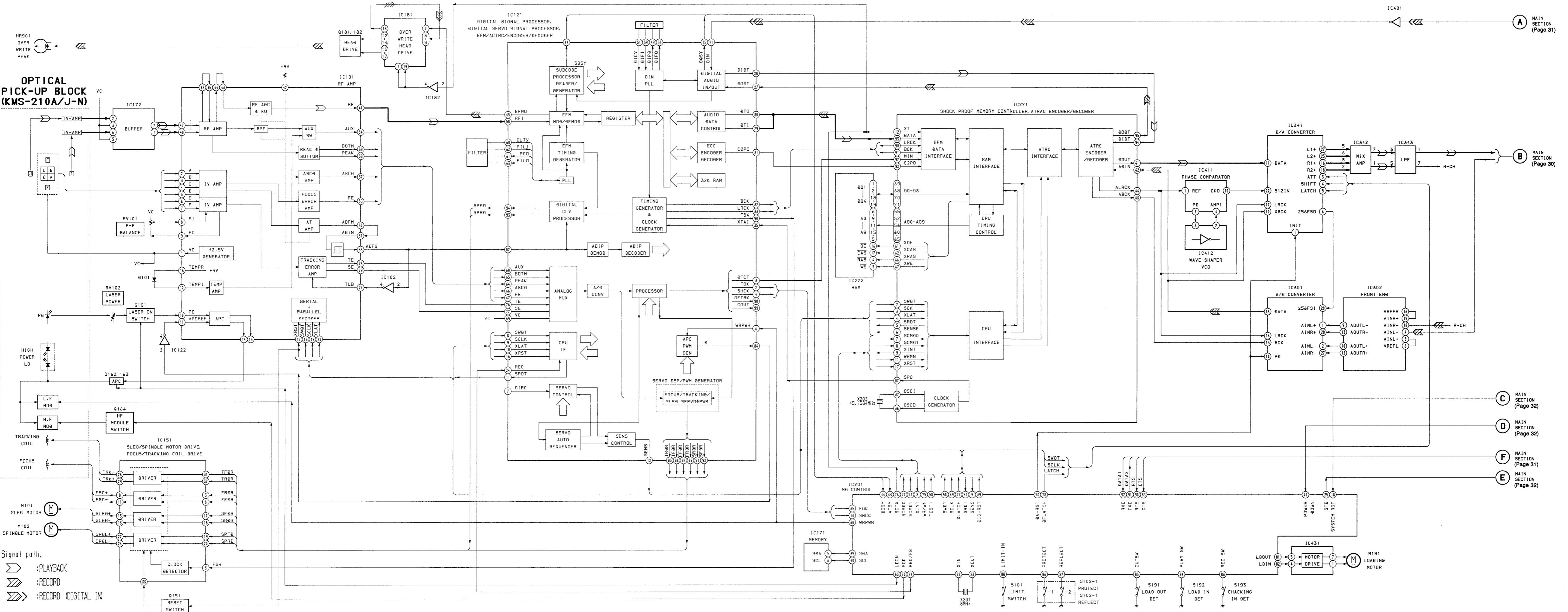
8-1. BLOCK DIAGRAM - MAIN SECTION -

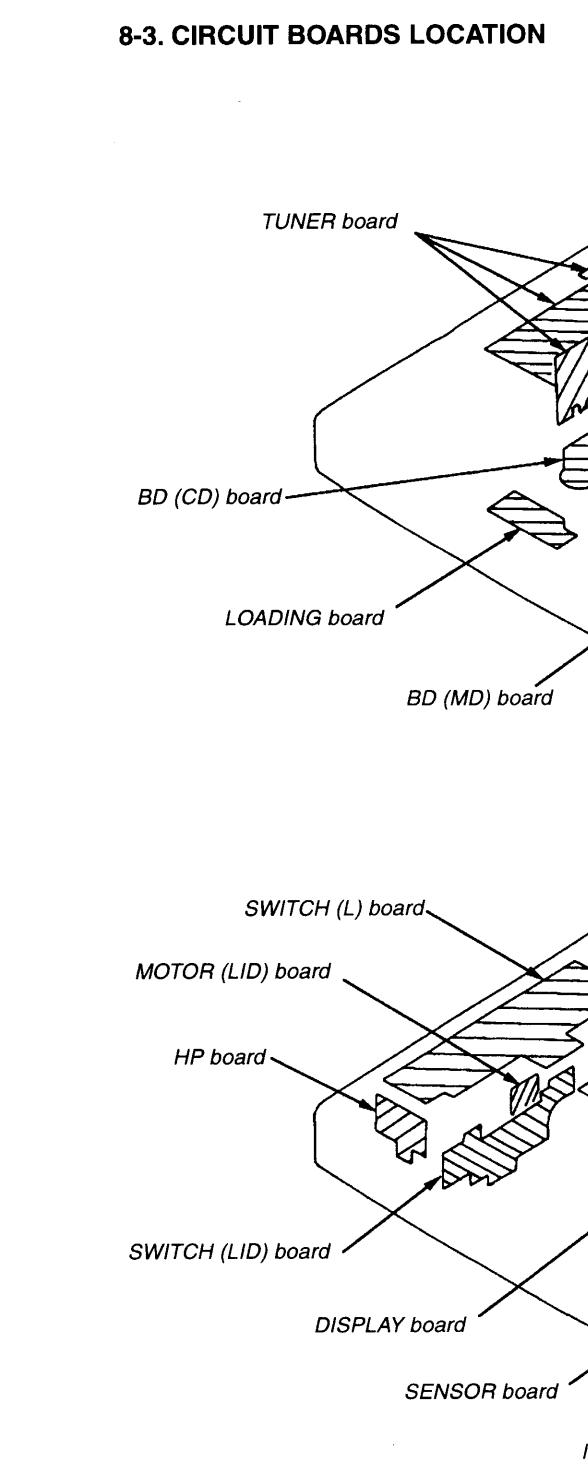


- Signal path.
- :PLAYBACK (MD)
- :RECORD (MD)
- :RECORD (DIGITAL IN)
- :FM
- :CD
- :TAPE (IN)
- :TAPE (OUT)

Abbreviation
 CNB:Canadian model.
 G:German model.
 IT:Italian model.
 SP:Singapore model.
 HK:Hong Kong model.

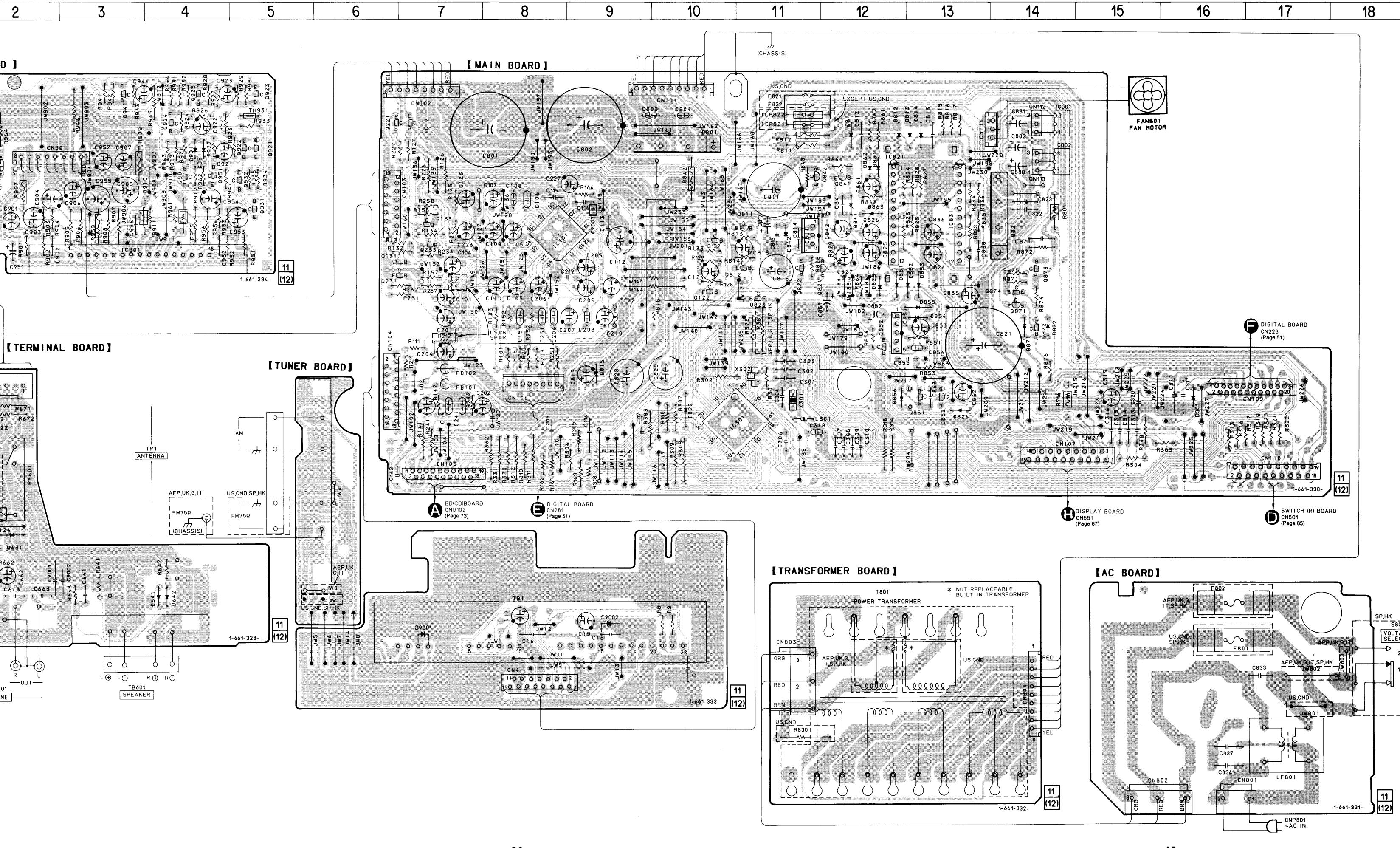
8-2. BLOCK DIAGRAM - MD SECTION -



**• SEMICONDUCTOR LOCATION**

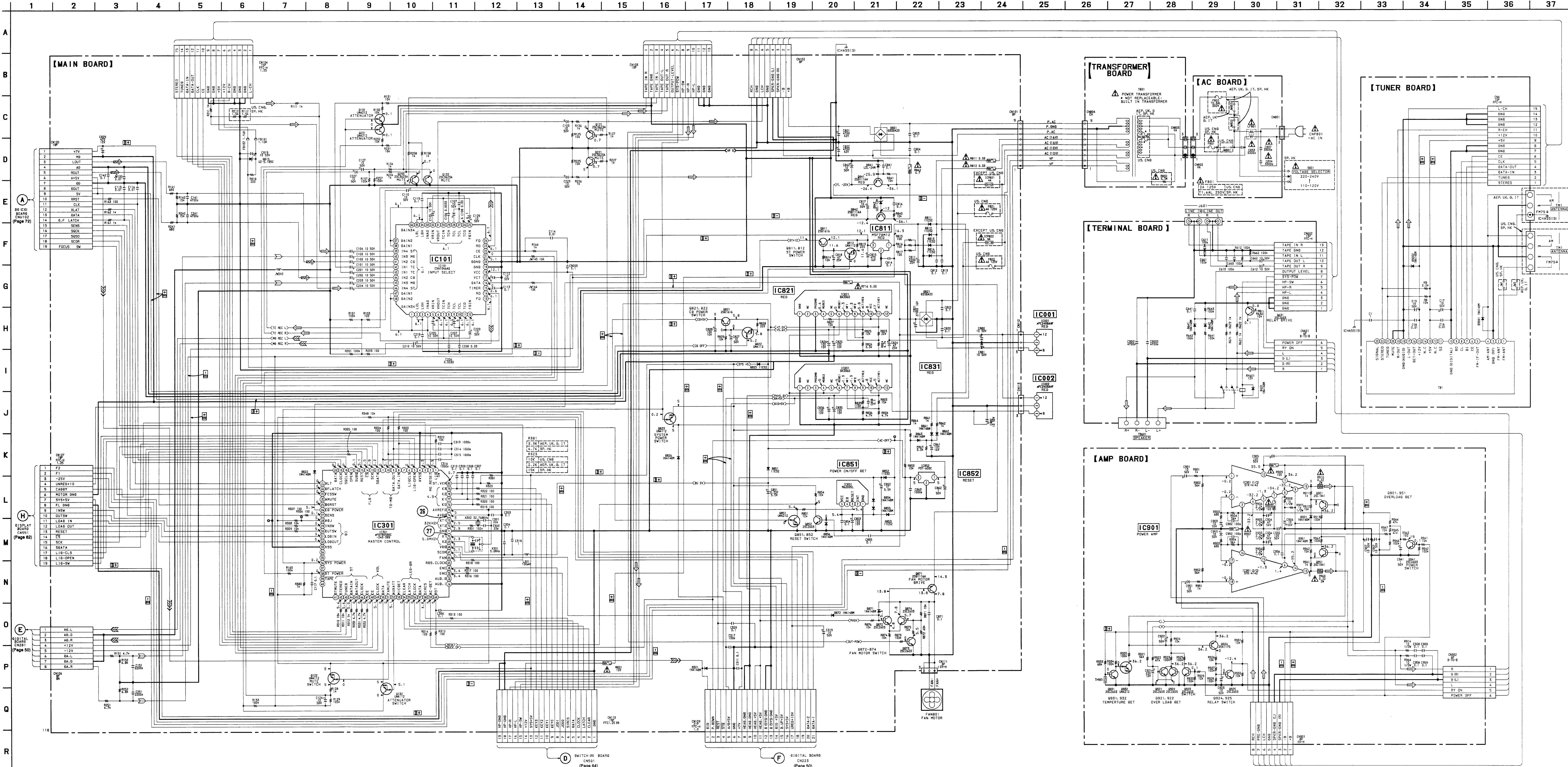
Ref. No.	Location	Ref. No.	Location
D301	E-16	IC821	B-12
D631	G-2	IC831	C-13
D641	G-4	IC851	D-12
D642	G-4	IC852	E-13
D801	B-10	IC901	C-3
D811	B-12	Q121	B-7
D812	B-12	Q122	D-10
D813	B-13	Q131	C-6
D814	E-9	Q132	C-10
D815	E-9	Q133	C-7
D821	C-14	Q221	B-6
D822	E-10	Q231	C-6
D825	D-12	Q233	C-7
D826	E-13	Q631	G-2
D841	C-12	Q811	C-11
D842	C-11	Q812	C-11
D851	D-12	Q821	C-12
D852	D-13	Q822	C-11
D853	D-13	Q823	D-11
D854	D-13	Q841	B-12
D855	D-13	Q842	B-12
D856	E-12	Q851	E-13
D861	B-12	Q852	D-12
D862	B-12	Q871	D-14
D863	C-12	Q872	D-14
D871	D-14	Q873	C-14
D872	D-14	Q874	D-14
D901	B-4	Q901	B-4
D951	B-4	Q921	B-5
D9001	I-7	Q922	B-5
D9002	H-9	Q923	A-5
		Q924	B-4
		Q925	A-4
		Q931	C-5
		Q932	B-5
IC001	A-14	Q941	A-3
IC002	B-14	Q951	B-4
IC101	C-8		
IC301	E-10		
IC811	C-11		

Note:
 • ○ : parts extracted from the component side.
 • — : parts extracted from the conductor side.
 • ■ : Pattern from the side which enables seeing.
 (The other layers' patterns are not indicated)
Abbreviation
 CND : Canadian
 G : German
 IT : Italian
 SP : Singapore
 HK : Hong Kong

8-4. PRINTED WIRING BOARDS – MAIN SECTION –

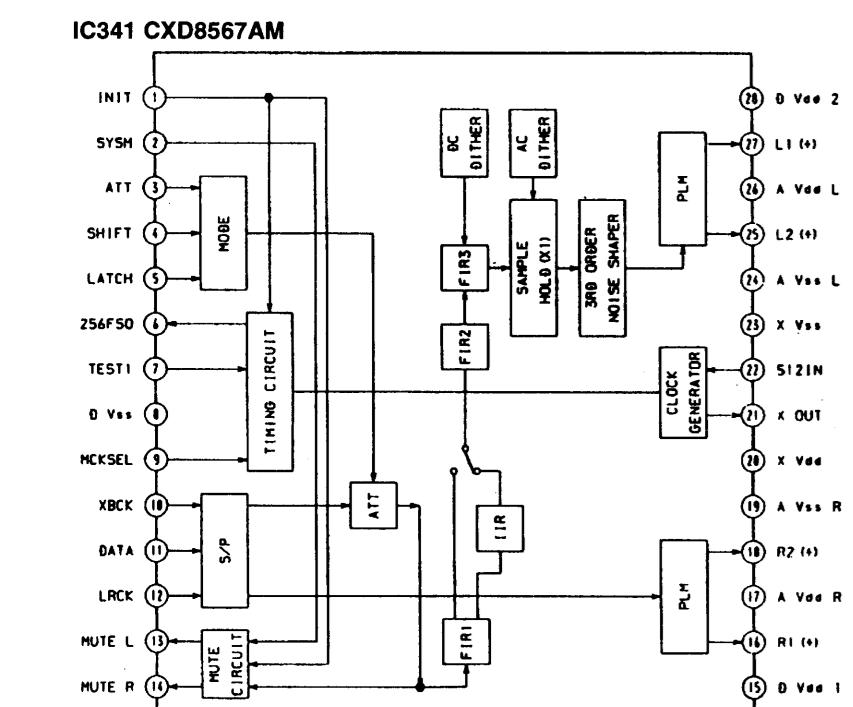
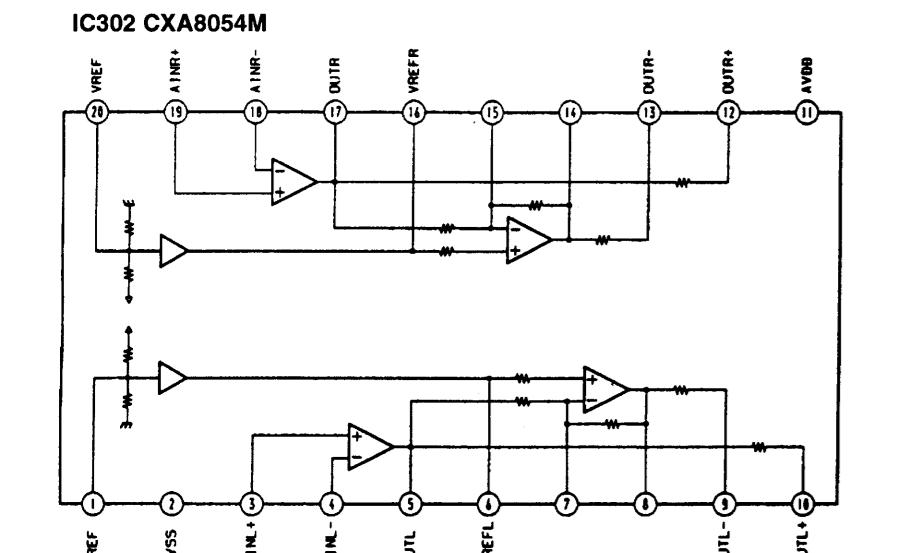
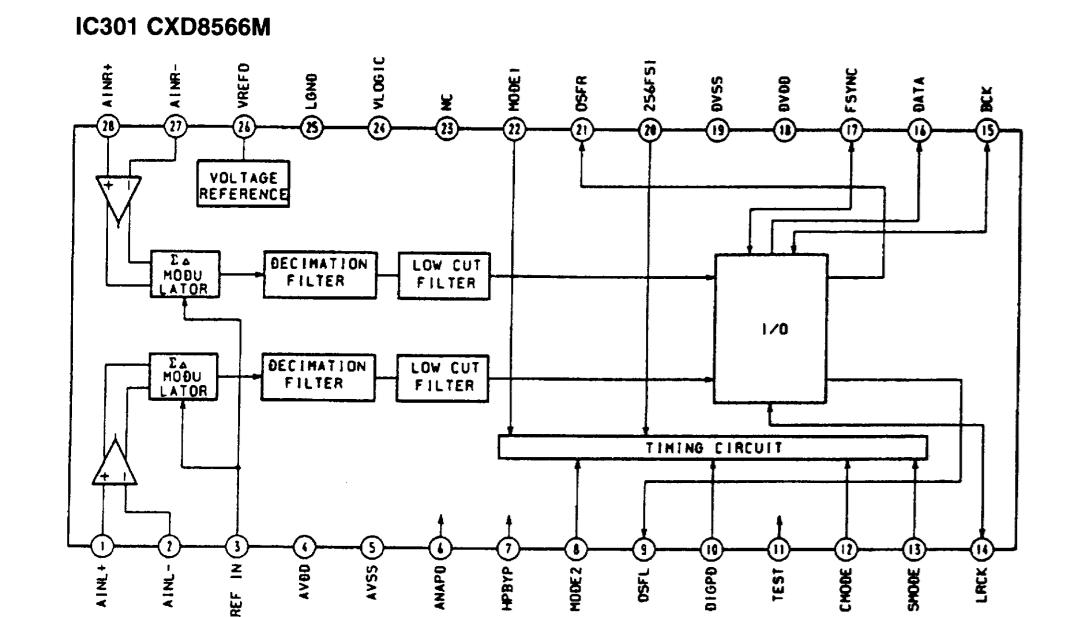
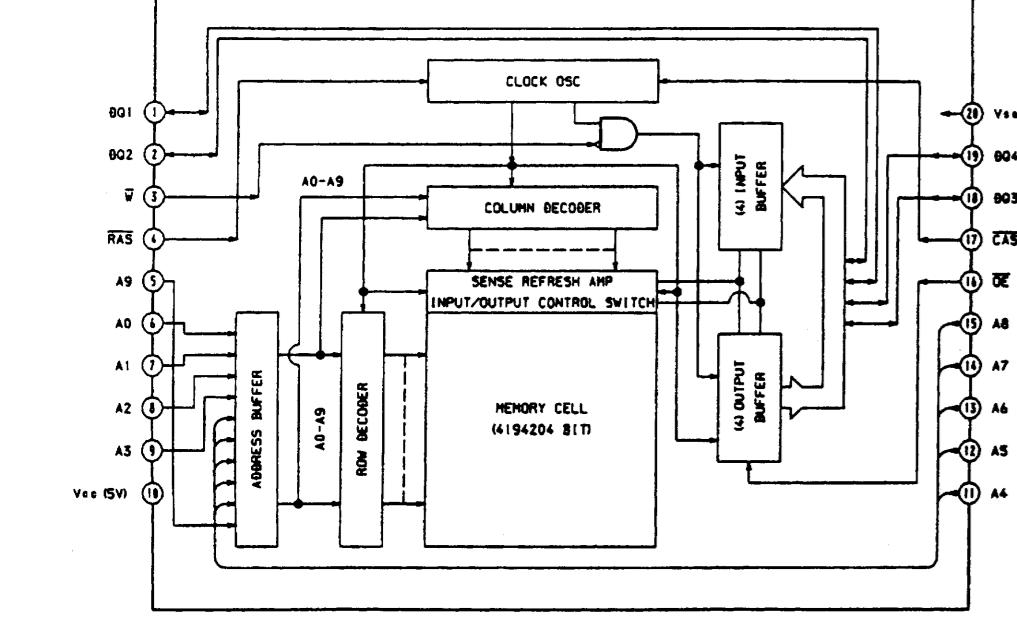
8-5. SCHEMATIC DIAGRAM - MAIN SECTION -

• Refer to page 75 for IC Block Diagrams.

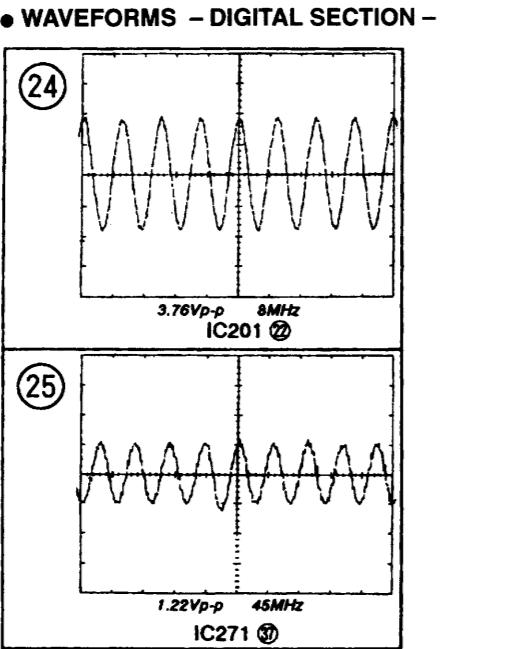
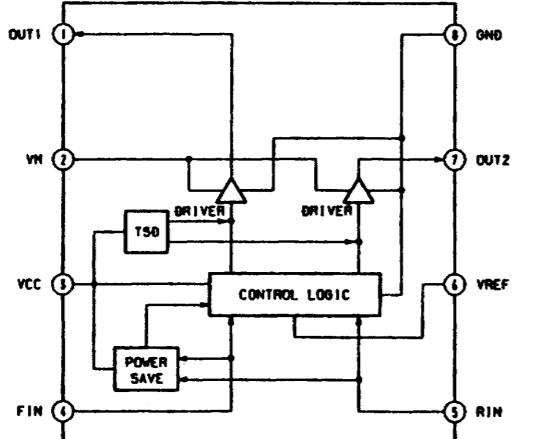


● IC BLOCK DIAGRAMS - DIGITAL SECTION -

IC272 M5M44400BJ-7-L2



IC431 BA6287F

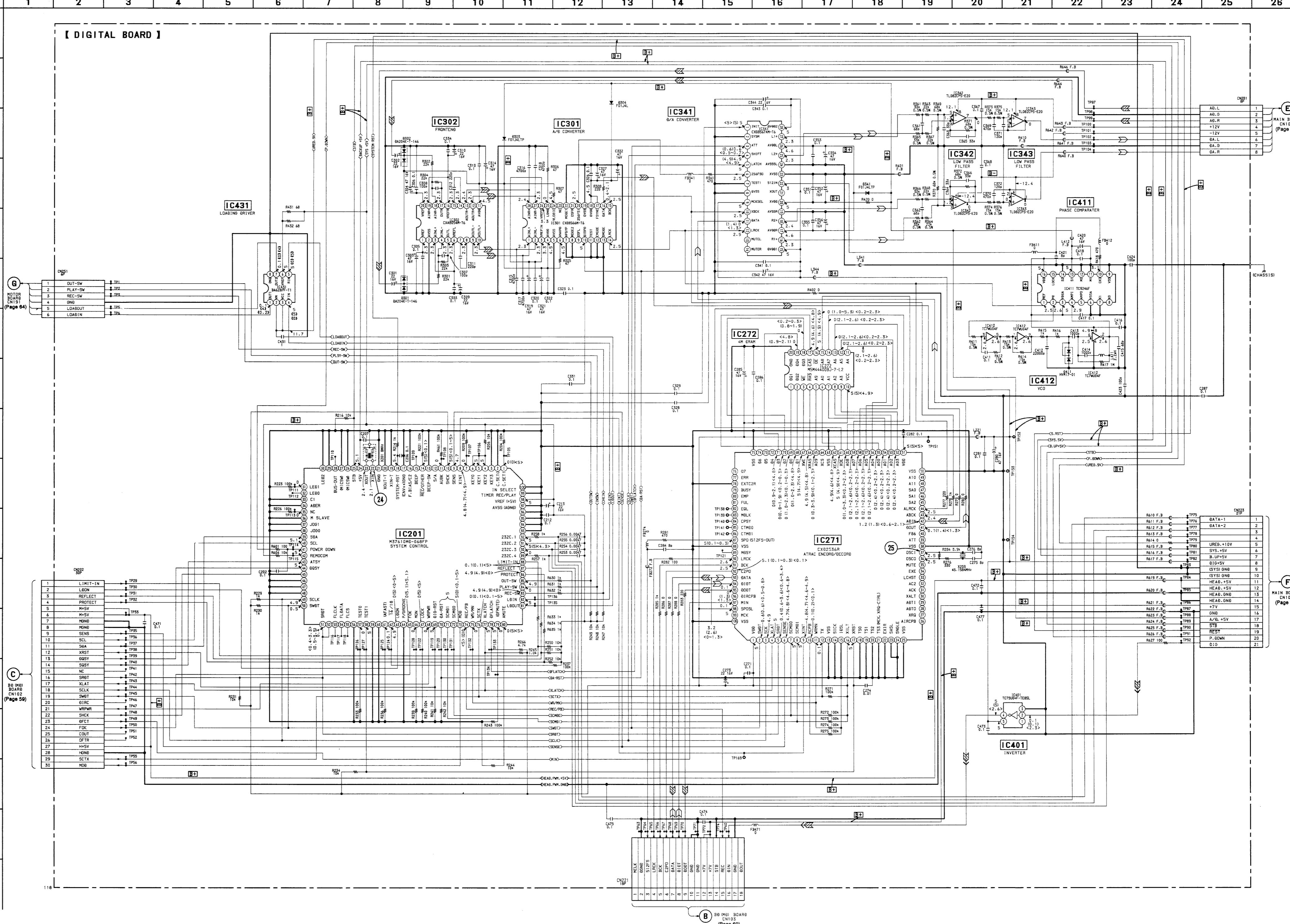


Note :

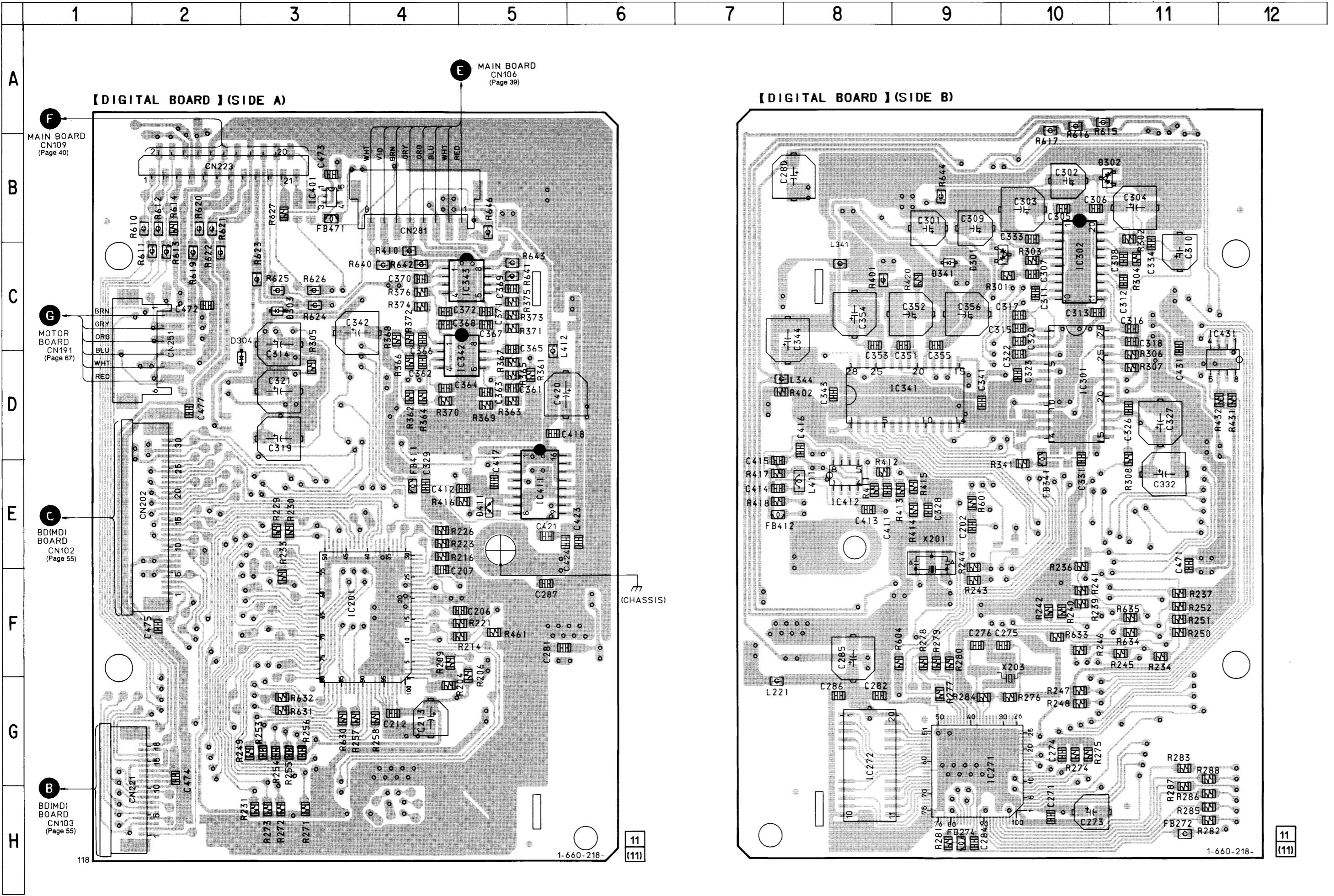
- All capacitors are in μ F unless otherwise noted. pF: μ F 50W or less are not indicated except for electrolytics and tantalums.
- All resistors are in Ω and V/W or less unless otherwise specified.
- % : indicates tolerance.
- Δ : internal component.
- \square : B+ Line
- \square : B- Line
- Voltage and waveforms are dc with respect to ground under no-signal (detuned) conditions.
- no mark : STOP (MD) () : LOAD IN () : PB (MD) () : REC OUT () : REC (MD)
- Voltages are taken with a VOM (Input impedance 10M Ω). Voltage variations may be noted due to normal production tolerances.
- Waveforms are taken with an oscilloscope. Voltage variations may be noted due to normal production tolerances.
- Circled numbers refer to waveforms.
- Signal path:

 - \square : PB (MD)
 - \square : REC (MD)
 - \square : REC (DIGITAL IN)

8-6. SCHEMATIC DIAGRAM - DIGITAL SECTION -



8-7. PRINTED WIRING BOARDS - DIGITAL SECTION -



• SEMICONDUCTOR LOCATION

Ref. No.	Location
D301	C-10
D302	B-10
D303	C-3
D304	D-3
D341	C-9
D411	E-5
IC201	F-4
IC271	G-9
IC272	G-8
IC301	D-10
IC302	C-10
IC341	D-9
IC342	D-5
IC343	C-5
IC401	B-3
IC411	E-5
IC412	E-8
IC431	D-12

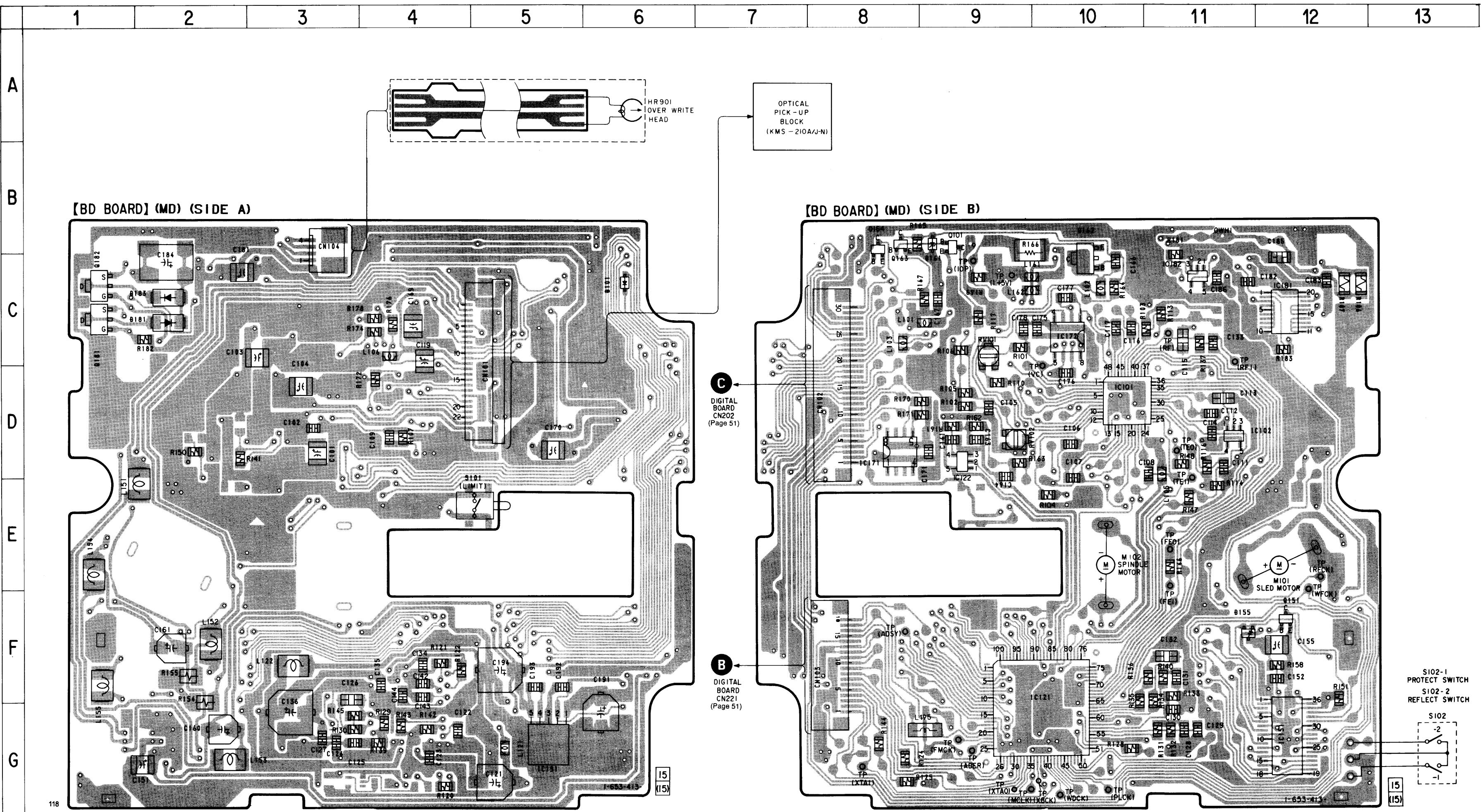
Note:

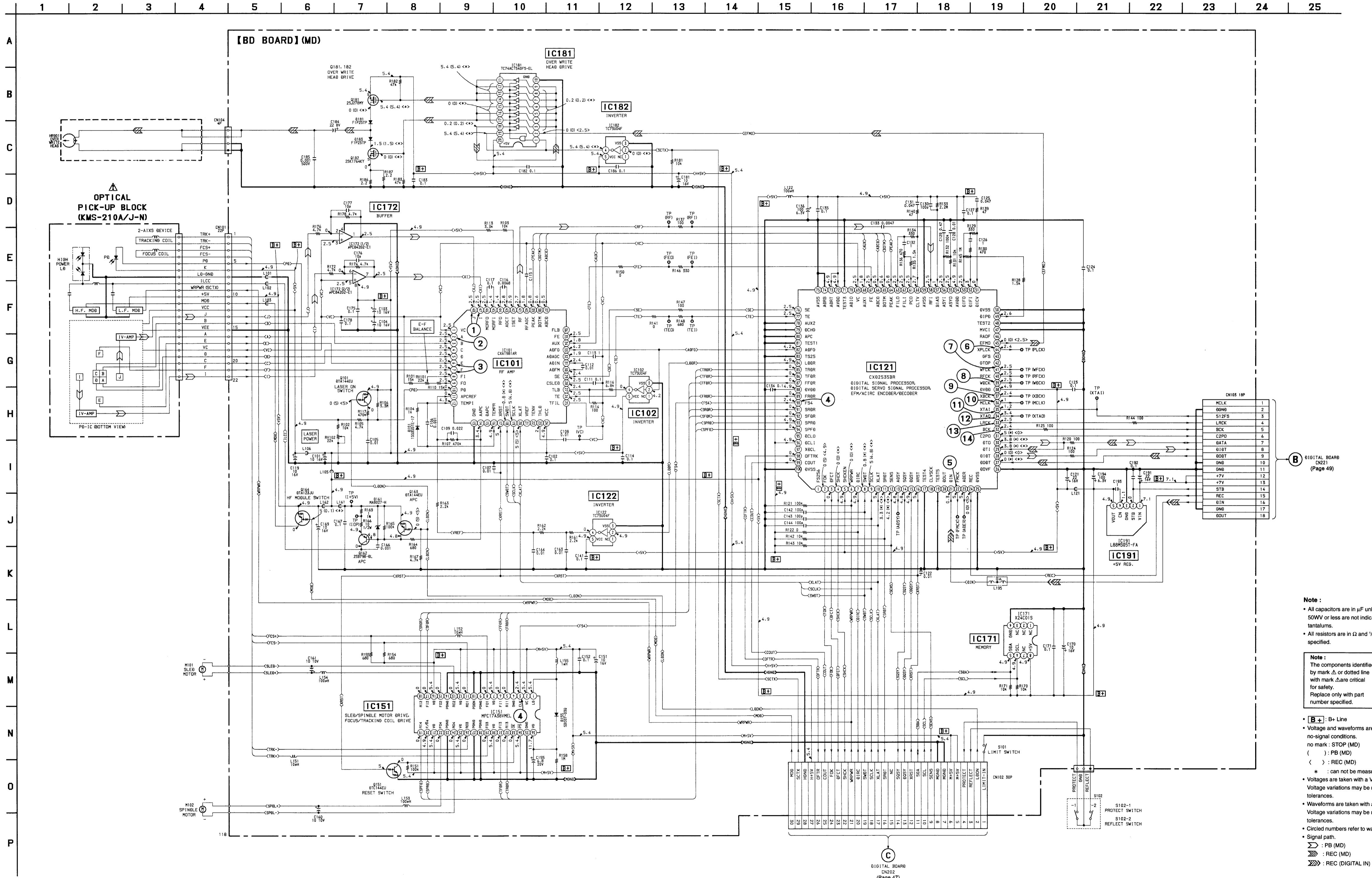
- : parts extracted from the conductor side.
- : Through hole.
- △ : internal component.
- : Pattern from the side which enables seeing.
(The other layers' patterns are not indicated)

8-8. PRINTED WIRING BOARDS - BD : MD SECTION -

● SEMICONDUCTOR LOCATION	
Ref. No.	Location
D101	C-6
D155	F-11
D161	B-9
D181	C-2
D183	C-2
IC101	D-10
IC102	D-11
IC121	G-10
IC122	D-9
IC151	G-12
IC171	D-8
IC172	C-10
IC181	C-12
IC182	C-11
IC191	G-5
Q101	B-9
Q151	F-12
Q162	C-10
Q163	B-8
Q164	B-8
Q181	C-1
Q182	C-1

Note:
 • — : parts extracted from the component side.
 • — : parts extracted from the conductor side.
 • ○ : Through hole.
 • : Pattern from the side which enables seeing.
 (The other layers' patterns are not indicated)





Note :

- All capacitors are in μF unless otherwise noted. pF: $\mu\mu F$
50V or less are not indicated except for electrolytics and tantalums.

Note :

- All resistors are in Ω and $1/4 W$ or less unless otherwise specified.

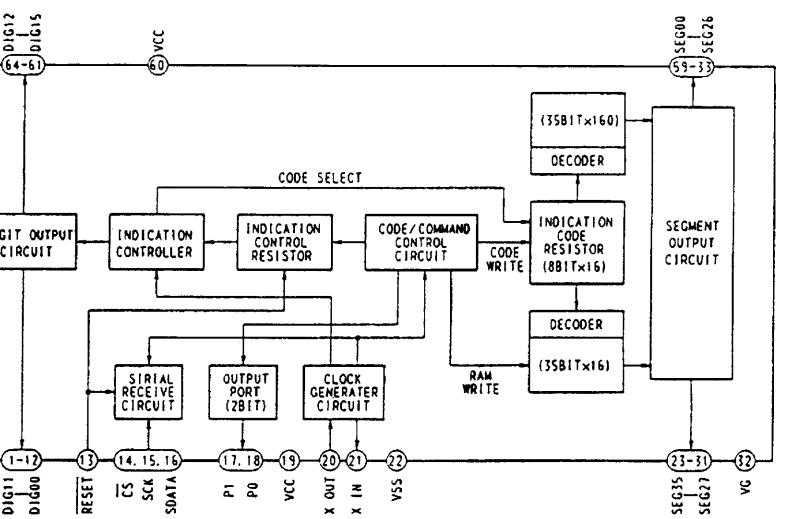
Note :

- The components identified by mark Δ or dotted line with mark Δ are critical for safety.
Replace only with part number specified.
- Les composants identifiés par une marque Δ ou une ligne pointillée avec une marque Δ sont critiques pour la sécurité.
Ne les remplacer que par une pièce portant le numéro spécifié.

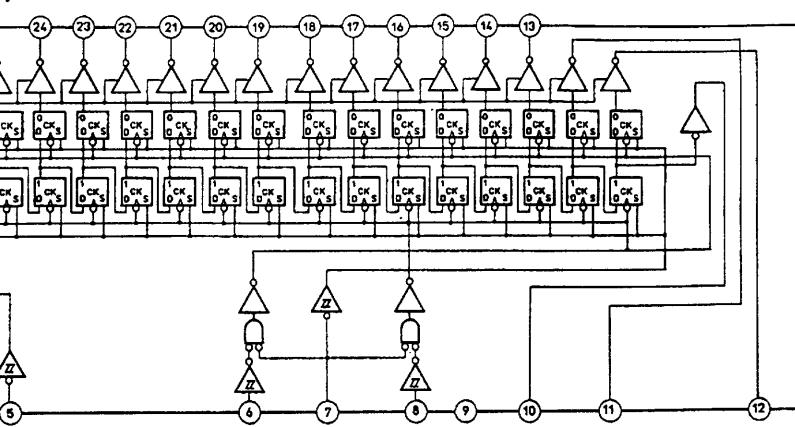
- B** : B+ Line
- Voltage and waveforms are dc with respect to ground under no-signal conditions.
- no mark : STOP (MD)
- () : PB (MD)
- < > : REC (MD)
- * : can not be measured
- Voltages are taken with a VCM (Input impedance 10M Ω). Voltage variations may be noted due to normal production tolerances.
- Waveforms are taken with an oscilloscope. Voltage variations may be noted due to normal production tolerances.
- Circle numbers refer to waveforms.
- Signal path.
- Σ : PB (MD)
- ∇ : REC (MD)
- $\nabla\nabla$: REC (DIGITAL IN)

● IC BLOCK DIAGRAMS – DISPLAY SECTION –

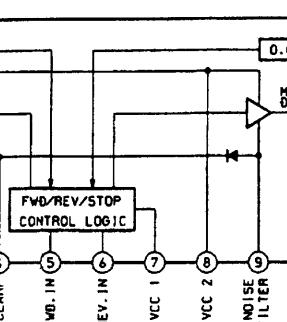
IC501 M66004M8FP



IC502 M66311FP



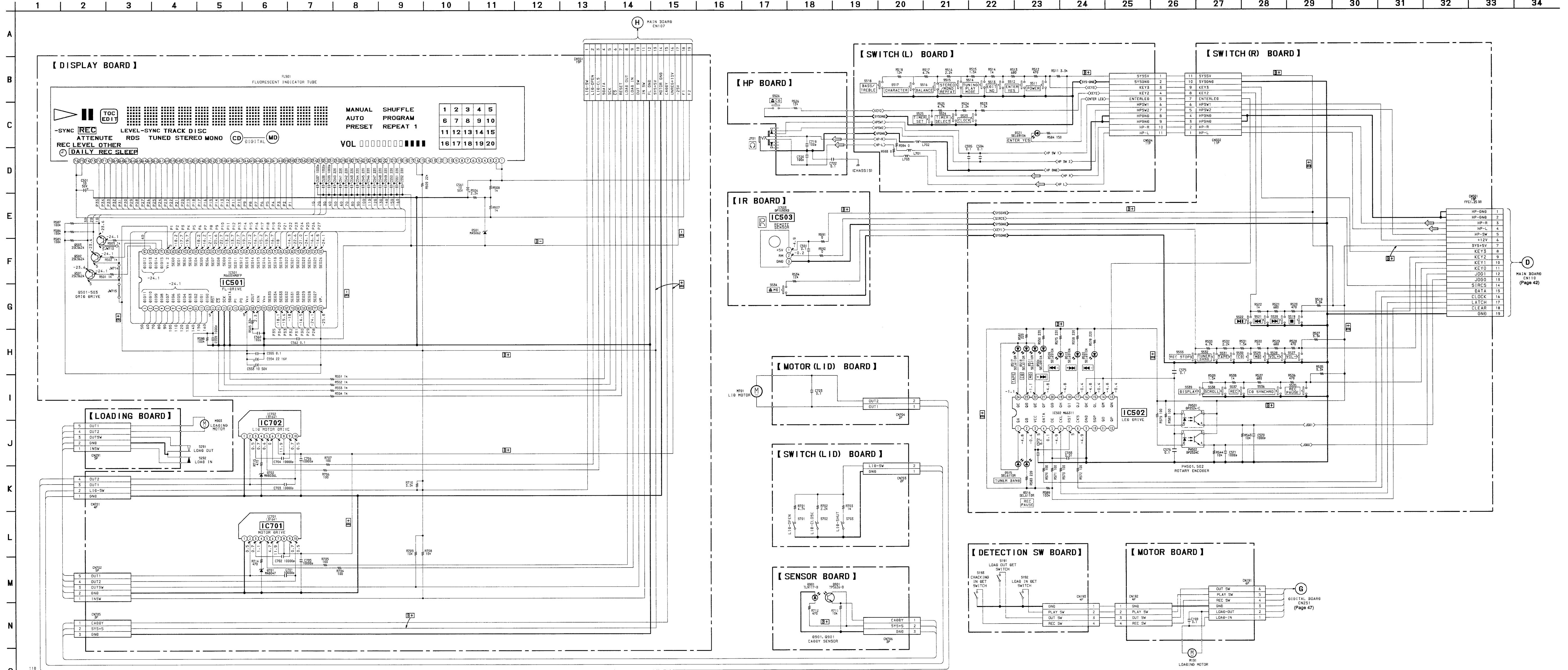
IC701, 702 LB1641



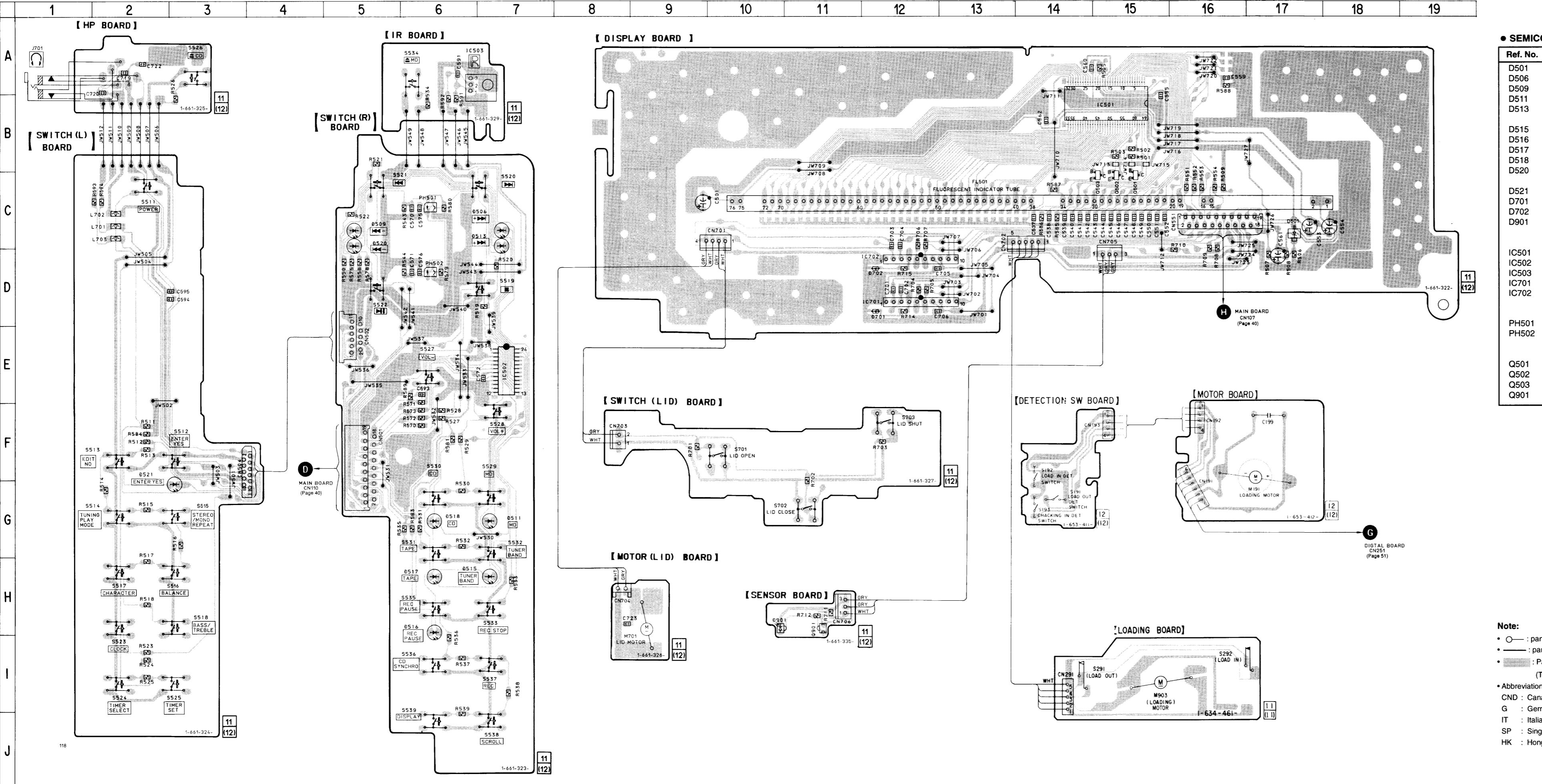
Note :

- All capacitors are in μF unless otherwise noted. pF: μF 50WV or less are not indicated except for electrolytics and tantalums.
- All resistors are in Ω and $1/4\text{W}$ or less unless otherwise specified.
- Signal path.
- Panel designation.
- Abbreviation
- CND : Canadian
- G : German
- IT : Italian
- SP : Singapore
- HK : Hong Kong

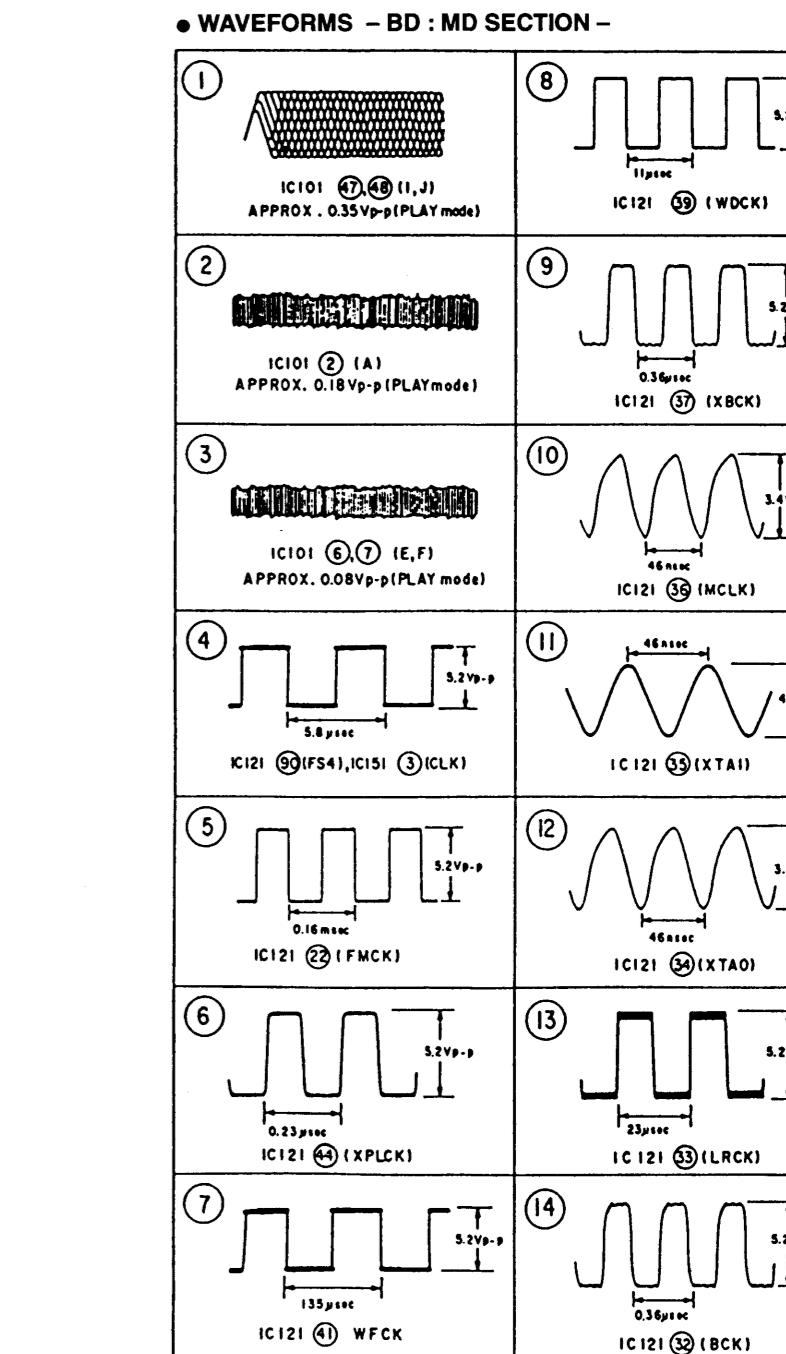
8-10. SCHEMATIC DIAGRAM – DISPLAY SECTION –



8-11. PRINTED WIRING BOARDS - DISPLAY SECTION -



● SEMICONDUCTOR LOCATION	
Ref. No.	Location
D501	C-17
D506	C-7
D509	C-5
D511	G-7
D513	C-7
D515	H-7
D516	H-6
D517	H-6
D518	G-6
D520	C-5
D521	G-3
D701	D-12
D702	D-12
D901	H-10
IC501	A-15
IC502	E-7
IC503	A-7
IC701	D-12
IC702	D-12
PH501	C-6
PH502	D-6
Q501	B-15
Q502	B-15
Q503	B-15
Q901	H-11



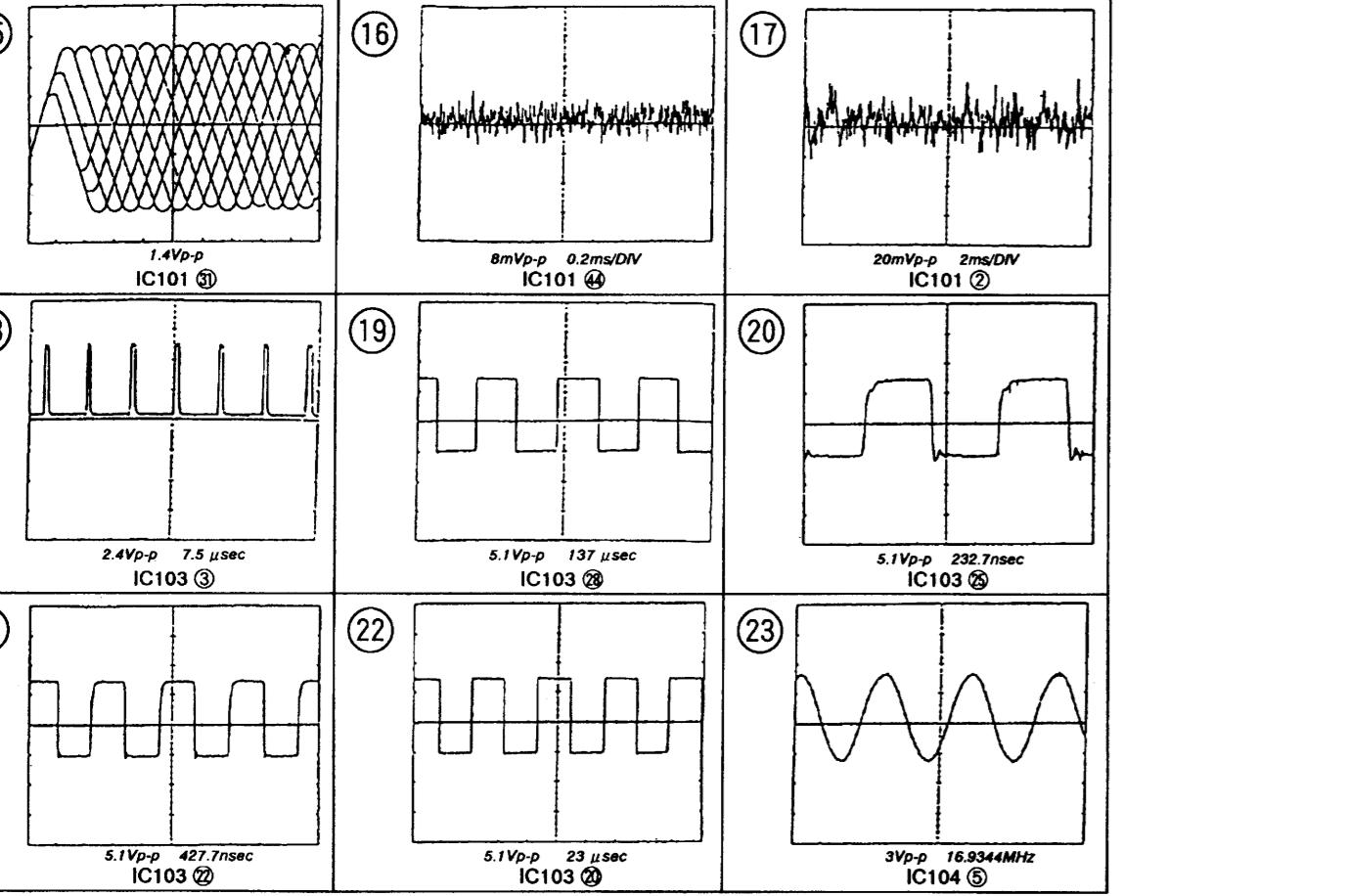
Note:

- : parts extracted from the component side.
- : parts extracted from the conductor side.
- : Pattern from the side which enables seeing.
(The other layers' patterns are not indicated)

Abbreviation

CND : Canadian
G : German
IT : Italian
SP : Singapore
HK : Hong Kong

• WAVEFORMS - BD : CD SECTION -



Note :

- All capacitors are in μF unless otherwise noted. pF: μpF 50WV or less are not indicated except for electrolytics and tantalums.
- All resistors are in Ω and $1/4\text{W}$ or less unless otherwise specified.

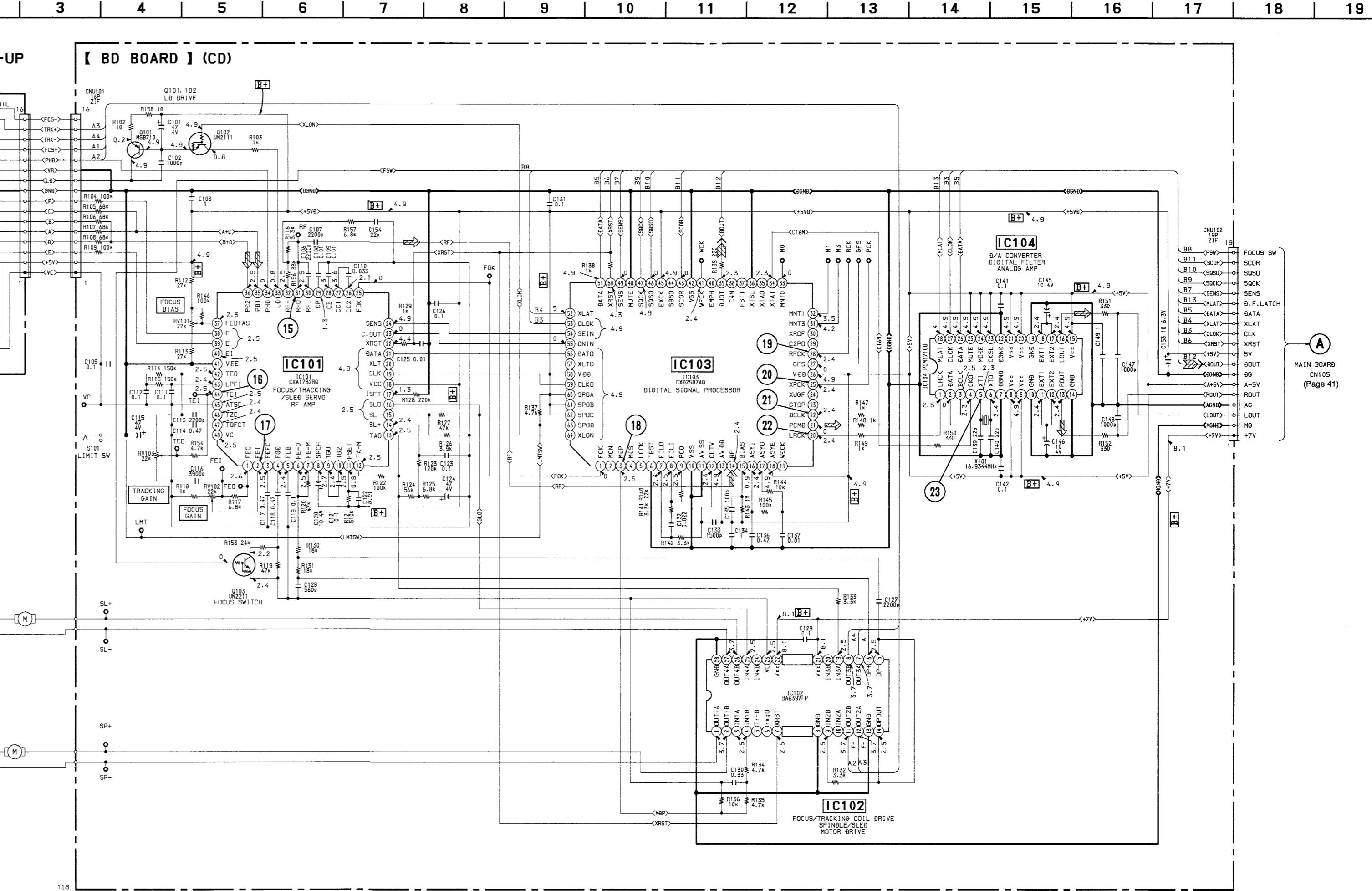
Note :
The components identified by mark \triangle or dotted line with mark \triangle are critical for safety.
Replace only with part number specified.

Note :
Les composants identifiés par une marque \triangle sont critiques pour la sécurité.
Ne les remplacer que par une pièce portant le numéro spécifié.

- B+** : B+ Line
- : adjustment for repair.
- Voltage and waveforms are dc with respect to ground under no-signal conditions.
no mark : PB (CD)
- Voltages are taken with a VOM (Input impedance 10M Ω).
Voltage variations may be noted due to normal production tolerances.
- Waveforms are taken with an oscilloscope.
Voltage variations may be noted due to normal production tolerances.
- Circled numbers refer to waveforms.
- Signal path.

: REC (DIGITAL IN) : CD

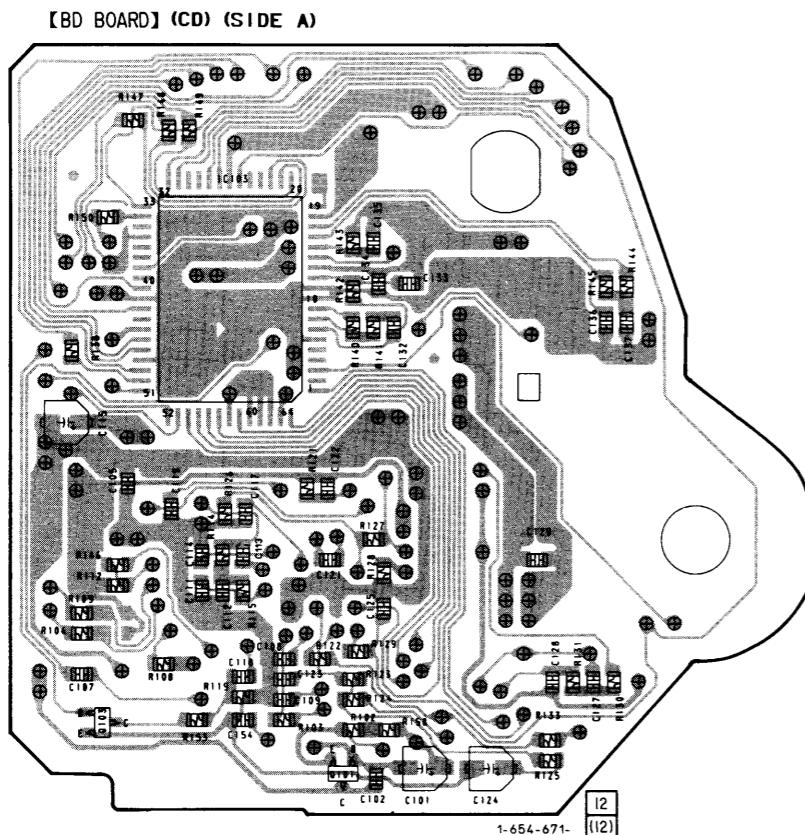
8-12. SCHEMATIC DIAGRAM - BD : CD SECTION - • Refer to page 77 for IC Block Diagrams.



8-13. PRINTED WIRING BOARDS – BD : CD SECTION –

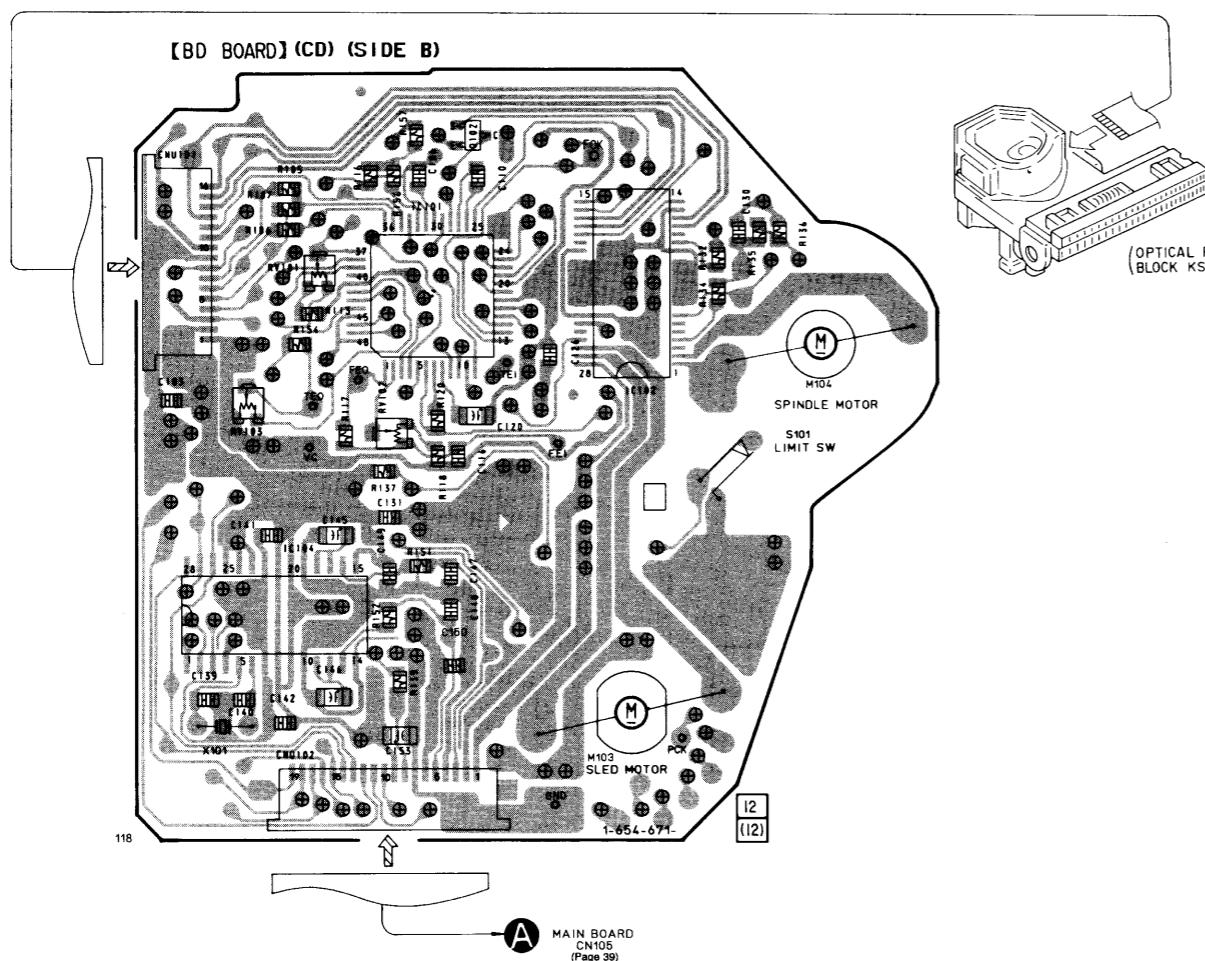
1	2	3	4	5	6	7	8
---	---	---	---	---	---	---	---

A
B
C
D
E
F
G
H
I
J
K



● SEMICONDUCTOR LOCATION

Ref. No.	Location
IC101	H-3
IC102	H-4
IC103	B-3
IC104	J-2
Q101	E-3
Q102	G-3
Q103	E-2



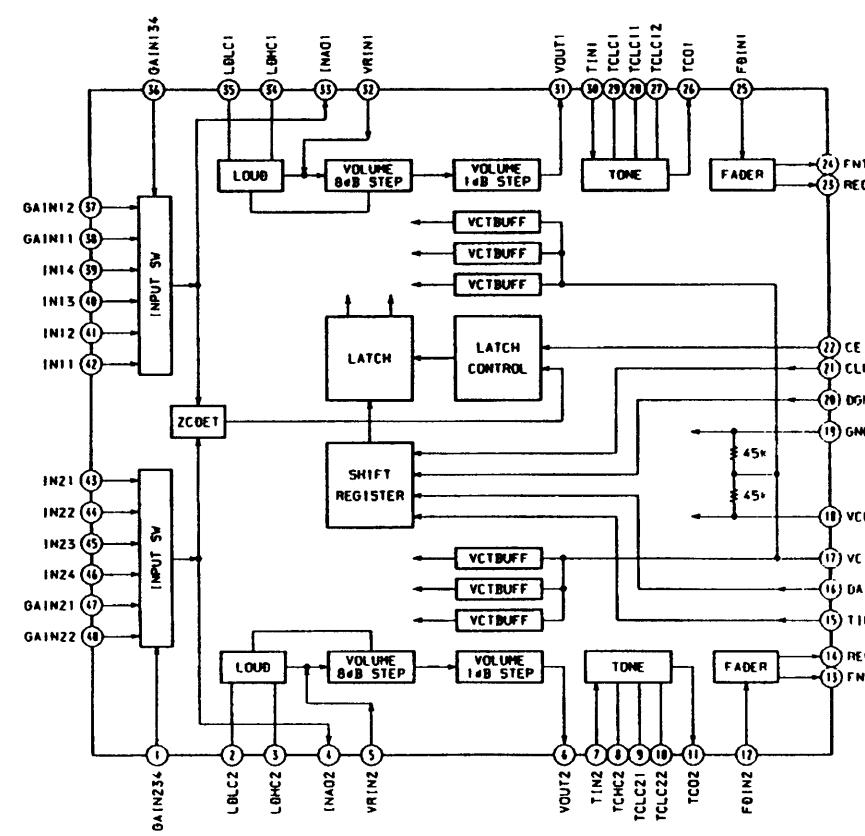
Note:

- ○ : parts extracted from the component side.
- — : parts extracted from the conductor side.
- ⊕ : Through hole.
- ■ : Pattern from the side which enables seeing.
(The other layers' patterns are not indicated)

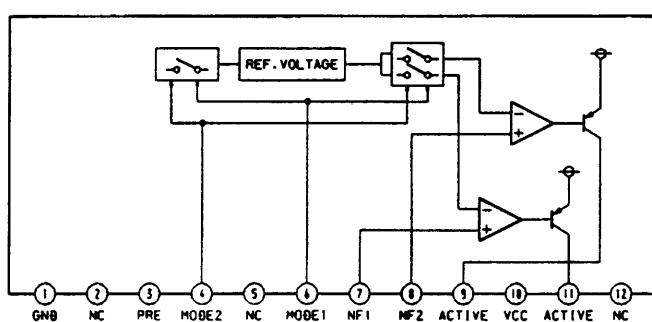
8-14. IC BLOCK DIAGRAM

- MAIN SECTION -

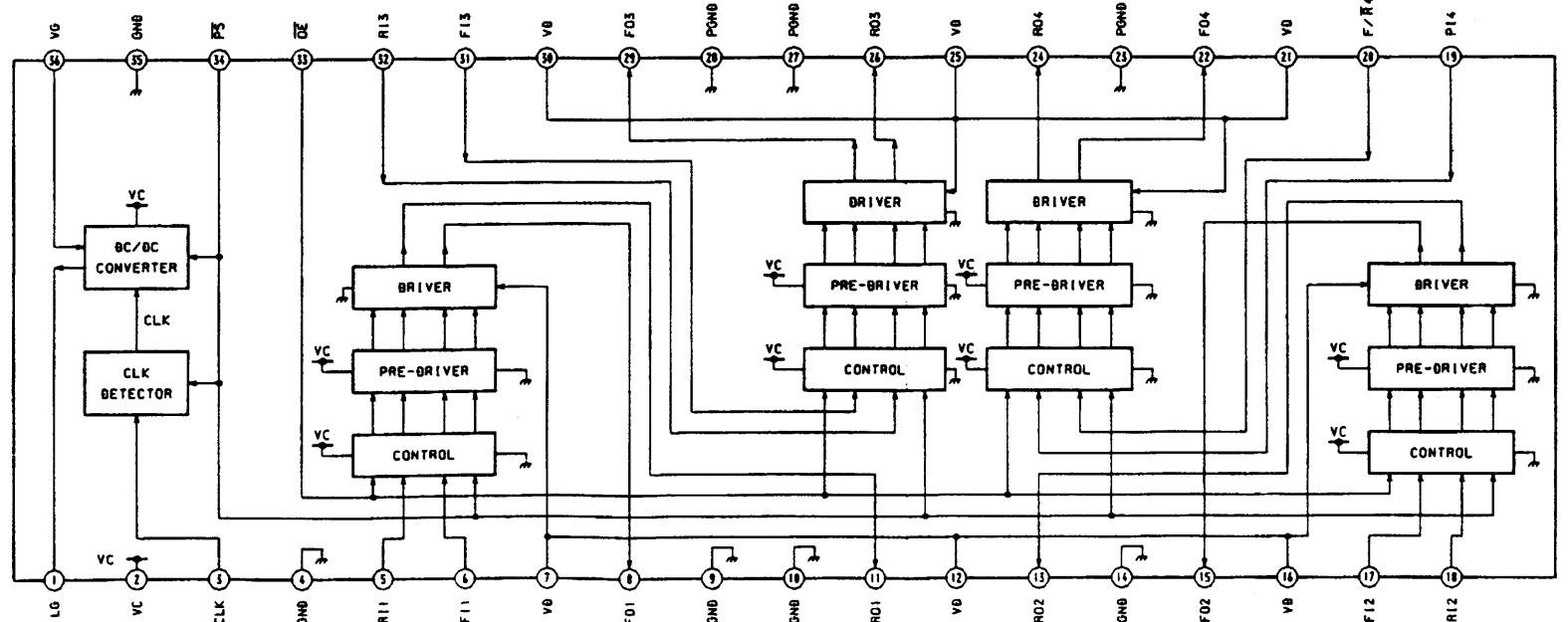
IC101 CXA1946AQ



IC821, 831 BA3960

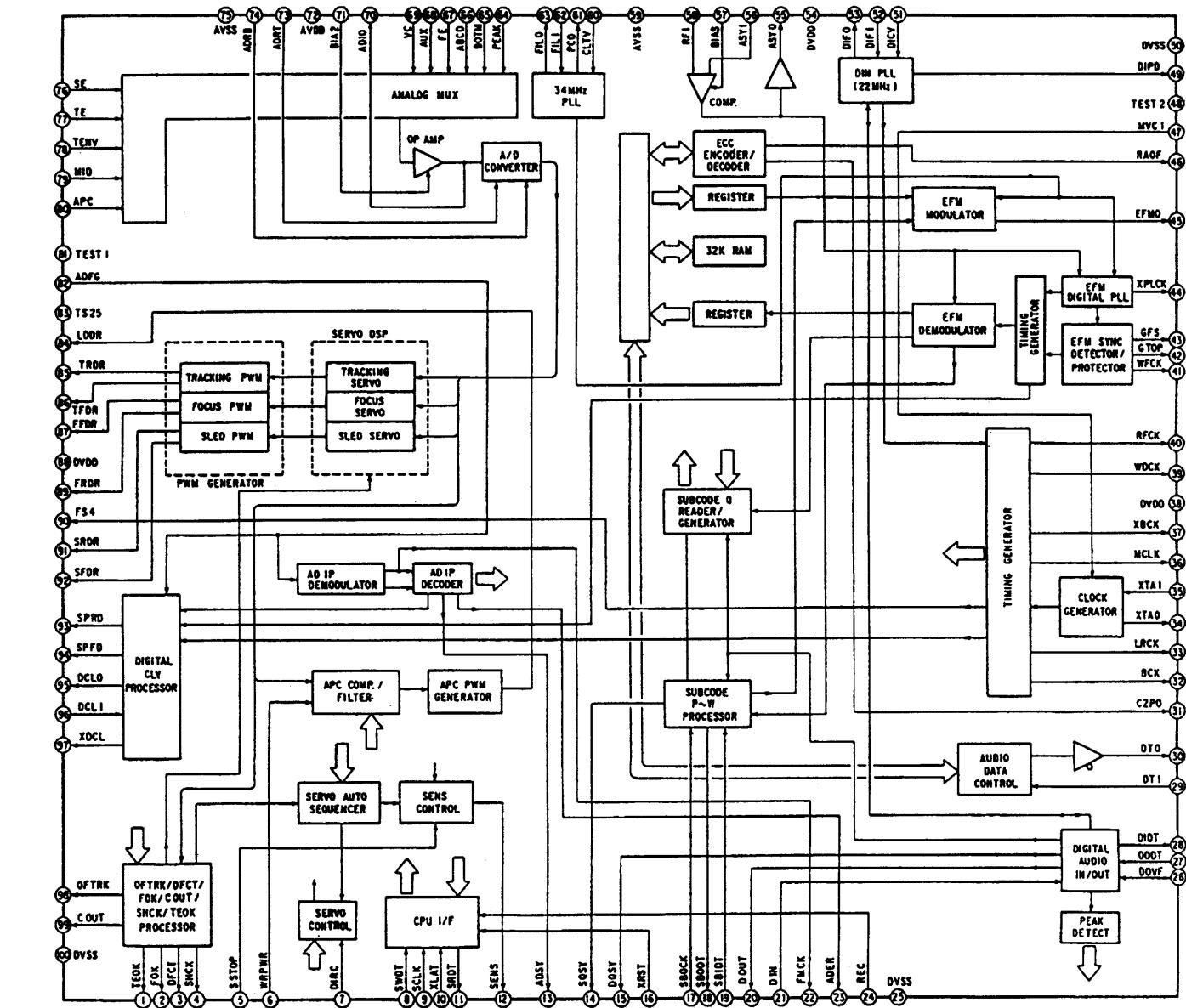


IC151 MPC17A38VMEL

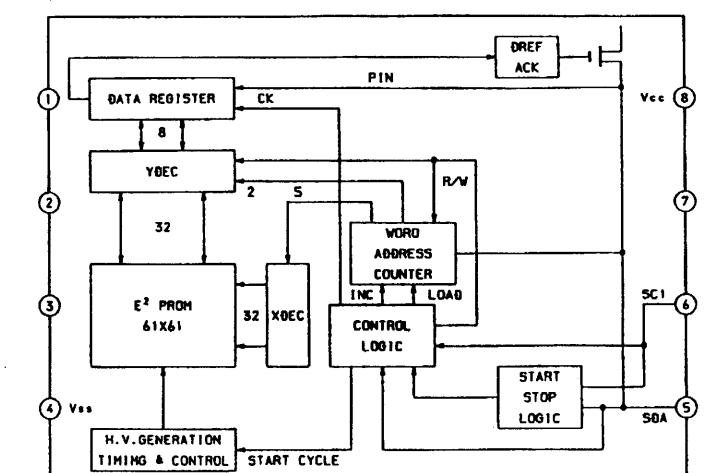


- MD SECTION -

IC121 CXD2535BR

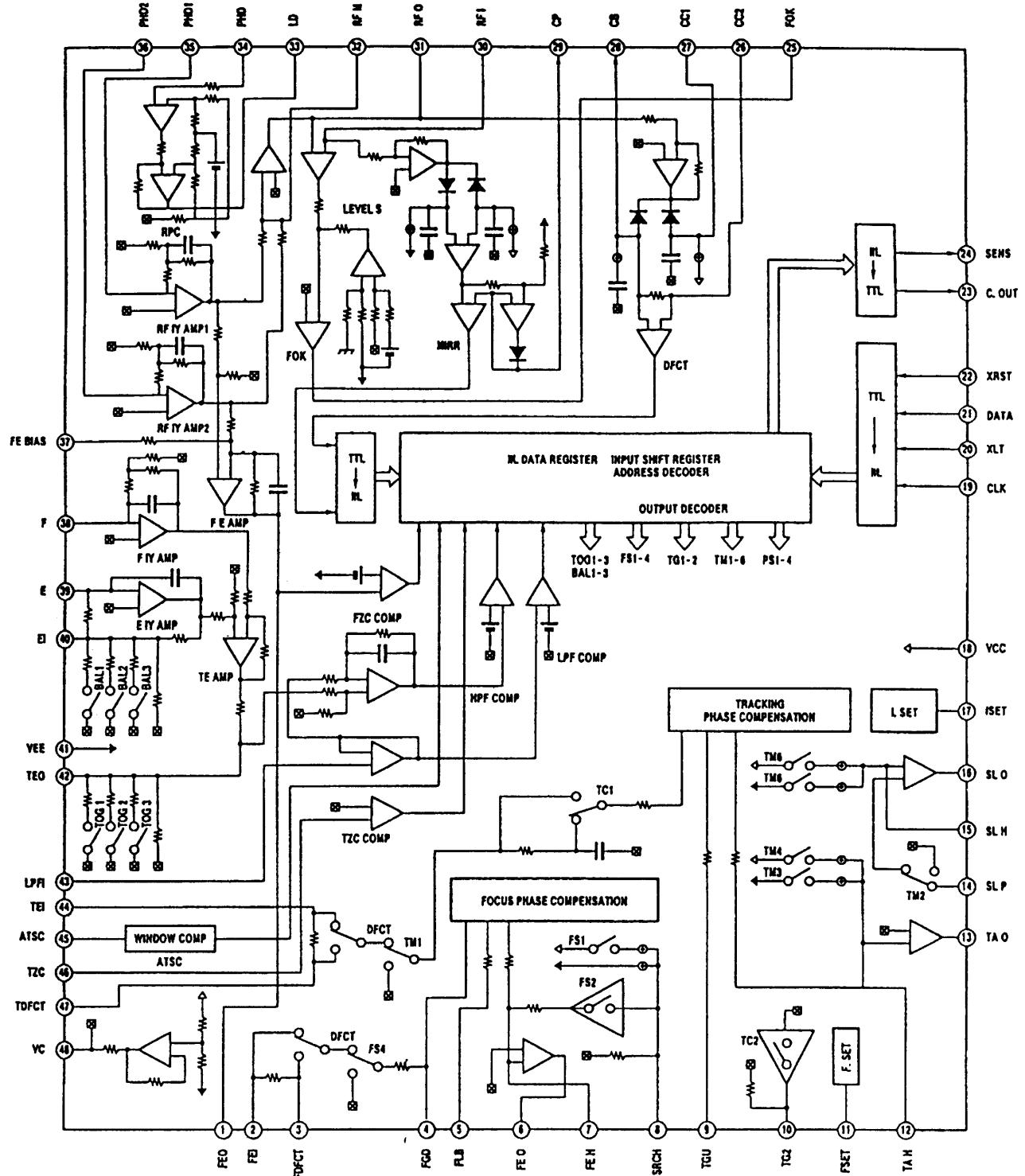


IC171 X24C01S

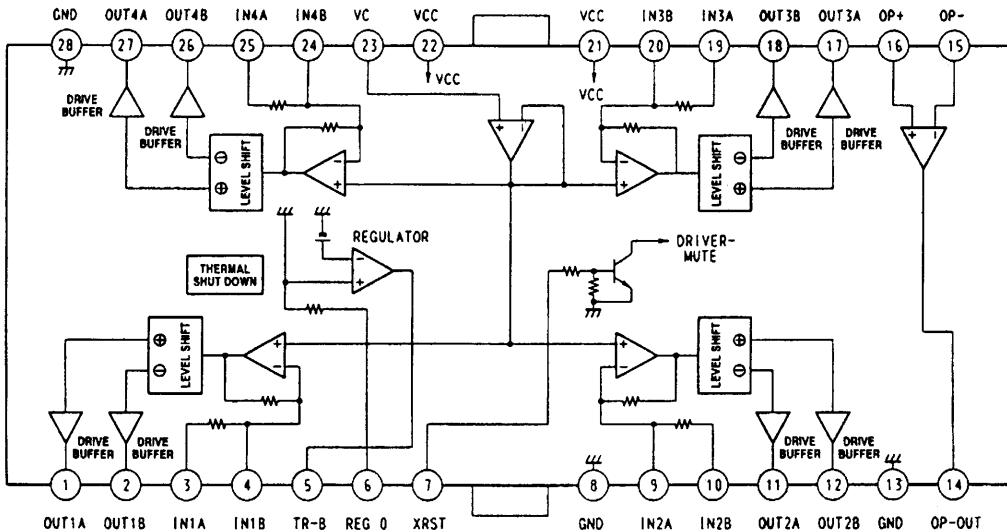


- CD SECTION -

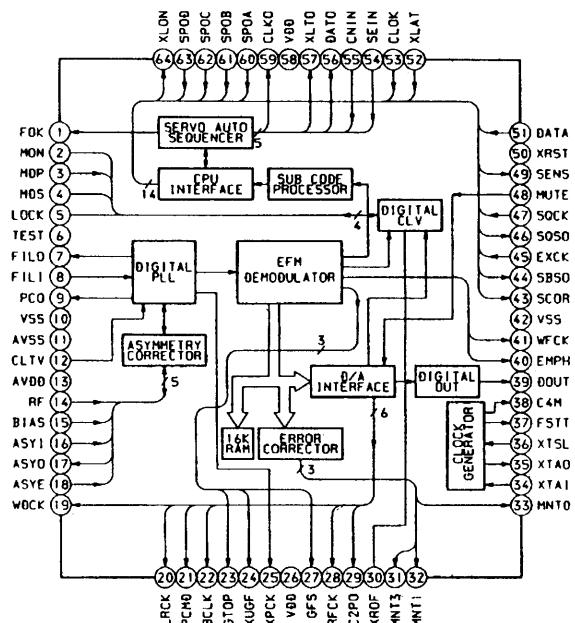
IC101 CXA1782BQ



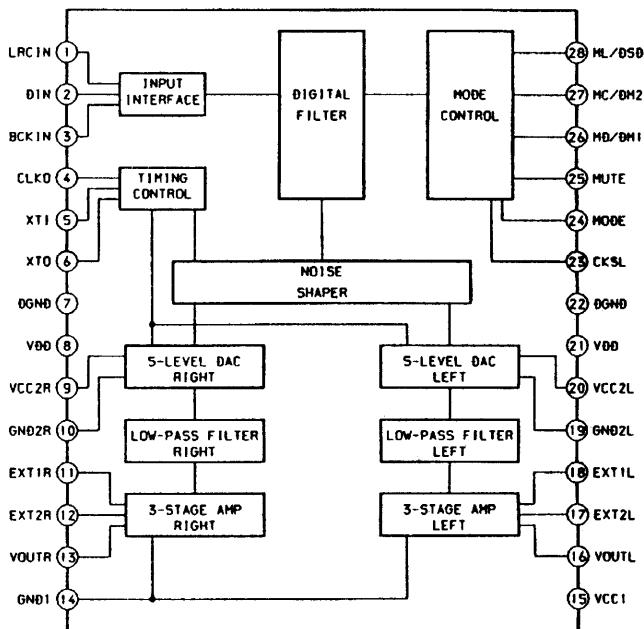
IC102 BA6397FP



IC103 CXD2507AQ



IC104 PCM1710U-B



SECTION 9

EXPLODED VIEWS

NOTE :

- -XX, -X mean standardized parts, so they may have some difference from the original one.
- Items marked “ * ” are not stocked since they are seldom required for routine service. Some delay should be anticipated when ordering these items.

- The mechanical parts with no reference number in the exploded views are not supplied.
- Hardware (# mark) list and accessories and packing materials are given in the last of this parts list.

● Abbreviation

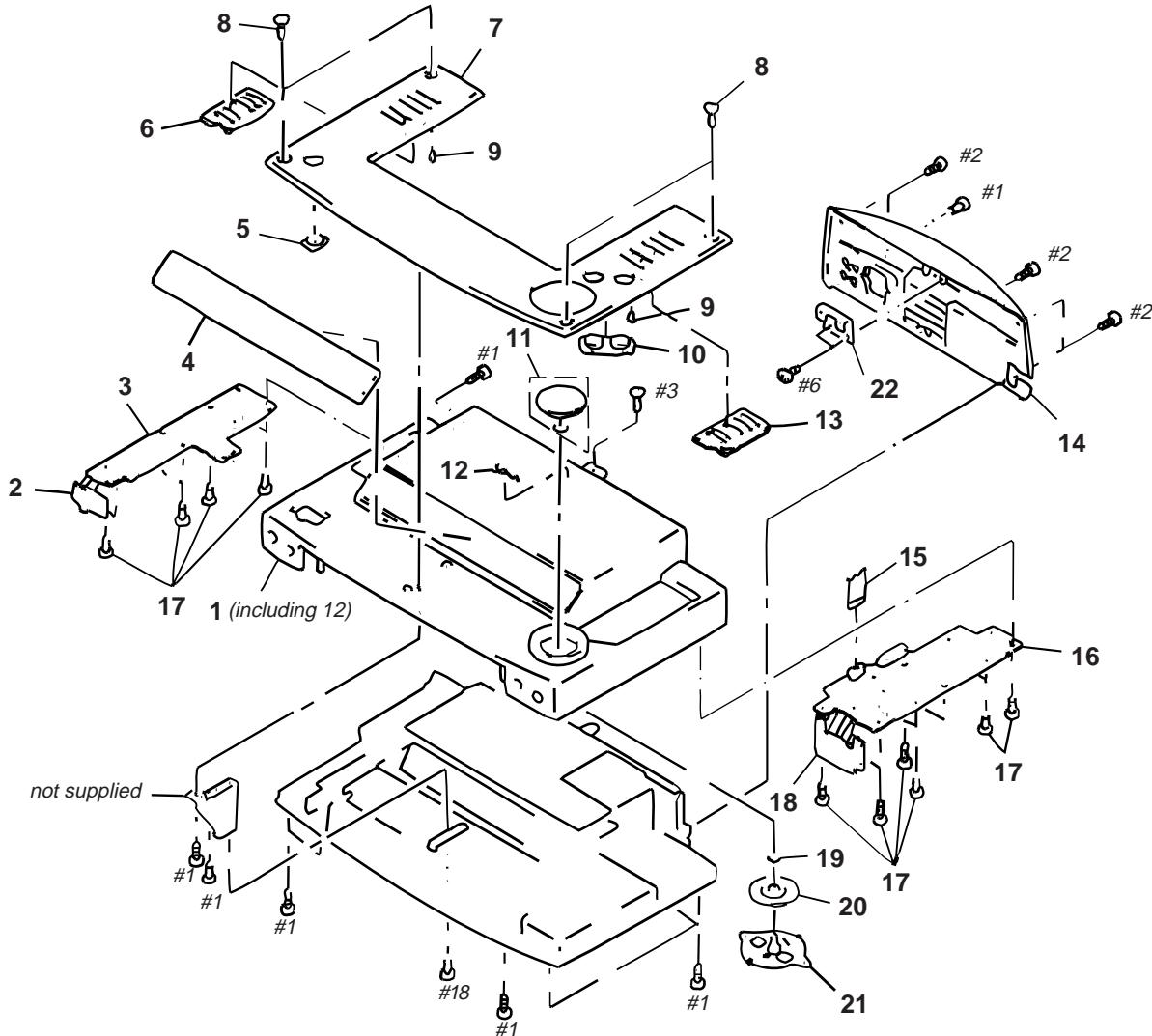
CND : Canadian	SP : Singapore
HK : Hong Kong	G : German
IT : Italian	

The components identified by mark \triangle or dotted line with mark \triangle are critical for safety.

Replace only with part number specified.

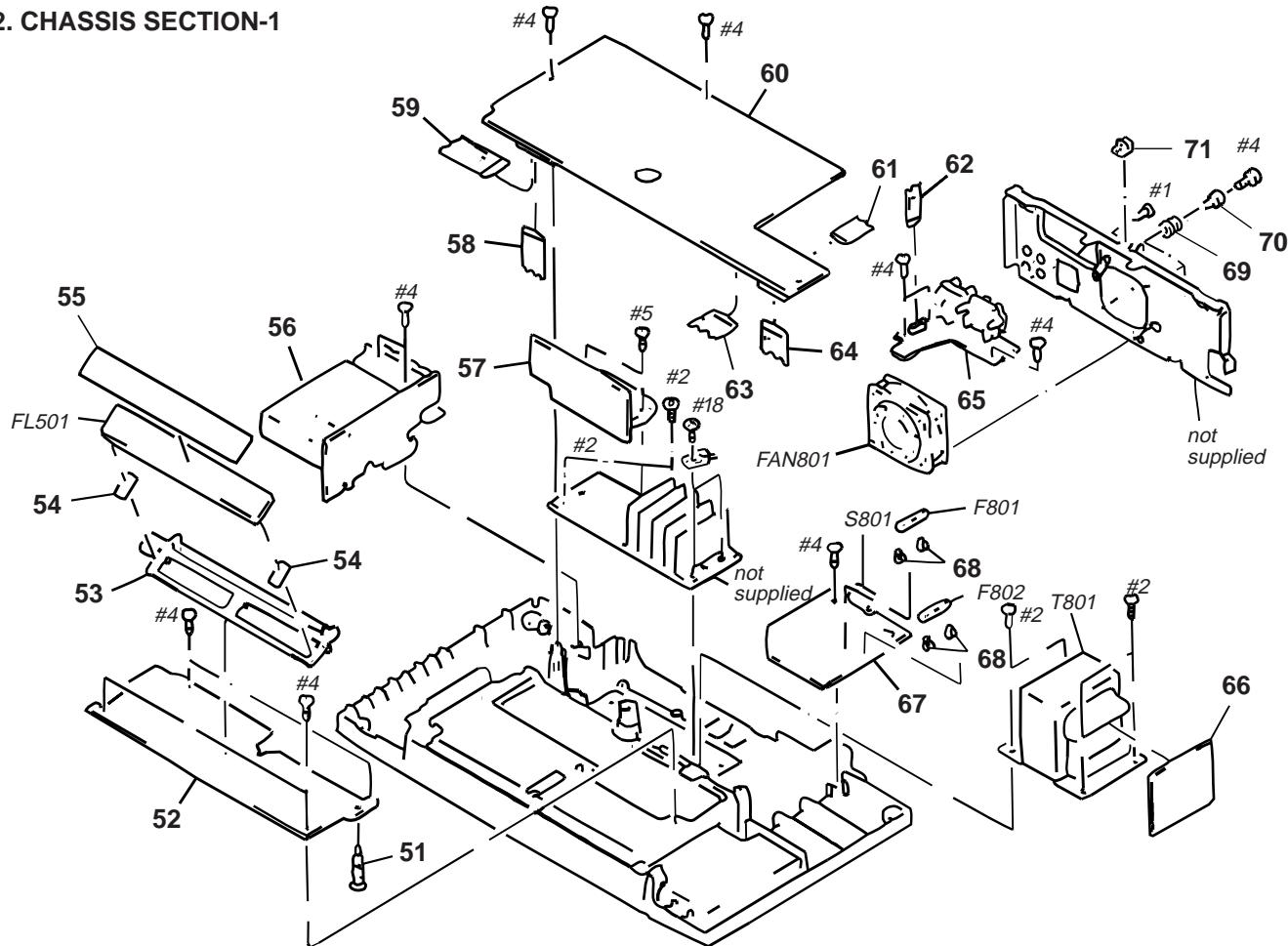
Les composants identifiés par une marque \triangle sont critiques pour la sécurité.
Ne les remplacer que par une pièce portant le numéro spécifié.

9-1. CABINET SECTION



Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
1	X-4947-203-1	CASE (TOP) ASSY (US,CND)		11	X-4947-291-1	KNOB (JOG) ASSY	
1	X-4947-204-1	CASE (TOP) ASSY (AEP,UK,G,IT)		12	4-942-567-01	EMBLEM (NO.4), SONY	
* 1	X-4947-205-1	CASE (TOP) ASSY (HK,SP)		13	X-4947-045-1	BUTTON (BAND) ASSY	
* 2	1-661-325-11	HP BOARD		* 14	4-980-506-01	PLATE (T BACK), ORNAMENTAL	
* 3	1-661-324-11	SWITCH (L) BOARD		15	1-777-137-11	WIRE (FLAT TYPE) (11CORE)	
4	4-980-513-01	PLATE, INDICATION		* 16	1-661-323-11	SWITCH (R) BOARD	
5	X-4947-046-1	BUTTON (POWER) ASSY		17	4-951-620-01	SCREW (2.6X8), +BVTP	
6	X-4947-044-1	BUTTON (MODE) ASSY		* 18	1-661-329-11	IR BOARD	
7	4-980-512-01	PLATE, ORNAMENTAL		19	4-981-608-11	WASHER, SLIT	
8	4-982-457-01	SCREW, HEXAGON HOLE TAPPING		20	X-4946-857-1	ROTOR ASSY	
9	4-980-519-01	INDICATOR (FUN)		21	X-4946-856-1	PLATE (JOG) ASSY	
10	X-4947-047-1	BUTTON (VOL) ASSY		22	4-983-312-01	BRACKET (T BACK)	

9-2. CHASSIS SECTION-1

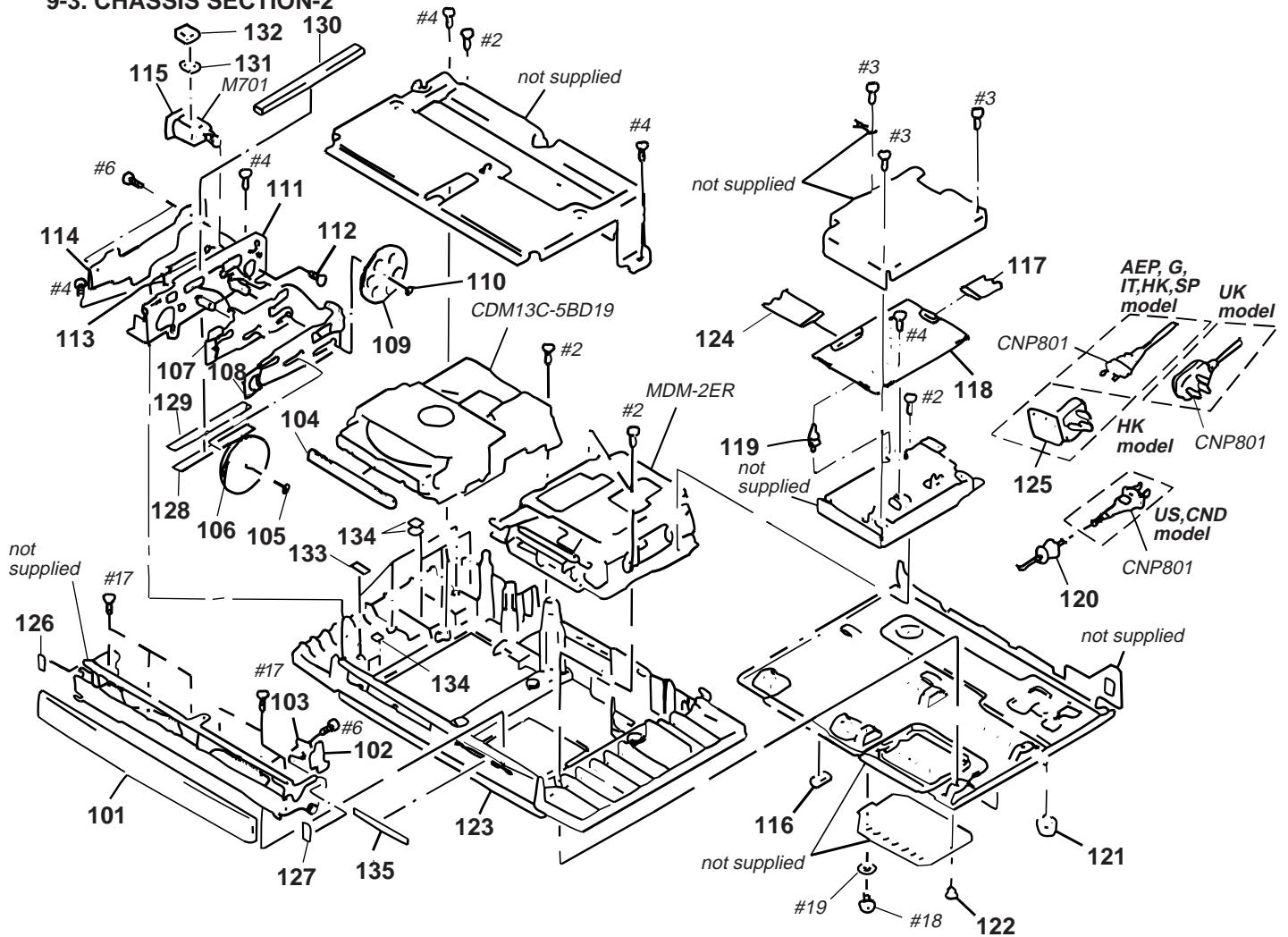


Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
* 51	4-982-455-01	HOLDER, PC BOARD		63	1-773-106-11	WIRE (FLAT TYPE) (19 CORE)	
* 52	1-661-322-11	DISPLAY BOARD		64	1-773-117-11	WIRE (FLAT TYPE) (19 CORE)	
* 53	4-980-523-01	HOLDER (FL)		* 65	1-661-328-11	TERMINAL BOARD	
* 54	4-955-901-01	CUSHION (FL)		* 66	1-661-332-11	TRANSFORMER BOARD	
* 55	4-980-522-01	FILTER		* 67	1-661-331-11	AC BOARD	
* 56	1-661-333-11	TUNER BOARD		68	1-533-293-11	FUSE HOLDER	
* 57	A-4390-522-A	AMP BOARD, COMPLETE (US)		* 69	4-888-798-11	BUSHING, RUBBER	
* 57	A-4390-538-A	AMP BOARD, COMPLETE (AEP,G,IT)		* 70	4-983-696-01	COLLAR	
* 57	A-4390-554-A	AMP BOARD, COMPLETE (HK,SP)		* 71	4-617-314-01	CLAMP	
* 57	A-4390-719-A	AMP BOARD, COMPLETE (CND)		△F801	1-533-296-11	FUSE, GLASS CYLINDRICAL (2A 125V)(US,CND)	
* 57	A-4390-735-A	AMP BOARD, COMPLETE (UK)		△F801	1-532-259-00	FUSE, TIME LAG (T1.6AL 250V)(SP,HK)	
58	1-777-033-11	WIRE (FLAT TYPE) (19 CORE)		△F802	1-532-215-00	FUSE, TIME LAG (T0.8AL 250V) (AEP,UK,G,IT,SP,HK)	
59	1-773-004-11	WIRE (FLAT TYPE) (15 CORE)		FAN801	1-698-651-11	FAN, D.C.	
* 60	A-4390-518-A	MAIN BOARD, COMPLETE (US)		FL501	1-517-520-11	INDICATOR TUBE, FLUORESCENT	
* 60	A-4390-534-A	MAIN BOARD, COMPLETE (AEP,G,IT)		△S801	1-572-675-11	SWITCH, POWER VOLTAGE CHANGE	
* 60	A-4390-550-A	MAIN BOARD, COMPLETE (HK,SP)		△T801	1-429-661-11	TRANSFORMER, POWER (AEP,UK,G,IT)	
* 60	A-4390-715-A	MAIN BOARD, COMPLETE (CND)		△T801	1-429-662-11	TRANSFORMER, POWER (SP,HK)	
* 60	A-4390-731-A	MAIN BOARD, COMPLETE (UK)		△T801	1-429-663-11	TRANSFORMER, POWER (US,CND)	
61	1-777-291-11	WIRE (FLAT TYPE) (21 CORE)					
62	1-769-974-11	WIRE (FLAT TYPE) (13 CORE)					

The components identified by mark \triangle or dotted line with mark \triangle are critical for safety.
Replace only with part number specified.

Les composants identifiés par une marque \triangle sont critiques pour la sécurité.
Ne les remplacer que par une pièce portant le numéro spécifié.

9-3. CHASSIS SECTION-2

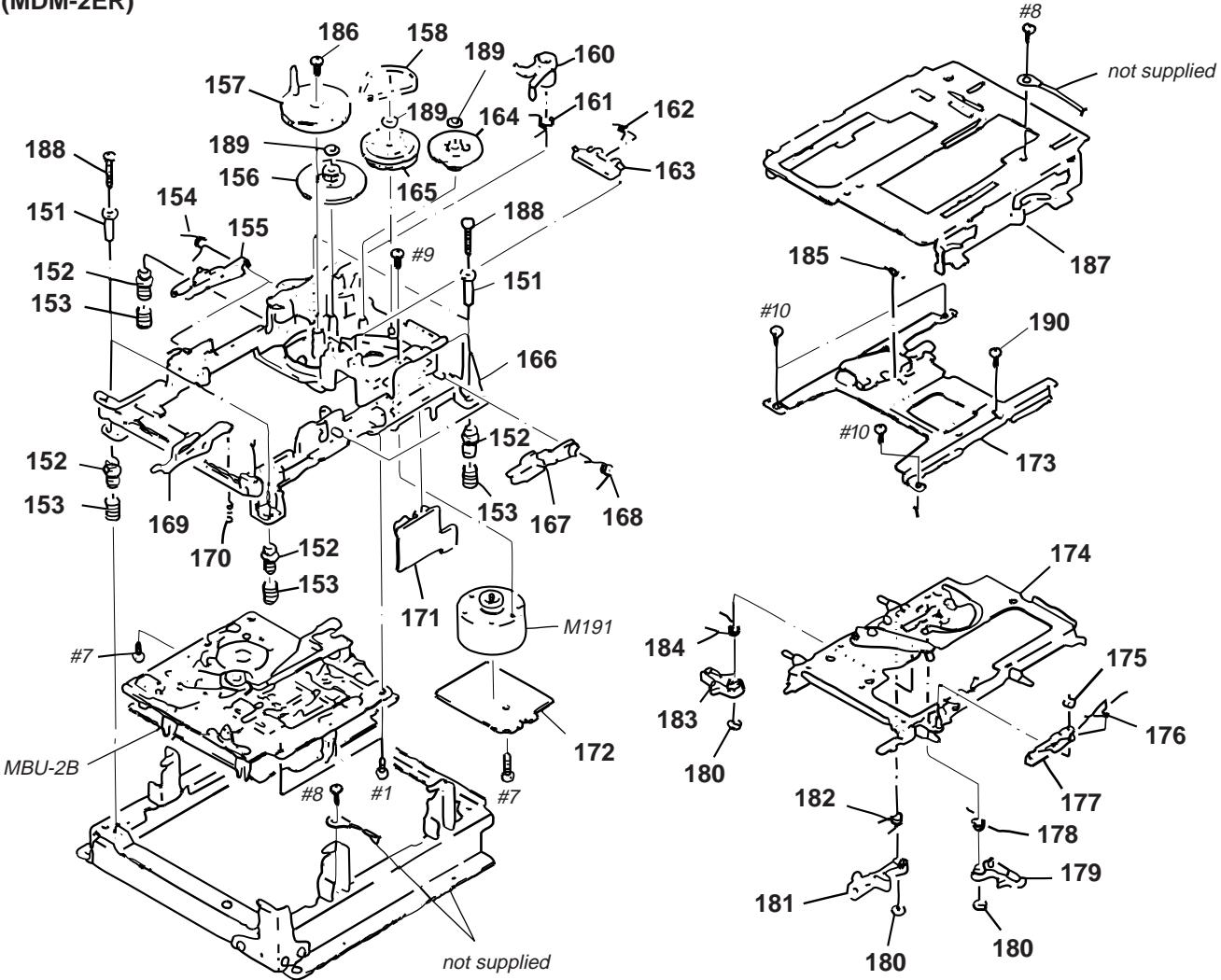


Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
101	X-4946-828-1	LID ASSY		119	4-924-098-21	HOLDER, PC BOARD	
* 102	1-661-335-11	SENSOR BOARD		* 120	3-703-244-00	BUSHING (2104), CORD	
* 103	4-980-529-01	HOLDER (SENSOR)		121	4-981-393-01	FOOT	
104	4-980-520-01	PANEL, CD		122	3-531-576-11	RIVET	
105	4-981-608-11	WASHER, SLIT		* 123	4-980-505-01	CASE (BOTTOM)	
106	4-980-496-01	GEAR (CAM)		124	1-769-118-11	WIRE (FLAT TYPE) (30 CORE)	
* 107	4-980-492-01	PLATE (CL)		▲125	1-770-019-11	ADAPTOR, CONVERSION PLUG 3P(HK)	
* 108	X-4946-826-1	CHASSIS (LD) ASSY		* 126	4-983-700-01	CUSHION (L)	
109	4-980-495-01	GEAR (C)		127	4-949-303-41	SPACER	
110	4-981-608-01	WASHER, SLIT		* 128	4-983-697-01	PLATE (LD)	
* 111	X-4946-830-1	PLATE (OP) ASSY		* 129	4-983-708-01	RUBBER (C)	
112	4-965-659-01	SCREW (+B 2X2.2)		* 130	4-983-703-01	CUSHION (T)	
113	4-982-456-01	SPRING, TENSION		* 131	4-983-705-01	RUBBER	
* 114	1-661-327-11	SWITCH (LID) BOARD		* 132	4-983-702-11	CUSHION (M)	
* 115	1-661-326-11	MOTOR (LID) BOARD		* 133	4-983-701-01	CUSHION (B)	
116	4-984-379-01	CUSHION (FOOT)		* 134	4-983-707-01	RUBBER (B)	
117	1-777-291-11	WIRE (FLAT TYPE) (21 CORE)		135	4-983-893-01	SHEET (MDM)	
* 118	A-4390-532-A	DIGITAL BOARD, COMPLETE (US)		▲CNP801	1-575-651-31	CORD, POWER (AEP,G,IT,SP,HK)	
* 118	A-4390-548-A	DIGITAL BOARD, COMPLETE (AEP,G,IT)		▲CNP801	1-775-789-11	CORD, POWER (US,CND)	
* 118	A-4390-564-A	DIGITAL BOARD, COMPLETE (HK,SP)		▲CNP801	1-696-570-21	CORD, POWER (UK)	
* 118	A-4390-729-A	DIGITAL BOARD, COMPLETE (CND)		M701	X-4947-281-1	LID MOTOR,ASSY	
* 118	A-4390-745-A	DIGITAL BOARD, COMPLETE (UK)					

The components identified by mark ▲ or dotted line with mark ▲ are critical for safety.
Replace only with part number specified.

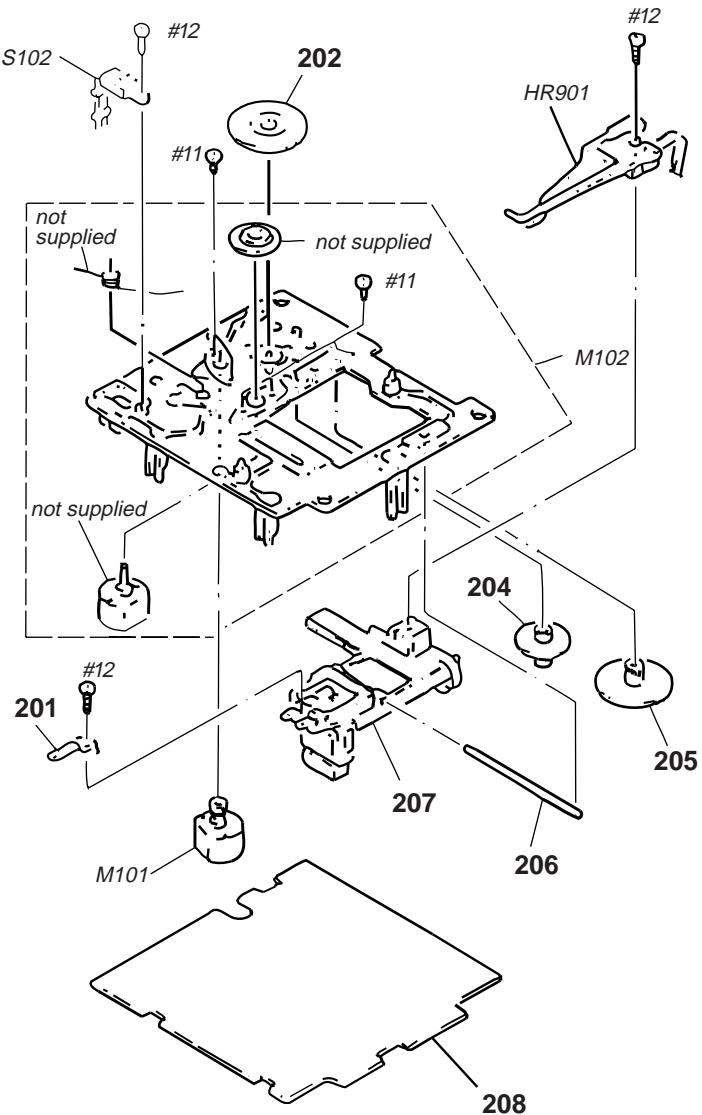
Les composants identifiés par une marque ▲ sont critiques pour la sécurité.
Ne les remplacer que par une pièce portant le numéro spécifié.

**9-4. MD MECHANISM SECTION
(MDM-2ER)**



Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
151	4-983-100-01	COLLAR (DAMPER)		* 172	1-653-412-11	MOTOR BOARD	
152	4-967-671-01	INSULATOR (MD)		173	A-4672-087-A	BRACKET (LVO) ASSY	
153	4-967-673-01	SPRING, COMPRESSION		174	X-4947-136-2	HOLDER ASSY	
154	4-967-668-01	SPRING (UDL), TORSION		175	4-968-919-11	WASHER, STOPPER	
155	4-967-667-01	LEVER (UDL)		176	4-967-646-01	SPRING (SHT), TORSION	
156	4-977-610-01	GEAR (BD-B)		177	4-967-645-01	LEVER (SHT)	
157	X-4945-069-1	CAM ASSY		178	4-983-106-02	SPRING (LM), TORSION	
158	4-967-656-01	BELT (BD)		179	4-967-639-01	LEVER (LM)	
160	4-967-637-01	LEVER (SLM)		180	4-968-919-01	WASHER, STOPPER	
161	4-984-426-01	SPRING (SLM), TORSION		181	4-967-641-01	LEVER (L)	
162	4-968-273-01	SPRING (OWH), TORSION		182	4-967-642-01	SPRING (L), TORSION	
163	4-968-272-01	LEVER (OWH)		183	4-982-040-01	LEVER (LOCK)	
164	4-977-609-01	GEAR (BD-A)		184	4-982-099-01	SPRING (LOCK), TORSION	
165	4-957-794-01	PULLEY (GEAR 1)		185	4-971-743-02	SPRING, TENSION	
* 166	X-4945-068-1	BASE (BD) ASSY		* 186	4-933-134-01	SCREW (+PTPWH M2.6X6)	
167	4-967-669-01	LEVER (UDR)		* 187	X-4945-872-1	SLIDER (M) ASSY	
168	4-967-670-01	SPRING (UDR), TORSION		188	4-972-910-01	SCREW (2.6X18), +B	
169	4-979-400-01	LEVER (DOOR)		189	7-621-770-67	SCREW +PWH 2.6X6	
170	4-970-710-01	SPRING, COMPRESSION		190	7-621-255-25	SCREW +PTT 2X4 (S)	
* 171	1-653-411-11	DETECTION SW BOARD		M191	A-4660-646-A	MOTOR (LOADING) ASSY	

**9-5. BASE UNIT SECTION (MD)
(MBU-2)**

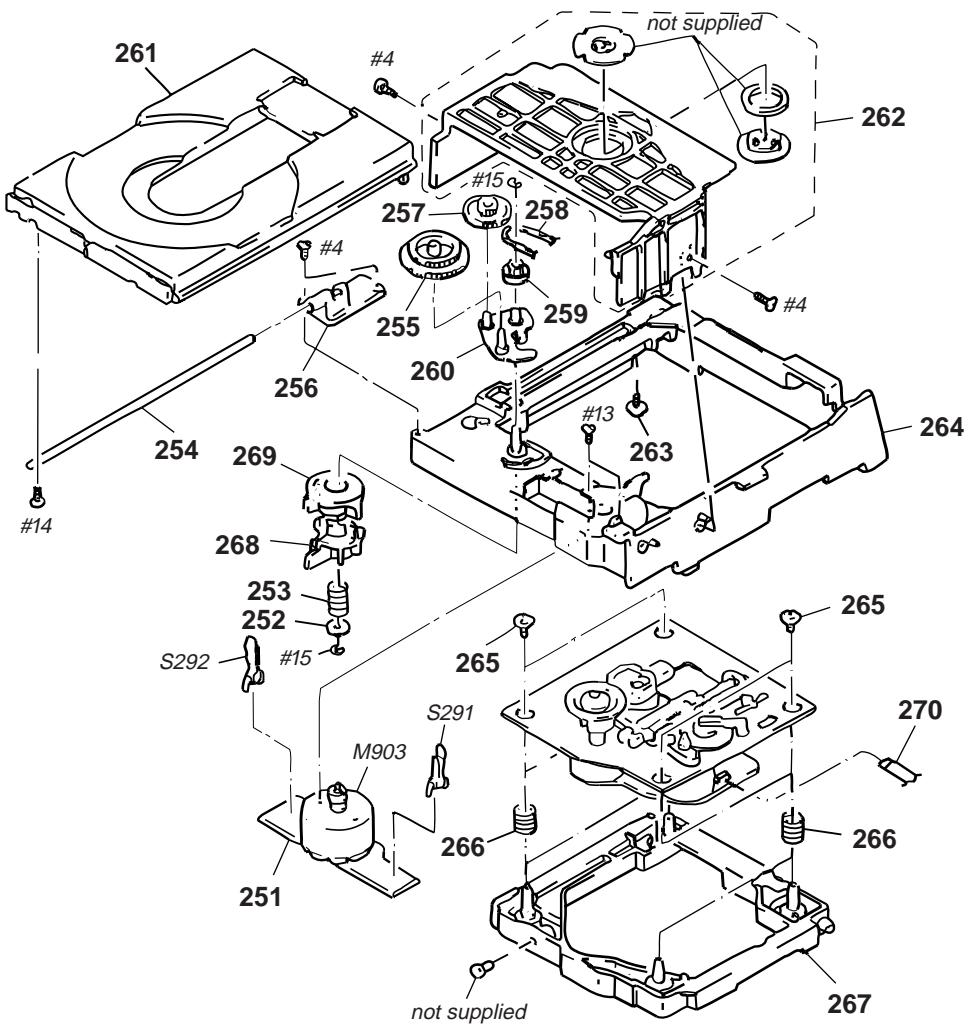


Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
* 201	1-634-461-11	LOADING BOARD		* 208	A-4673-809-A	BD(MD)BOARD, COMPLETE	
202	4-967-675-01	GEAR (SL-A)		HR901	1-500-304-21	HEAD, OVER LIGHT (RF322-74A)	
204	4-967-676-01	GEAR (SL-B)		M101	A-4660-651-A	MOTOR (SLED) ASSY	
205	4-967-677-01	GEAR (SL-C)		M102	A-4660-650-A	CHASSIS ASSY, BU	
206	4-967-678-01	SHAFT (OP)		S102	1-762-148-11	SWITCH, PUSH (2 KEY) (PROTECT/REFLECT SWITCH)	
△207	8-583-009-11	OPTICAL PICK-UP KMS-210A/J-N (MD)					

The components identified by mark \triangle or dotted line with mark \triangle are critical for safety.
Replace only with part number specified.

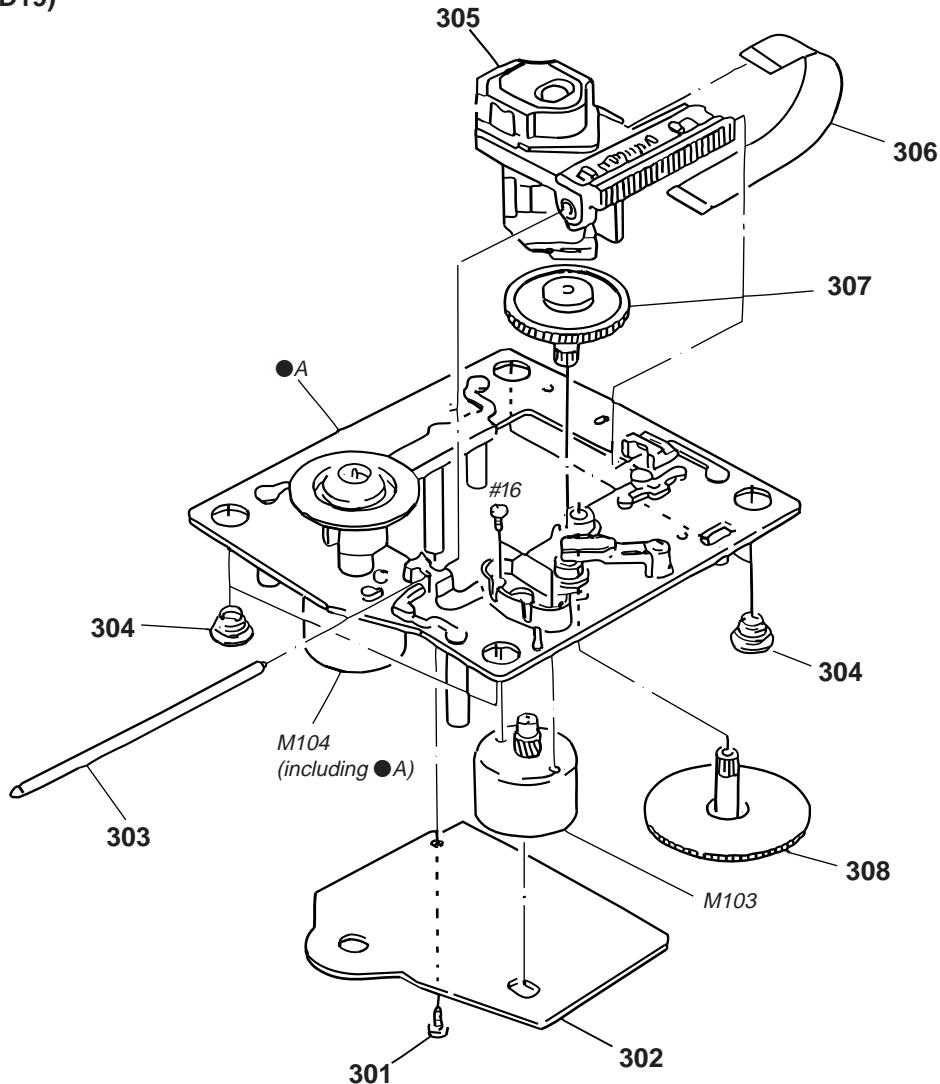
Les composants identifiés par une marque \triangle sont critiques pour la sécurité.
Ne les remplacer que par une pièce portant le numéro spécifié.

**9-6. CD MECHANISM SECTION-1
(CDM-5BD19)**



Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
251	4-967-679-01	SPRING (OP), LEAF		* 263	4-917-583-21	BRACKET, YOKE	
252	4-927-654-01	WASHER (LIMITER)		* 264	X-4946-208-2	CHASSIS (MD) ASSY	
253	3-659-338-00	SPRING, COMPRESSION		265	4-933-134-01	SCREW (+PTPWH M2.6X6)	
254	4-929-764-01	SHAFT (TABLE GUIDE)		266	4-958-593-01	SPRING (BU), COMPRESSION	
255	4-927-620-01	GEAR (P)		267	4-929-747-01	HOLDER (BU)	
256	4-944-006-11	BEARING		268	4-929-727-01	CAM (A)	
257	4-927-628-01	GEAR (C)		269	4-929-729-01	CAM (B)	
258	4-927-649-01	BELT		270	1-777-033-11	WIRE (FLAT TYPE) (19 CORE)	
259	4-929-724-01	PULLEY (B)		M903	A-4608-362-A	MOTOR (L)ASSY (LOADING)	
260	X-4947-265-1	ARM ASSY, SWING		S291	1-571-924-11	SWITCH, LEAF (LOAD OUT)	
261	4-944-012-01	TABLE, DISC		S292	1-571-924-11	SWITCH, LEAF (LOAD IN)	
262	A-4604-752-A	HOLDER (MG) ASSY					

**9-7. CD MECHANISM SECTION-2
(CDM-5BD19)**



Ref. No.	Part No.	Description	Remark
301	4-951-620-01	SCREW (2.6X8), +BVTP	
* 302	A-4673-402-A	BD (CD) BOARD, COMPLETE	
303	4-917-565-01	SHAFT, SLED	
304	4-951-940-01	INSULATOR (BU)	
△ 305	8-848-367-11	OPTICAL PICK-UP KSS-213B/K-N (CD)	

Ref. No.	Part No.	Description	Remark
306	1-769-069-11	WIRE (FLAT TYPE) (16 CORE)	
307	4-917-567-01	GEAR (M)	
308	4-917-564-01	GEAR (P), FLATNESS	
M103	X-4917-504-1	MOTOR, ASSY(CD)(SLED MOTOR)	
M104	X-4917-523-4	MOTOR, ASSY(CD)(SPINDLE MOTOR)	

The components identified by mark △ or dotted line with mark △ are critical for safety.
Replace only with part number specified.

Les composants identifiés par une marque △ sont critiques pour la sécurité.
Ne les remplacer que par une pièce portant le numéro spécifié.

Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark				
Q922	8-729-620-05	TRANSISTOR	2SC2603-EF	▲R957	1-217-637-00	FUSIBLE	1 5% 1/4W F				
Q923	8-729-620-05	TRANSISTOR	2SC2603-EF	▲R959	1-212-881-11	FUSIBLE	100 5% 1/4W F				
Q924	8-729-119-76	TRANSISTOR	2SA1175-HFE	▲R960	1-217-151-00	METAL PLATE	0.22				
Q925	8-729-620-05	TRANSISTOR	2SC2603-EF	R961	1-249-417-11	CARBON	1K 5% 1/4W				
Q931	8-729-620-05	TRANSISTOR	2SC2603-EF	R962	1-249-431-11	CARBON	15K 5% 1/4W				
Q932	8-729-422-73	TRANSISTOR	UN4212	R963	1-249-441-11	CARBON	100K 5% 1/4W				
Q941	8-729-620-05	TRANSISTOR	2SC2603-EF	R964	1-260-076-11	CARBON	10 5% 1/2W				
Q951	8-729-140-84	TRANSISTOR	2SC1841-PAFAEA	< THERMISTOR >							
< RESISTOR >											
R901	1-249-417-11	CARBON	1K 5% 1/4W	TH931	1-807-796-11	THERMISTOR	*****				
R902	1-249-438-11	CARBON	56K 5% 1/4W	* A-4673-402-A	BD(CD) BOARD, COMPLETE	*****					
R903	1-249-415-11	CARBON	680 5% 1/4W								
R904	1-249-438-11	CARBON	56K 5% 1/4W								
R905	1-260-103-11	CARBON	2.2K 5% 1/2W	< CAPACITOR >							
R906	1-260-103-11	CARBON	2.2K 5% 1/2W	C101	1-126-607-11	ELECT CHIP	47uF 20% 4V				
R907	1-260-099-11	CARBON	1K 5% 1/2W	C102	1-163-275-11	CERAMIC CHIP	0.001uF 5% 50V				
R908	1-260-099-11	CARBON	1K 5% 1/2W	C103	1-164-346-11	CERAMIC CHIP	1uF 16V				
▲R909	1-212-881-11	FUSIBLE	100 5% 1/4W F	C105	1-163-038-91	CERAMIC CHIP	0.1uF 25V				
▲R910	1-217-151-00	METAL PLATE	0.22 F	C106	1-164-695-11	CERAMIC CHIP	0.0022uF 5% 50V				
R911	1-249-417-11	CARBON	1K 5% 1/4W	C107	1-164-695-11	CERAMIC CHIP	0.0022uF 5% 50V				
R912	1-249-431-11	CARBON	15K 5% 1/4W	C108	1-164-232-11	CERAMIC CHIP	0.01uF 50V				
R913	1-249-441-11	CARBON	100K 5% 1/4W	C109	1-164-232-11	CERAMIC CHIP	0.01uF 50V				
R914	1-260-076-11	CARBON	10 5% 1/2W	C110	1-163-989-11	CERAMIC CHIP	0.033uF 10% 25V				
R921	1-249-438-11	CARBON	56K 5% 1/4W	C111	1-163-038-91	CERAMIC CHIP	0.1uF 25V				
R922	1-249-437-11	CARBON	47K 5% 1/4W	C112	1-163-038-91	CERAMIC CHIP	0.1uF 25V				
R923	1-249-441-11	CARBON	100K 5% 1/4W	C113	1-164-695-11	CERAMIC CHIP	0.0022uF 5% 50V				
R924	1-249-429-11	CARBON	10K 5% 1/4W	C114	1-164-005-11	CERAMIC CHIP	0.47uF 25V				
R925	1-249-441-11	CARBON	100K 5% 1/4W	C115	1-126-607-11	ELECT CHIP	47uF 20% 4V				
R926	1-249-429-11	CARBON	10K 5% 1/4W	C116	1-163-016-00	CERAMIC CHIP	0.0039uF 10% 50V				
R927	1-249-441-11	CARBON	100K 5% 1/4W	C117	1-164-005-11	CERAMIC CHIP	0.47uF 25V				
R928	1-249-441-11	CARBON	100K 5% 1/4W	C118	1-107-823-11	CERAMIC CHIP	0.47uF 10% 16V				
R929	1-249-429-11	CARBON	10K 5% 1/4W	C119	1-163-038-91	CERAMIC CHIP	0.1uF 25V				
R930	1-249-441-11	CARBON	100K 5% 1/4W	C120	1-135-201-11	TANTALUM CHIP	10uF 20% 4V				
R931	1-249-429-11	CARBON	10K 5% 1/4W	C121	1-163-038-91	CERAMIC CHIP	0.1uF 25V				
R932	1-249-429-11	CARBON	10K 5% 1/4W	C122	1-164-232-11	CERAMIC CHIP	0.01uF 50V				
R933	1-249-439-11	CARBON	68K 5% 1/4W	C123	1-163-038-91	CERAMIC CHIP	0.1uF 25V				
R934	1-249-441-11	CARBON	100K 5% 1/4W	C124	1-126-607-11	ELECT CHIP	47uF 20% 4V				
R935	1-249-441-11	CARBON	100K 5% 1/4W	C125	1-164-232-11	CERAMIC CHIP	0.01uF 50V				
R941	1-249-429-11	CARBON	10K 5% 1/4W	C126	1-163-038-91	CERAMIC CHIP	0.1uF 25V				
R942	1-249-441-11	CARBON	100K 5% 1/4W	C127	1-164-695-11	CERAMIC CHIP	0.0022uF 5% 50V				
R943	1-247-807-31	CARBON	100 5% 1/4W	C128	1-163-135-00	CERAMIC CHIP	560PF 5% 50V				
R944	1-249-437-11	CARBON	47K 5% 1/4W	C129	1-163-038-91	CERAMIC CHIP	0.1uF 25V				
R945	1-249-437-11	CARBON	47K 5% 1/4W	C130	1-164-336-11	CERAMIC CHIP	0.33uF 25V				
R946	1-249-441-11	CARBON	100K 5% 1/4W	C131	1-163-038-91	CERAMIC CHIP	0.1uF 25V				
R947	1-249-429-11	CARBON	10K 5% 1/4W	C132	1-163-037-11	CERAMIC CHIP	0.022uF 10% 25V				
R951	1-249-417-11	CARBON	1K 5% 1/4W	C133	1-163-145-00	CERAMIC CHIP	0.0015uF 5% 50V				
R952	1-249-438-11	CARBON	56K 5% 1/4W	C134	1-164-346-11	CERAMIC CHIP	1uF 16V				
R953	1-249-415-11	CARBON	680 5% 1/4W	C135	1-163-251-11	CERAMIC CHIP	100PF 5% 50V				
R954	1-249-438-11	CARBON	56K 5% 1/4W	C136	1-164-005-11	CERAMIC CHIP	0.47uF 25V				
R955	1-260-103-11	CARBON	2.2K 5% 1/2W	C137	1-164-232-11	CERAMIC CHIP	0.01uF 50V				
R956	1-260-103-11	CARBON	2.2K 5% 1/2W								

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Ref. No.	Part No.	Description	Remark
△F802	1-532-215-00	FUSE, TIME LAG (T0.8AL 250V)	(AEP,UK,G,IT,SP,HK)
FAN801	1-698-651-11	FAN, D.C.	
HR901	1-500-304-21	HEAD, OVER LIGHT (RF322-74A)	
M101	A-4660-651-A	MOTOR (SLED) ASSY	
M102	A-4660-650-A	CHASSIS ASSY, BU	
M103	X-4917-504-1	MOTOR, ASSY(CD)(SLED MOTOR)	
M104	X-4917-523-4	MOTOR, ASSY(CD)(SPINDLE MOTOR)	
M701	X-4947-281-1	LID MOTOR,ASSY	
M191	A-4660-646-A	MOTOR (LOADING) ASSY	
M903	A-4608-362-A	MOTOR (L)ASSY	
S102	1-762-148-11	SWITCH, PUSH (2 KEY) (PROTECT/REFLECT SEITCH)	
S801	1-572-675-11	SWITCH, POWER VOLTAGE CHANGE (VOLTAGE SELECTOR)(SP,HK)	
S291	1-571-924-11	SWITCH, LEAF (LOAD OUT)	
S292	1-571-924-11	SWITCH, LEAF (LOAD IN)	
△T801	1-429-663-11	TRANSFORMER POWER (US,CND)	
△T801	1-429-661-11	TRANSFORMER POWER (AEP,UK,G,IT)	
△T801	1-429-662-11	TRANSFORMER POWER (SP,HK)	

ACCESSORIES & PACKING MATERIALS			

*	4-941-548-01	LABEL, CLASS (1)(EXCEPT US,CND)	
*	4-981-825-01	CUSHION (RIGHT)	
*	4-981-826-01	CUSHION (LEFT)	

***** HARDWARE LIST *****			

#1	7-685-647-79	SCREW +BVTP 3X10 TYPE2 N-S	
#2	7-685-873-09	SCREW +BVTT 3X10 (S)	
#3	7-685-871-01	SCREW +BVTT 3X6 (S)	
#4	7-685-646-79	SCREW +BVTP 3X8 TYPE2 N-S	
#5	7-685-649-79	SCREW +BVTP 3X14 TYPE2 N-S	
#6	7-685-132-19	SCREW +BTP 2.6X5 TYPE2 N-S	
#7	7-685-645-79	SCREW +BVTP 3X6 TYPE2 N-S	
#8	7-621-773-86	SCREW +BVTT 2.6X4 (S)	
#9	7-621-775-20	SCREW +B 2.6X5	
#10	7-685-104-19	SCREW +P 2X6 TYPE2 NON-SLIT	
#11	7-627-852-08	SCREW,PRECISION +P 1.7X2.5	
#12	7-685-105-19	TPG +P 2X8, TYPE 2, NON-SLIT	
#13	7-621-775-10	SCREW +B 2.6X4	
#14	7-685-234-19	SCREW +KTP 2.6X8 TYPE2NON-SLIT	
#15	7-624-105-04	STOP RING 2.3, TYPE -E	
#16	7-621-255-15	SCREW +P 2X3	
#17	7-685-546-19	SCREW +BTP 3X8 TYPE2 N-S	
#18	7-685-874-09	SCREW +BVTT 3X12 (S)	
#19	7-623-422-07	LW3, TYPE B	

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